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Final

Technical Summary Report

of

RESEARCH AND DEVELOPMENT PROGRAM

OF

THERMIONIC CONVERSION OF HEAT TO ELECTRICITY

Volume I

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June 30, 1964

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GENERAL ELECTRIC COMPANY
SPECIAL PURPOSE NUCLEAR SYSTEMS OPERATION
VALLECITOS ATOMIC LABORATORY
P. O. BOX 846
PLEASANTON, CALIFORNIA

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THERMIONIC CONVERSION OF HEAT TO ELECTRICITY

June 30, 1964

General Electric Company

SPECIAL PURPOSE NUCLEAR SYSTEMS OPERATION

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I. INTRODUCTION AND SUMMARY

This is Volume I of the third technical summary and final report describing progress on the research and development program on thermionic conversion of heat to electricity under the Department of the Navy, Bureau of Ships contract, NObs-88578. The period covered by this report extends from October 31, 1963 to June 30, 1964. Volume I of this report describes the work performed under the Insulator Materials Development Task performed at the Vallecitos Atomic Laboratory and the Ceramic-to-metal Seals Task, performed at the Tube Department, Schenectady.

The work performed on the other major tasks under this contract are reported in Volume II of this report. These tasks include the Emitter-Collector Spacing Development Task, the Intercell Discharges Between Series-Connected Thermionic Converters Task and the UO_2-Refractory Metals Reaction Kinetics Task. These three tasks are reported in a separate volume due to the possibility of security classification.

A summary of work performed in each of the tasks reported in Volume I follows:

1) The electrical conductivity of Lucalox alumina has been measured under conditions representing the operational environment of a thermionic diode.

2) Tungsten and molybdenum based coatings have been developed, metallized to alumina and tested in cesium vapor

for over 2000 hours. Multilayered cermets were prepared but failed to prove electrically insulating. Alumina-to-nickel and alumina-to-niobium shim seals were prepared and tested for extended periods of time. The joining of various refractory metals to metallized alumina using diffusion bonding, brazing, and braze-diffusion bonding techniques were investigated. The cesium corrosion resistance of various materials and seals was determined at 1000°C.

II. INSULATOR MATERIALS DEVELOPMENT TASK - THE ELECTRICAL CONDUCTIVITY OF LUCALOX ALUMINA IN THE PRESENCE OF CESIUM

A. General

The proposed use of alumina insulators for nuclear thermionic energy converters has raised some interesting questions about insulator properties under extreme conditions. The environment of the converter is strongly reducing due to the presence of cesium vapor, which is in equilibrium with a liquid cesium reservoir at about 300°C. The insulators experience temperatures between about 100°C and 1500°C depending on the insulator location and the type of nuclear thermionic reactor. Potential gradients of at least one volt/mil are likely to be imposed across some of the insulators. In addition, the insulators must be chemically compatible with their neighboring materials and must maintain their desirable properties in the radiation field of a power reactor.[1]

The purpose of this study was to measure the electrical conductivity of a candidate material for nuclear thermionic insulation in the cesium and temperature environment of a converter. Another purpose was to determine the breakdown potential of the insulator in that environment. The material chosen for this study was Lucalox (brand) high purity alumina. Alumina was selected as the primary design material due to known desirable properties,[1] the advanced state of its fabrication art, and its successful use in laboratory thermionic devices.[2]

B. Summary

The electrical conductivity of Lucalox alumina has been measured in the temperature range 700 to 1250°C. The experimental arrangement approximated the environment of a thermionic diode; cesium vapor was present on one side of the alumina. Volt amp curves obtained across the 0.0307-inch thick sample show ohmic behavior over the full voltage range investigated (-150 to +400 volts). The observed conductivity of Lucalox alumina is similar to that reported for high purity polycrystalline alumina under reducing conditions. An activation energy of 3.55 ev was observed for the conductivity in the temperature range 1020 to 1250°C.

C. Experiment Specimen

Five tubes of Lucalox alumina were obtained from the Large Lamp Department, General Electric Company. A tube is shown in Figure II-1. The tubes were about 1/2-inch diameter, 0.030-inch wall thickness and 4 inches long. Each end was sealed to a niobium end piece which lead to a 1/8-inch niobium tube about 1 inch long. A 0.394-inch long niobium cylinder was placed in the center of the Lucalox tube to serve as one electrode. The other electrode was a 1.05-inch long coating of tantalum metal applied to the exterior of the tube by flame-spraying. Each tube was checked upon receipt for vacuum tightness by the He mass spectrometer method; all proved leak-free.

Two of the Lucalox tubes were ultrasonically cleaned in methanol and transferred into an argon glove box for cesium introduction. In the glove box, one of the 1/8-inch niobium tubes was inert-arc welded shut and liquid cesium was injected into the other

Ta Susceptor Electrode

Cs Vapor

Nb Insert Electrode

Mo Lead Wire

Lucalox Alumina

Cs Reservoir (Nb)
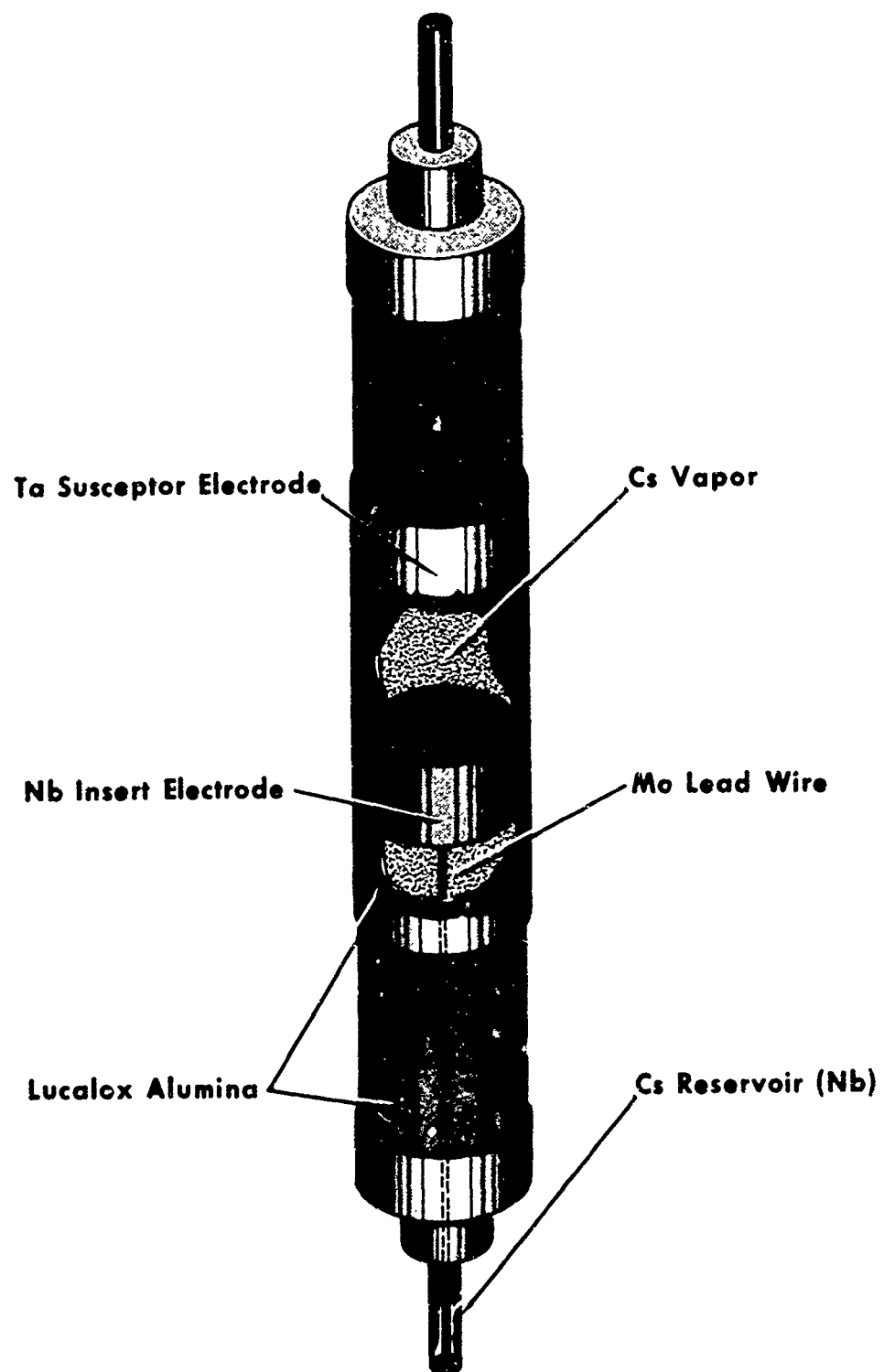
FIGURE II-1. LUCALOX ALUMINA CONFIGURATION
FOR CONDUCTIVITY EXPERIMENT
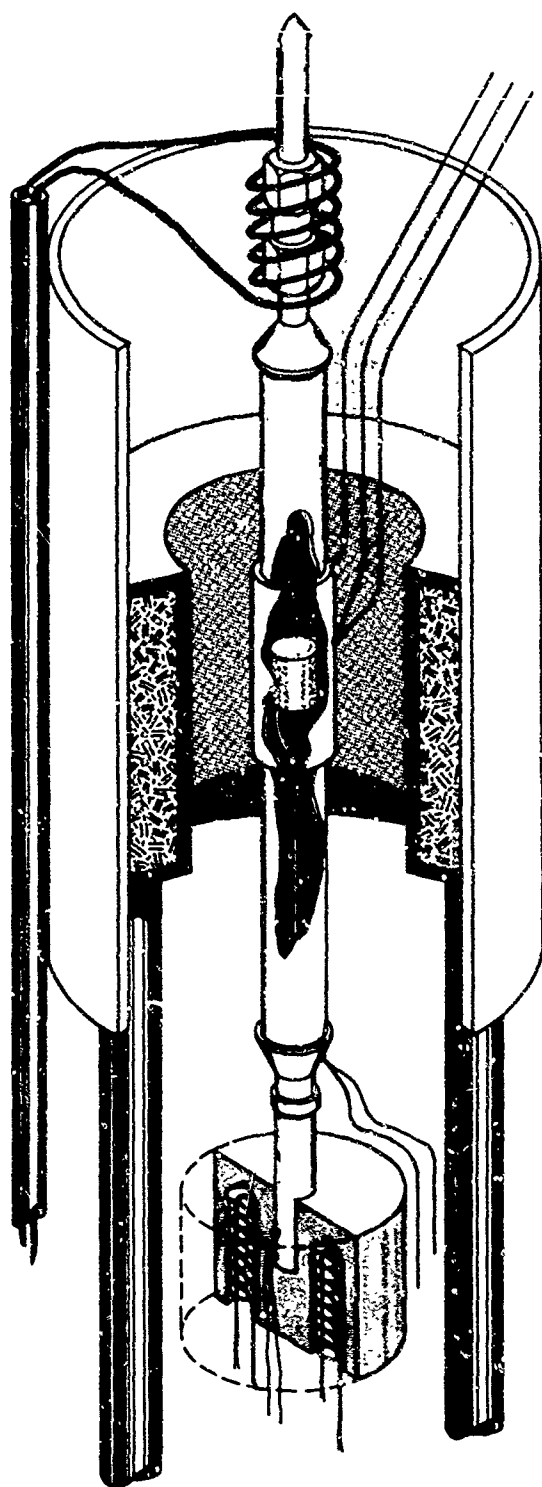
FIGURE II-2. INSTRUMENTED LUCALOX TUBE
INSIDE CURRENT CONCENTRATOR

II-4.

end. A Swagelok fitting connected the 1/8-inch niobium tube to a 1/4-inch tantalum tube. After evacuating each tube to less than 0.01 torr argon pressure, the Ta appendage was pinched off. To assure leak-tightness, the pinched area was beaded (welded) using the inert-arc torch. Following cesium introduction, each tube was placed in a helium-filled pressure chamber over night. Subsequent leak checking for helium showed the cesium-filled tubes to be leak tight.

Heaters were added to both ends of the tubes for the purpose of controlling the cesium pressure. The heaters consisted of platinum wire wrapped on an alumina base and covered with a Sauerizen cement. The lower heaters (cesium wall heaters) were imbedded in a copper block containing the 1/8-inch niobium well for cesium, to provide better temperature control. Thermocouples (Pt-Pt/Rh) were attached to the seal areas and to the cesium reservoir heater. A sheathed thermocouple was attached to the Ta electrode by wrapping several layers of Ta foil around the susceptor; the Ta sheath also was used as the lead to the outer electrode.

D. Experiment Procedure

The Lucalox tubes were heated by rf currents induced in the tantalum susceptor-electrode. A water-cooled copper current concentrator was utilized to direct the rf field into the susceptor and away from the metal ends of the tube. Figure II-2 illustrates the specimen and the concentrator. The assembly shown in Figure II-2 was placed inside a dynamic vacuum system which maintained the pressure between 10^{-6} and 10^{-5} torr during experimentation. Figure II-3 is a schematic illustration of

the electrical circuitry used for obtaining conductivity values. Only dc measurements were made; the technique is a 2-probe technique utilizing both potentiometer and electrometer current measurements.

Contact resistance of the tantalum-alumina interface was estimated to be less than 10^3 ohms from prior experiments. Contact resistance between the Nb insert and the alumina was much higher than 10^3 ohms in the absence of cesium. It was found that below about one torr cesium pressure, the observed current through the Lucalox was dependent on cesium pressure. For cesium pressures greater than about 10 torr, the measured current was independent of cesium pressure. Hence the contact resistance of the Nb-Cs vapor-alumina interface was not significant at high cesium pressures. The cesium pressure in the tube was determined by the temperature of the seal above the cesium reservoir. This was the coldest spot in the tube.

Conductivity was measured after an initial heating of each specimen to about 1500°C for about 4 hours. After this treatment, no significant changes in conductivity with time were observed for any given temperature and for times up to one hour. After a change in power input to the susceptor, about 3 minutes were required for temperature equilibrium to be obtained in the electrode area. Temperature equilibrium at the ends of the tubes was very slowly reached and generally was not obtained during the experiment; however, for high cesium pressures, temperature transients in the tube ends did not affect the measurements.
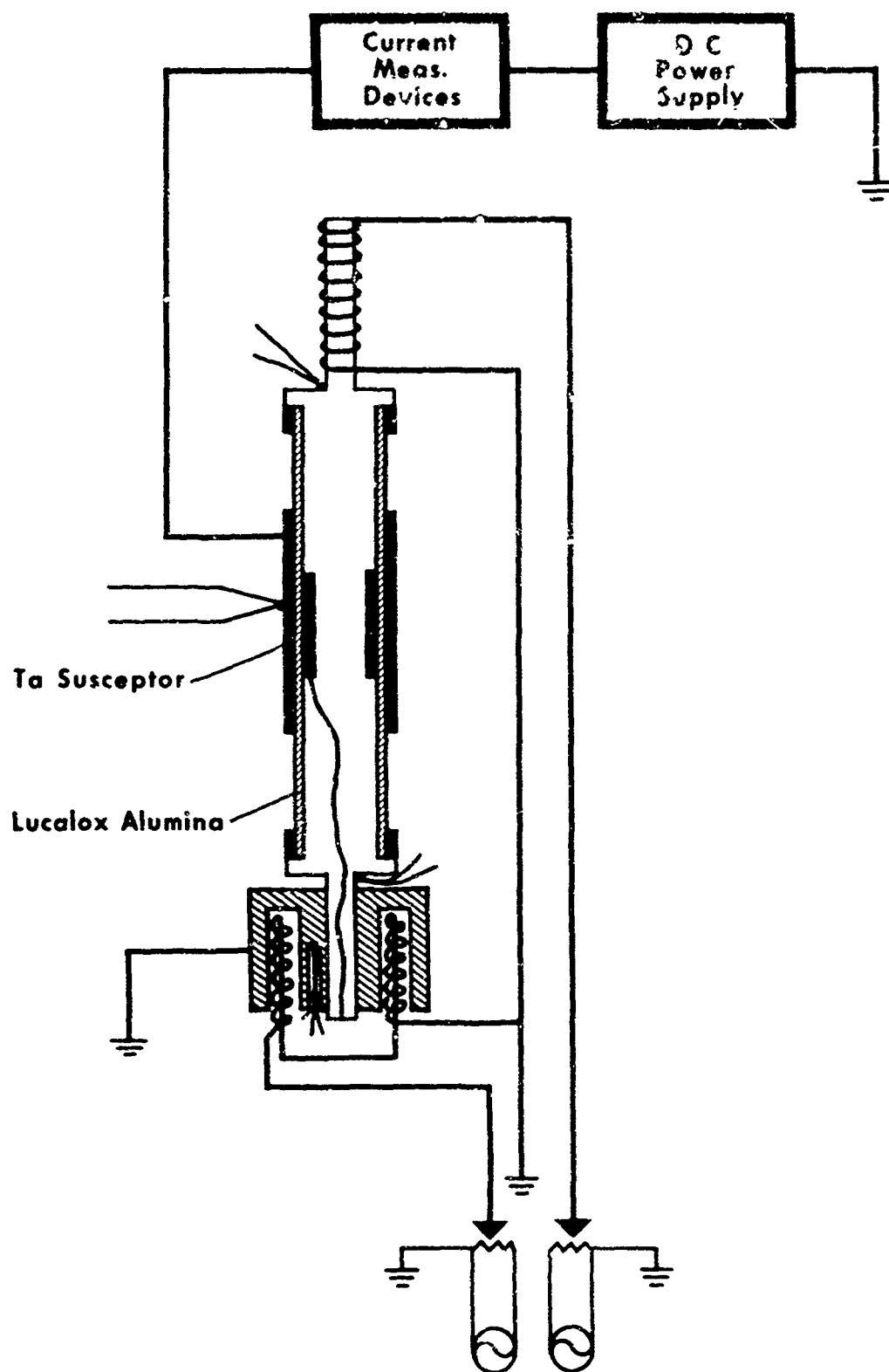
FIGURE II-3. SCHEMATIC OF CONDUCTIVITY EXPERIMENT

Currents above 10^{-7} amp were measured using a potentiometer and a 198 ohm resistor in series with the specimen. Between 10^{-10} and 10^{-7} amp, an electrometer was used. Below 10^{-10} amp, currents could not be measured reproducibly. The error in current measurement was less than 1% above 10^{-7} amp and about 20% between 10^{-10} and 10^{-7} amp. The observed resistance values are given in Figure II-4 for the two specimens. Points on Figure II-4 designated by a letter E are values determined using the electrometer.

The voltage across the specimen was varied between 0 and ± 6.7 volts using a precision rheostat and batteries; it was varied between -400 and +150 volts using a dc power supply with about 0.01% ripple. Some volt-amp curves are shown in Figure II-5. When the Ta electrode was made positive, a short transient effect was noted with each increase in voltage; the current across the specimen would rise to some initial value and then drop to about 1/2 that value over about 10 seconds (at 1250°C); no further change with time would occur. The curve in Figure 5 labeled 918°C shows non-ohmic behavior typical of that observed for low cesium pressures.

After the resistance measurements, tube #2 was sectioned and examined microscopically. The alumina wall thickness was found to be 0.0307" ± 0.0002". No solid-state reaction-phases were present in the alumina microstructure; much less than 1% porosity was observed. Spectroscopic analysis of the alumina tube #2 was obtained after the conductivity studies and the results are given in Table II-1. Tube #1 was neither sectioned nor analyzed.
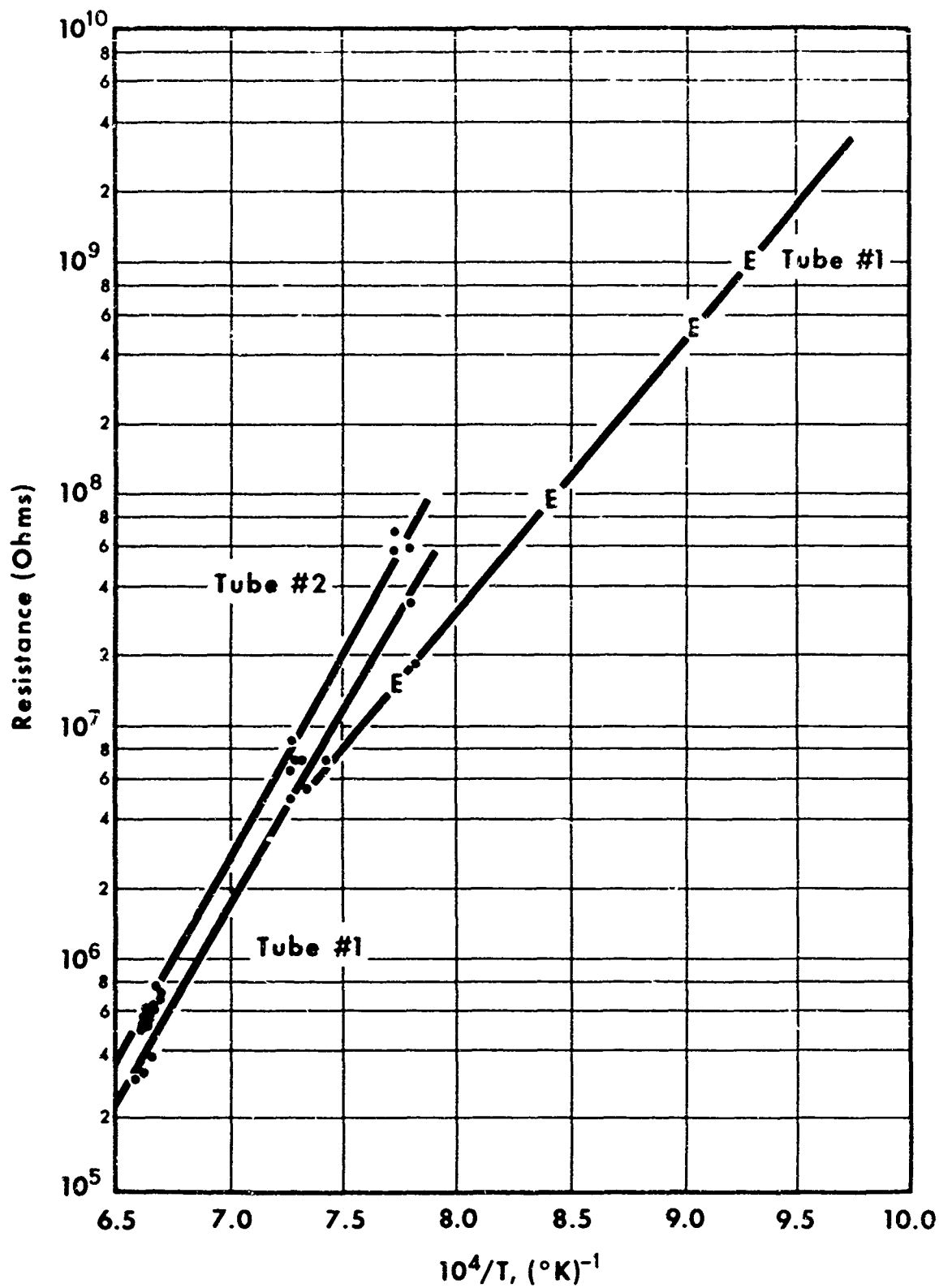
FIGURE II-4.   TEMPERATURE DEPENDENCE OF RESISTANCE
FOR TWO ALUMINA TUBES
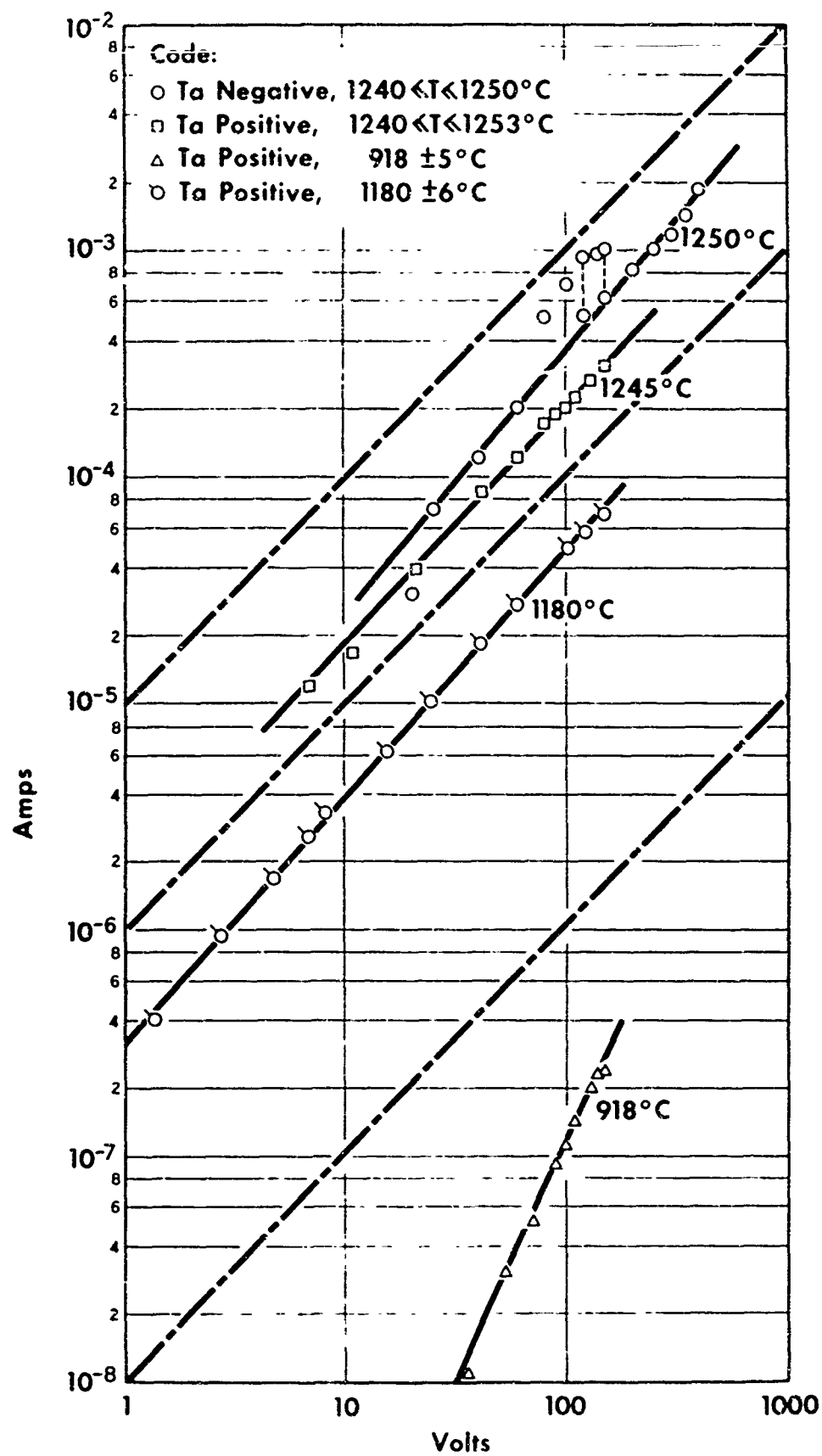
FIGURE II-5.   CURRENT VERSUS VOLTAGE ACROSS INSULATOR

TABLE II-1

Spectroscopic Analysis of Tube #2
After Conductivity Measurements

Material: Aluminum Oxide (solid)   Date of results: 4/22/64

Al	------------------		Major
Sb	------------------	<	10 ppm
B	------------------	<	10
Ba	------------------	<	10
Bi	------------------	<	50
Cd	------------------	<	100
Ca	------------------		10
Cr	------------------	<	1
Co	------------------	<	10
Cu	------------------		5
Fe	------------------		10
Pb	------------------	<	10
Mg	------------------		5000
Mn	------------------		1
Mo	------------------	<	10
Ni	------------------	<	10
K	------------------	<	10
Si	------------------		400
Ag	------------------	<	1
Na	------------------		50
Sn	------------------	<	50
Ta	------------------	<	10
V	------------------	<	10
Ti	------------------	<	10
Zn	------------------	<	50
Sc	------------------	<	10
Nb	------------------	<	100
Cs	------------------	<	1
Y	------------------	<	10
W	------------------	<	100

All data reported in parts per million

E. Effect of Temperature on the Conductivity of Lucalox Alumina

Resistivity values may be obtained from the data in Figure II-4 for
Tube #2 by multiplying the resistance values by 9.33. The resis-
tance data shown in Figure II-4 are characteristic of oxide insulators.
A comparison of the data obtained from the two specimens shows
the two to be essentially identical except for wall thickness and
perhaps relative impurity content. The data obtained in tube #2
using the potentiometer is of sufficient accuracy to allow giving
careful attention to the temperature dependence of the resis-
tivity. The resistivity is shown in Figure II-6 as a function of tem-
perature while the conductivity is shown in Figure II-7 in the usual
way for thermally activated processes.

The activation energy associated with the conductivity of Luca-
lox alumina (Figure II-7) is 3.55 electron volts between 1020 and
1200°C. The same activation energy (slope) was observed for
both Lucalox tubes in the high temperature regime of Figure II-4.
The low temperature activation energy from Figure II-4 is 2.32 ev.
The high temperature values are similar to those obtained by
Pappis and Kingery on polycrystalline alumina under 10^{-10} at-
mospheres oxygen pressure.[3] The temperature at which tran-
sition to the higher activation energy conduction mechanism
occurs was observed to be about 1520°C by Pappis and Kingery,
while about 1000°C was observed in this study. The difference
may be due to lower impurity concentrations in the present
specimens; however, Pappis and Kingery did not present de-
tailed analyses of their specimens for comparison.

Pappis and Kingery observed for single-crystal alumina a
maximum activation energy of 5.5 to 5.8 ev at high temperatures.[3]
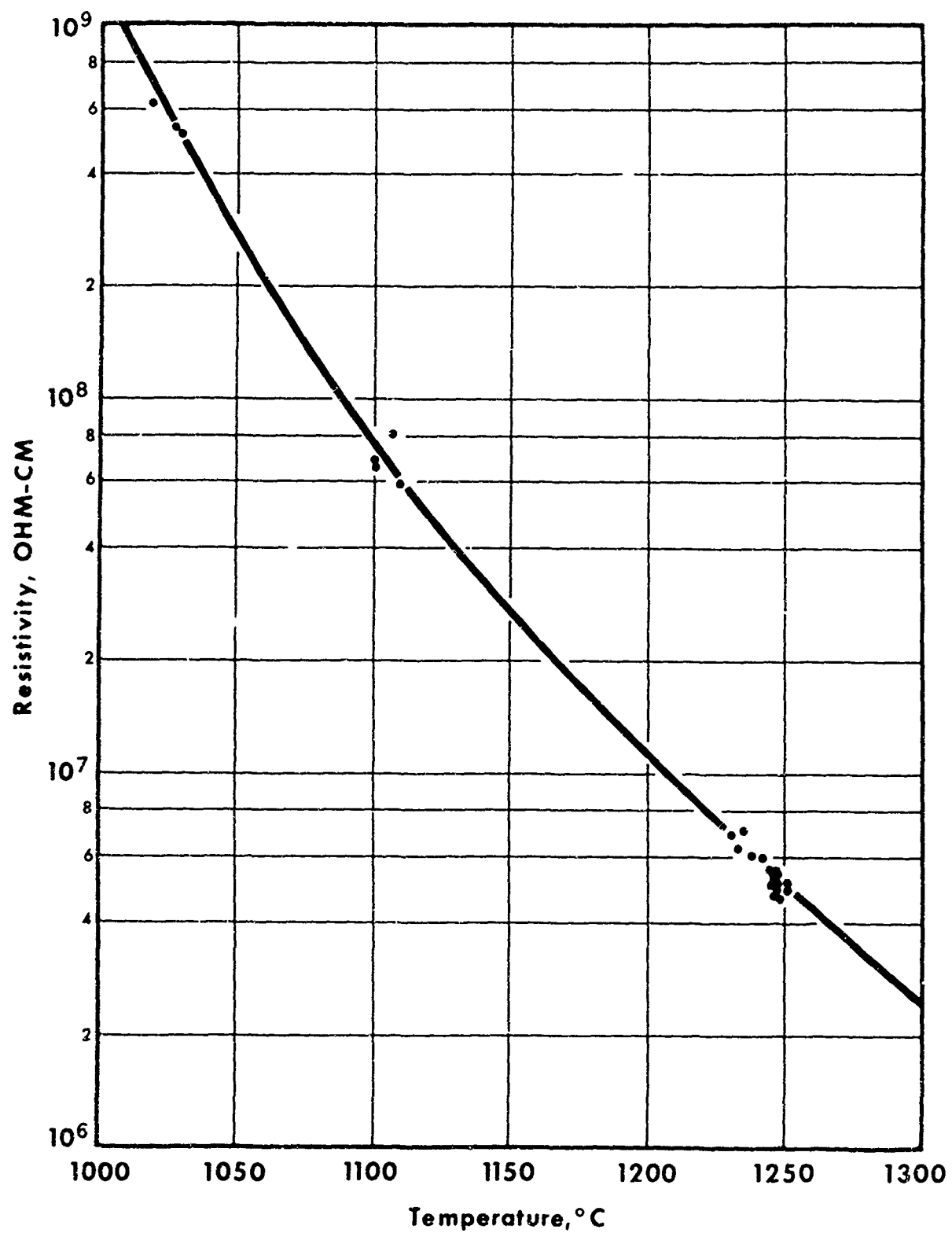
FIGURE II-6. TEMPERATURE DEPENDENCE OF RESISTIVITY
FOR LUCALOX ALUMINA
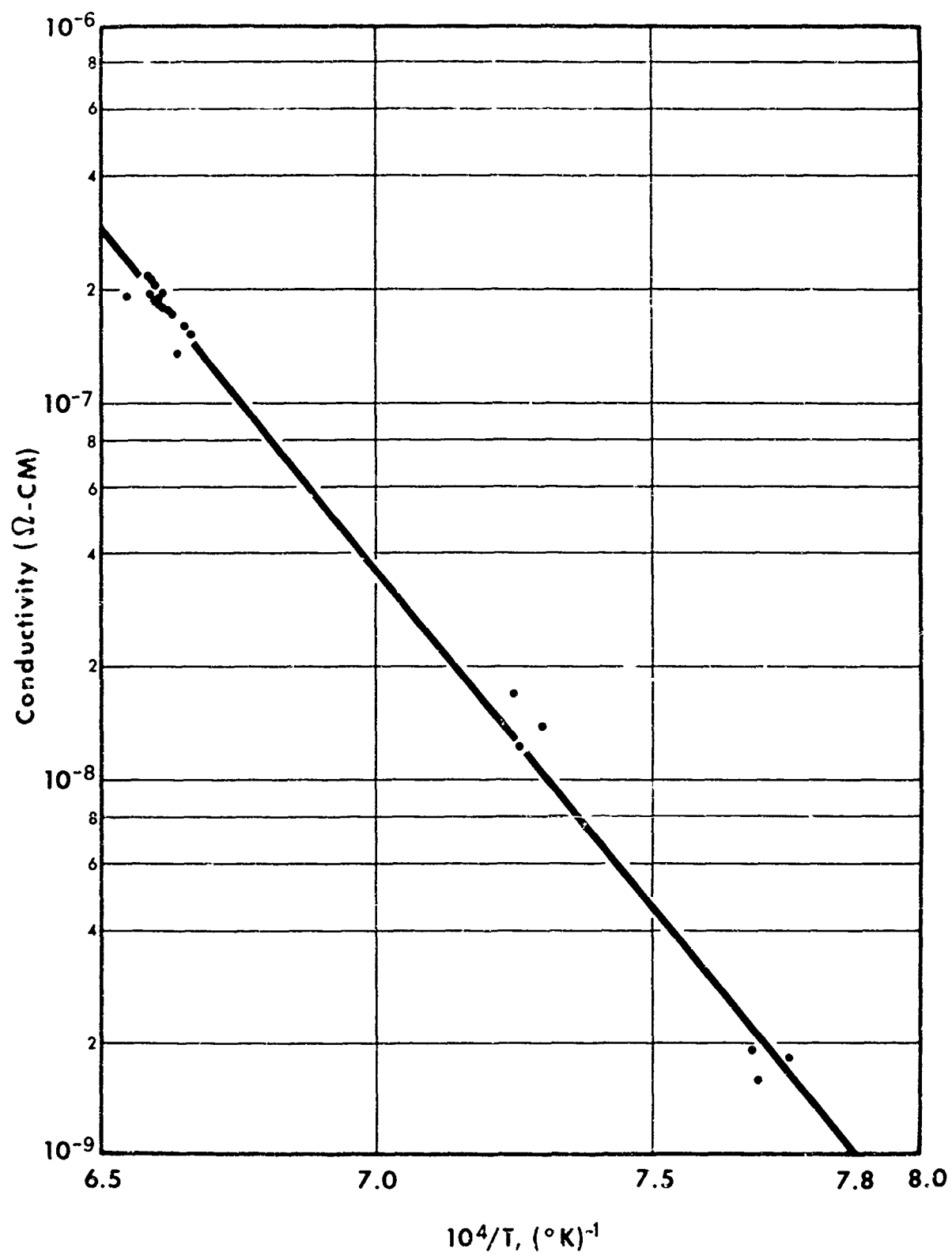
FIGURE II-7.   TEMPERATURE DEPENDENCE OF ELECTRICAL CONDUCTIVITY
FOR LUCALOX ALUMINA

Assuming this figure to be representative of intrinsic conduction a corresponding band gap of about 11 ev is found. Those authors found no activation energies higher than 3.6 ev for polycrystalline alumina with temperatures up to 1777°C. That observation is confirmed by the present study for temperatures up to 1250°C. The conductivity of polycrystalline alumina was apparently impurity dominated for both studies.

CHAPTER II
REFERENCES

1. L. N. Grossman, "Electrical Insulators and Spacers for Nuclear Thermionic Devices," GEST-2022 (1964).

2. "Survey of the State-of-Art in Thermionic Power Conversion Diode Utilization," GESR-2008 (1963), p. I-24.

3. J. Pappis and W. D. Kingery, "Electrical Properties of Single-Crystal and Polycrystalline Alumina at High Temperature," J. Am. Cer. Soc. 44 (9), 459 (1961).

III. CERAMIC-TO-METAL SEAL DEVELOPMENT

A. General

High-temperature tolerant, alkali metal vapor-resistant
ceramic-to-metal seals are needed for application in many
of the electrical power generating systems currently under
development. These systems include the nuclear fuel
heated thermionic converters developed under this contract,
solar and fossil fuel heated converters, as well as nuclear
turbo-electric power systems. Although a need exists for
$1500^{\circ}C$ tolerant seals, the present interest is in systems
capab. of sustained operation at temperatures up to approx-
imately $900^{\circ}C$ as an interim goal.

Two distincly different sealing techniques have come into
widespread use for sealing ceramics to metal for electronic
as well as mechanical applications: (1) active-alloy sealing,
and (2) refractory metal metallizing. In the former method,
a molten brazing alloy is suitably "activated" to impart cer-
amic wetting and bonding characteristics, thereby permitting
direct union of the ceramic and the metal members to be
joined. In the second method, a thin layer of powdered re-
fractory metal (usually with admixed metals or oxides) is
sintered to the surface of the ceramic to provide a metallic
layer to which a conventional braze can be made.

Work under a previous BuShips contract,[1] together with the
results of related programs, have shown that state-of-the-
art seals are not suitable for application in high-temperature
thermionic converters. Their inadequacy stems largely
from the use of vitrified high alumina ceramics (usually 94

percent to 99 percent alumina). Such ceramics contain silica, and it has been shown[1,2,3] that even very small amounts of silica cause the ceramic to undergo rapid attack by cesium vapor at temperatures above approximately 600°C. Hall et al[2] investigated the attack on a number of commercial alumina bodies at 750°C in a pressure of 10 Torr cesium. Of the many ceramics studied, only two (a 95 percent and a 98 percent alumina which were claimed by the manufacturer to be silica free) showed no degradation. Levinson,[3] on the other hand, observed during a study of seal and insulator problems in thermionic converters that "alumina is the most desirable insulator material and the principal current temperature limitation is imposed by the brazing processes rather than the insulator material." Cowan,[4] however, supports the observed deleterious effect of cesium on silica-containing, high-alumina ceramics, and stated, "The problem of resistance to cesium vapor may be minimized by avoiding the intentional use of silica in the ceramic. The limits of silica concentration have not been established but at temperatures below 1000°C, approximately one percent silica does not appear to be harmful. For the ultimate seal utilizing alumina and operating at 1200°C for 10,000 hours, it is probably wise to keep the silica content as low as possible." M. J. Slivka[1] found that of all the ceramics which he tested, including a commercial 99.5 percent alumina body, only pure sintered alumina ceramics (such as Lucalox* alumina and General Electric Schenectady

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*Lucalox is a General Electric trade name for a high-purity alumina ceramic

Tube Operation body A-976) were sufficiently resistant to cesium attack as to permit application at 900°C. Feingold,[5] in a study of cesium attack on silica-doped alumina ceramics, concluded that pure polycrystalline alumina was resistant to cesium attack at temperatures as high as 1500°C. The pure alumina- and silica-doped alumina bodies studied by Feingold were prepared in the Ceramic Laboratory of the Schenectady Tube Operation, Tube Department, and it is this same polycrystalline alumina (body A-976) which was found resistant at 1500°C, that has been the backbone of our seal development studies.

Another deficiency[4] of state-of-the-art seals lay in the common use of brazing alloys such as copper, silver-copper, gold-copper, and gold-nickel.... alloys which are lacking in the need for low vapor pressure and resistance to cesium corrosion. Few commercial brazing alloys are available which would be predicted to be cesium resistant and even fewer alloys have actually been tested.

Active alloy seals of the titanium hydride type are inadequate since they, too, generally utilize one of the noble metal brazing alloys referred to previously. Even ceramic-to-tantalum seals (bonded with a titanium-nickel alloy), which have been found so reliable in moderate temperature applications, were shown[2] to have an extremely short life at a temperature of 900°C due to embrittlement of the bonding alloy through continued reaction with the ceramic. Titanium shim seals to nickel, prepared so as to contain only $TiNi_3$ or nickel solid solution at the interface, were, however, so

successful on preliminary testing as to warrant further
evaluation and life testing.

Although additional study of the aforementioned alumina-to-
nickel seals constituted a portion of the program of seal
development and evaluation performed under this contract,
primary emphasis was placed upon two new approaches to
ceramic-to-metal sealing: (1) the development of multi-
layered cermet structures having an electrically insulating
core but with metallic surfaces, and (2) the development of
cesium resistant metallizing for pure alumina ceramics.
Both of these approaches required the development of a
brazing, welding, diffusion bonding or other joining tech-
nique to hermetically seal the metallic surface of the insul-
ator to the structural metal members of the converter.

Thus, the program of seal development and evaluation com-
prised five separate but related studies:

1.   Cesium resistant metallizing for pure alumina ceramics
2.   Multilayered cermets
3.   Active-alloy ceramic-to-metal sealing
4.   Metal-to-metal joining for high temperature, cesium-
      vapor environments
5.   Cesium corrosion testing of materials and seals.

This final technical report treats each of these studies separ-
ately, presenting further background information on the sub-
ject, results obtained and recommendations for future work.

This program of seal development and evaluation was performed by the Tube Technology Subsection of the Schenectady Tube Operation. The program was under the technical direction of R. H. Bristow, Senior Ceramist. Engineers responsible for specific tasks were: (1) multilayered cermets - R. D. Hanna, Ceramist; (2) cesium resistant metallizing - R. D. Hanna; (3) active-alloy sealing - R. H. Bristow; (4) metal-to-metal joining - K. P. Zeman, Metallurgist; and (5) cesium corrosion testing - K. P. Zeman.

B. Summary

Cesium Resistant Metallizing

Several refractory metal (molybdenum or tungsten) based coatings, containing calcia, magnesia, alumina or yttria as bonding oxides, have been developed for the metallizing of essentially pure sintered alumina ceramics (such as G-E body A-976). Sintering schedules which will yield strong, vacuum-tight coatings have been determined and flexural strengths as high as 35,600 pounds per square inch have been measured on brazed specimens. Similar specimens remained vacuum tight after heat treatment for 2020 hours at a temperature of $900^{\circ}C$ in vacuum, and withstood repeated thermal cycling to room temperature. Metallized specimens, brazed with cesium-resistant brazing alloys, were subjected to a 20 Torr cesium vapor atmosphere at $1000^{\circ}C$ for periods ranging up to 1000 hours and showed no detectable degradation.

Multilayered Cermets

The sintering behavior of a number of types of molybdenum
and alumina powders have been studied. Materials selected
from these studies have been incorporated in cermet com-
positions, containing from 5 to 75 volume percent (v/o)
molybdenum. Sintering cycles were established which pro-
duced vacuum-tight structures from these cermet powder
blends. Multilayered cermet specimens were prepared and
sintered to a vacuum-tight condition, but were not electrically
insulating. The necessity of using a very alumina-rich com-
postion as the core layer to prevent electrical conduction
greatly aggravated fabrication problems, making difficult
the production of a composite which was both vacuum-tight
and electrically insulating. Cold pressing, isostatic and hot
pressing techniques were utilized and further development
using these fabrication methods is recommended to achieve
the desired multilayer cermet properties.

Active-Alloy Sealing

The preparation of titanium shim seals of alumina-to-nickel,
and alumina-to-refractory metals using nickel buffer washers
was studied and sealing parameters were optimized. Alumina-
to-niobium seals using nickel foil to form a liquid phase at
the interface were also investigated. Specimens of each type
of seal were life tested at temperatures of $700^{\circ}C$, $900^{\circ}C$ and
$1075^{\circ}C$, and thermal cycle tested between room temperature
and $900^{\circ}C$.

At a life test temperature of $900^\circ C$, one-third of the alumina-to-nickel and alumina-to-refractory metal specimens had developed leaks (detectable by the helium mass spectrometer leak detector) by the end of 1370 hours. One group of specimens accumulated 2280 hours of exposure and was still vacuum tight. At a test temperature of $1075^\circ C$, the rate of failure markedly increased and one-half of the specimens had developed leaks by the end of 240 hours of exposure. The $TiNi_3$ layer initially present at the alumina-nickel interface disappears during high-temperature life testing due to solutioning by the nickel washer. Seals containing a nickel solid solution at the interface possess a lower mechanical strength which, coupled with the stresses induced by thermal expansion mismatch, causes failure at the metal-ceramic interface.

No failures were recorded among the alumina-to-niobium seals which were exposed to a temperature of $900^\circ C$ for 2020 hours or those which were tested at $1075^\circ C$ for 240 hours. The excellent thermal expansion match between alumina and niobium, the apparent stability of the nickel-niobium intermetallic which is formed at the interface, and the lack of hardening of the niobium, are undoubtedly responsible for their excellent behavior on high-temperature testing.

Metal-to-Metal Joining

The joining of molybdenum to itself, niobium, and tantalum was studied. It was assumed that the molybdenum would be

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present as a metallized coating on a pure alumina ceramic or as the metallic surface of a graded cermet. Diffusion bonding, high-temperature brazing, and braze-diffusion-bonding are the techniques that were considered.

Diffusion bonding of molybdenum-to-molybdenum using palladium and chromium as active diffusing metals was shown to be possible. A joint made with palladium was still vacuum tight after 500 hours of testing in 20 Torr cesium vapor at $1000^{\circ}C$.

High-temperature brazing with palladium alloys and with commercially available nickel and cobalt-based braze alloys was studied and vacuum-tight joints were produced. However, it was found that unless the palladium alloys were used very sparingly, they continued to react with the refractory metals. during testing, forming pores and, in the case of metallized ceramics, causing disruption of the metallizing. The nickel- and cobalt-based braze alloys were subject to brittle phase formation, due to reaction with the refractory metals. Even though vacuum-tight joints could be obtained by properly controlling the brazing cycle, the continued reaction which occurs during testing causes extensive brittle phase formation. The mechanical stresses imposed by thermal expansion mismatch can fracture such brittle phases, resulting in leakage paths through the joint.

Nickel braze-diffusion-bonding, which consists of initially forming a liquid by reaction of nickel foil with the surface of

a refractory metal member, followed by a holding period sufficiently long to absorb this liquid into the refractory metal, has been very successful. Bonds of molybdenum-to-molybdenum, niobium-to-molybdenum, and tantalum-to-molybdenum have been developed which are free of intermediate phases and therefore, should have remelt temperatures limited only by the structural members.

Molybdenum discs have been bonded to metallized ceramic rings and the resulting seals have remained vacuum tight after 500 hours exposure to 20 Torr of cesium vapor at 1000°C, and through 12 thermal cycles to 900°C in vacuum. Similarly prepared niobium-to-metallized-alumina seals have remained vacuum tight through the same test conditions. Tantalum discs nickel braze-diffusion-bonded to molybdenum rings have remained vacuum tight through 500 hours in cesium and tantalum washers bonded to metallized ceramics have remained vacuum tight through 12 cycles to 900°C in vacuum.

Cesium Corrosion Testing

Cesium corrosion resistance of various materials and seals was determined at 1000°C and 20 Torr cesium pressure. The test vessels were made of high purity alumina (G-E A-976) ceramic, while the end closure and cesium reservoir were made from high purity nickel.

The following metals, which are of interest in thermionic converter construction, were not attacked during exposure times ranging from 200 to 1000 hours: chromium, iron, nickel, niobium, palladium, platinum, and tantalum.

Other materials which did not exhibit cesium attack when exposed for 500 to 1000 hours were:

1. palladium based braze alloys (65-35 Pd-Co, 60-40 Pd-Ni, 54-36-10 Pd-Ni-Cr)

2. ultra-high-temperature titanium- and vanadium-based braze alloys supplied especially for refractory metals

3. commercially available nickel- and cobalt-based high-temperature braze alloys

4. commercially available alumina ceramic, Coors AD-995

5. metallizing coatings and metallizing bonding oxides developed under this program when applied to cesium resistant substrates

6. molybdenum-alumina graded cermets developed under this program.

Although the alumina-to-nickel active-alloys seals studied during this program were not attacked by cesium vapor, they developed leaks due to continued reaction of the braze with the seal components at $1000^{\circ}C$.

The following materials were found to be attacked by cesium vapor at $1000^{\circ}C$:

1. commercially available alumina ceramic, Silk City SC 95D

2. Coors metallizing applied to Coors AD-995 alumina ceramic

3.   silica containing metallizing (designated S-20) applied to cesium resistant G-E A-976 alumina ceramic

4.   commerically available chromium-alumina cermet, LT-1 (produced by the Haynes Stellite Division, Union Carbide Corporation).

C.   Cesium Resistant Metallizing

Introduction

The study conducted under this portion of the contract concerns the development of a silica-free metallizing for pure alumina ceramics. The need for such a technique and the problems involved in its development can be best understood by considering the chemistry of a state-of-the-art refractory metal metallizing process as currently practiced by many manufacturers of electronic devices.

In the now widely used molybdenum-manganese metallizing process, finely divided molybdenum and manganese powders are dispersed in a suitable organic vehicle and a thin coat of this suspension is applied to the surface of the ceramic. Following drying, the ceramic is heated in a wet hydrogen atmosphere at a relatively high temperature (1200 to 1600°C) to promote adherence of the coating to the ceramic. The metal surface thereby produced can be plated and brazed using conventional techniques.

Pure molybdenum does not react with pure aluminum oxide in the 1200 to 1600°C temperature range, and any adherence in such a system is assumed to be purely mechanical. (Studies

related to this point as well as other reactions during metal-
lizing have been reported by Cole.[6]) It is the manganese in
the above discussed coating, as well as the fluxing oxides
present in a so-called high-alumina ceramic, which promote
adherence. Consider the specific case of metallizing of a
high alumina body having a composition of 96 w/o (weight
percent) alumina and 4 w/o other oxides. During sintering
of the metallizing coating, the dew point of the hydrogen
atmosphere is maintained sufficiently moist to insure oxida-
tion of the manganese. The resulting manganous oxide then
reacts: (1) with alumina forming manganese-alumina com-
pounds, and (2) with the fluxing oxides of the ceramic, pro-
ducing a glassy phase which fills the interstices of the sintered
molybdenum coating and serves to strongly lock it to the cer-
amic. A photomicrograph of such a coating on a high alumina
ceramic is shown in Figure III-1. The reaction products
mentioned can be seen in this illustration.

Commercial alumina bodies often contain the same total alum-
ina content, but incorporate different fluxing oxides or different
ratios of these oxides. These differences not only change the
temperature at which the desired liquid phase is obtained but
may also produce melts with widely varying viscosities. In
cases where the flux content of a ceramic body is small or of
a refractory nature, oxides are usually added to the metalliz-
ing mix to produce the desired liquid phase for proper reaction.
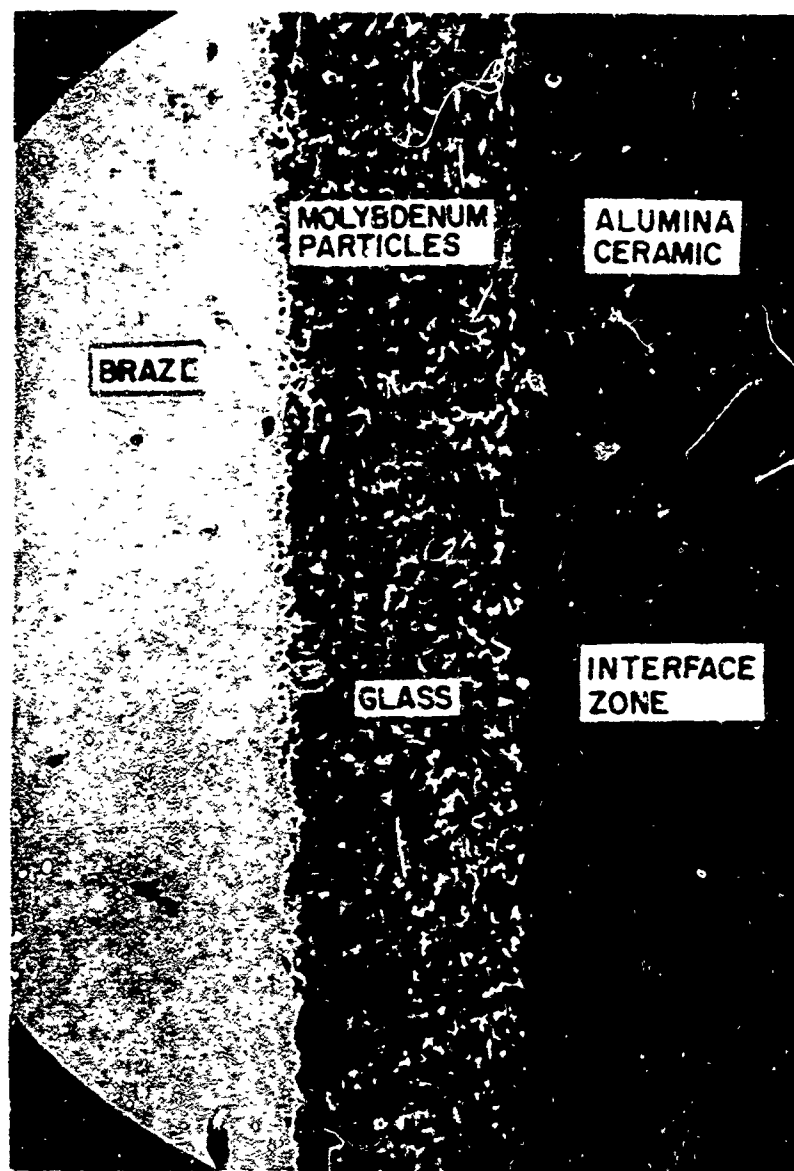
Figure III-1

Typical Metallized Ceramic

As mentioned previously, silica must be eliminated from a ceramic-to-metal sealing system which is to be exposed to high temperatures in a cesium vapor environment. An essentially pure. silica-free polycrystalline alumina ceramic, Schenectady Tube Operation body A-976, has been proven suitable for this application, and was used extensively in this ceramic-to-metal seal study. Since, a liquid phase for bonding purposes is not available from this ceramic short of its destruction; the metallizing composition must contain the oxides which will supply the needed liquid at the sintering temperature.

Selection of the Bonding Oxide

The liquid phase which is present in a molybdenum-manganese metallizing coating solidifies, during cooling, to a partially or predominately glassy material. With the bonding oxides considered for use in a silica-free metallizing composition, glass formation was not anticipated nor was it desirable. With the possible exception of the calcia-alumina system, glass formation is not common in the systems considered. If a glass were to be formed on cooling, there was a low probability of it remaining stable during subsequent high-temperature exposure of the seal, and consequent devitrification could cause failure of the metallizing-to-ceramic bond. Thus, it was desired to select a bonding oxide or oxides which, upon heating to the metallizing temperature, would form a strong, stable bond to the alumina as well as a strong bond (mechanical

and possibly chemical) to the sintered molybdenum particles. Such a "flux" should possess a viscosity during sintering which allows flow throughout the molybdenum matrix but which would not drain out of this structure through excessive reaction with the alumina body. Ideally, the reacted flux should consist of stable microcrystals of one or more phases which would have thermal expansion characteristics compatible with the alumina and molybdenum.

Included among the bonding oxide systems studied were $CaO-Al_2O_3$, $MgO-CaO-Al_2O_3$, $BaO-Al_2O_3$, Y_2O_3 and $Y_2O_3-Al_2O_3$. These are all refractory oxides systems which, from limited test data, appeared to be compatible with cesium vapor environment.

In a recent study[7] of ceramic-to-metal sealing mechanisms, it has been reported that a eutectic composition consisting of 41.5 percent CaO, 6.7 percent MgO, 51.8 percent Al_2O_3, when placed in contact with molybdenum and heated to $1600^\circ C$ in a forming gas atmosphere with a dew point of $+80^\circ F$, produces a contact angle of 10 degrees. This wetting is desirable but it does not necessarily insure a strong bond. However, it does indicate that conditions are favorable for distribution of the molten oxides through as well as the retention of the melt in the interstices of the molybdenum particles of a metallizing layer. Spectrographic analysis of the contact angle specimen, after being melted on the molybdenum, indicated that two percent of molybdenum was present in the

melt. Thus, apparently, a reaction took place between the oxides and the molybdenum, which might contribute to chemical bonding.

Baria has been reported to attack molybdenum when heated in a hydrogen atmosphere at 1600°C.[8] This reaction, if it could be controlled, might also assist in producing a strong bond to molybdenum.

Preliminary information relating to these oxide systems was obtained by blending various powder compositions, and pressing compacts which were sintered at various temperatures in a hydrogen tube furnace. Stability of the reaction products and the melting ranges of the various bonding oxide compositions were observed, and X-ray diffraction data were obtained on selected oxide melts. Information related to the chemical analysis of the initial powders as well as the preliminary test results has been reported.[9]

Ceramic-to-Metal Seal Preparation and Evaluation

Metallizing mixes were prepared by blending M&R Type P* molybdenum powder with bonding oxide raw materials in the proportion 60-70 v/o (volume percent) molybdenum, 30-40 v/o oxides. These powder mixtures were dispersed in an organic vehicle and milled for 144 hours in a high purity alumina jar mill. (This operation reduced the metal particle size as well as intimately blending all of the powders.) Then, after addition of an organic binder, the mixture was applied to the G-E A-976 alumina ceramic specimens using the screen process method.

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*M&R Refractory Metals, Inc., Springfield, N. J.

This method of metallizing mix preparation is preferred since a fine particle, homogenous mixture is obtained which can be applied uniformly. It does, however, consume time and material. In some instances, therefore, mixes were prepared by: (1) manually stirring the powders with the vehicle to form a thin paste, or (2) modifying a ball-milled mix by adding more oxides. Mixes prepared by these methods were suitable for the study of the reactions which occur during sintering but are not as desirable as ball-milled mixes for producing vacuum-tight seals, since uniform application of a coating is much more difficult.

The compositions which were studied in greatest detail, together with the leak check results obtained with various sintering treatments, are shown in Table III-1. Photomicrographs revealing the structure of the metallizing and reaction zone are shown in Figures III-2 and III-3. Sintering was performed in a dry hydrogen atmosphere tube furnace with a soak time of one hour.

Variations in sintering temperature cause different metallizing interface structures. For example, Figure III-2 shows metallizing mix No. 1 sintered at three different temperatures. In the $1680^{\circ}C$ sample, the interface is fractured; in the $1760^{\circ}C$ sample, the interface is slightly modified but intact; while the $1855^{\circ}C$ sample shows no apparent interface reaction zone.

In an attempt to identify the reaction products present after such sintering treatments, a series of samples were prepared

Table III-1

Ceramic-Metal Seal Results

Mix No.	Metallizing Oxide Composition No.	*Oxide Constituents w/o					**Sintering Temp.	***Leak Check Results Vacuum Tight	Leakers
		Al_2O_3	CaO	MgO	BaO	Y_2O_3			
1	26	51.8	41.5	6.7	-	-	1610	0	6
							1680	0	6
							1750	3	1
							1755	5	1
							1760	3	0
							1800	3	0
							1850	7	0
18	20	80	17	3	-	-	1700	0	3
							1750	0	3
							1800	0	6
							1850	3	0
							1900	3	0
21	47	95	4.3	7	-	-	1700	0	2
							1750	0	3
							1800	3	3
							1850	1	2
							1900	0	3
36	48	80	20	-	-	-	1700	0	3
							1750	0	3
							1800	1	5
							1850	3	0
							1900	3	0
54	44	60	-	-	40	-	1750	0	3
55	46	65	-	-	-	35	1800	3	0
							1850	2	1
							1900	3	0
56	-	-	-	-	-	2	1890	0	2
60	-	-	-	-	-	2	1890	2	1

*Bonding oxides comprise 30 to 40 volume percent of a mix, except in mixes No. 56 and No. 60 where only 2 weight percent was added.

**All sintering times were for one hour.

***These results include the flexural strength samples reported in Table III-3.
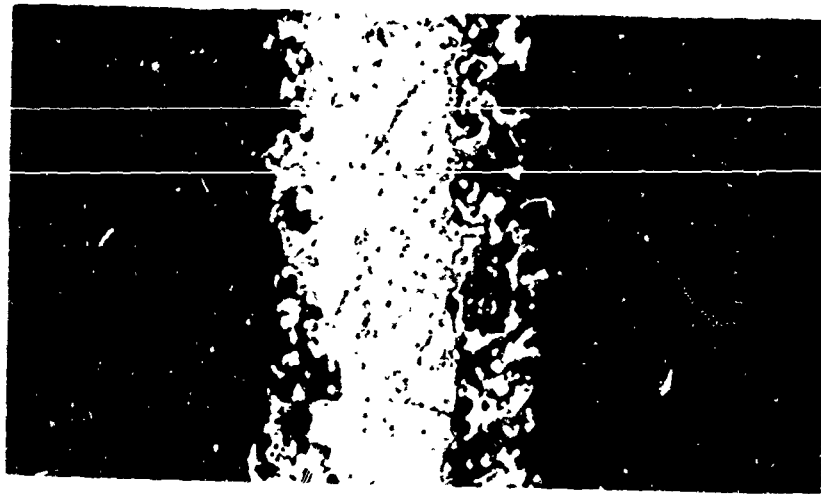
A 1680°C   Leaker
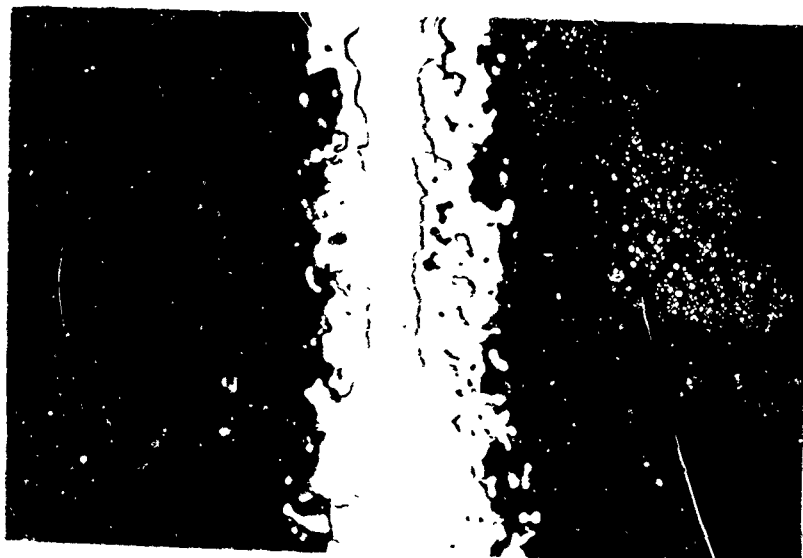
B 1760°C   Vacuum Tight
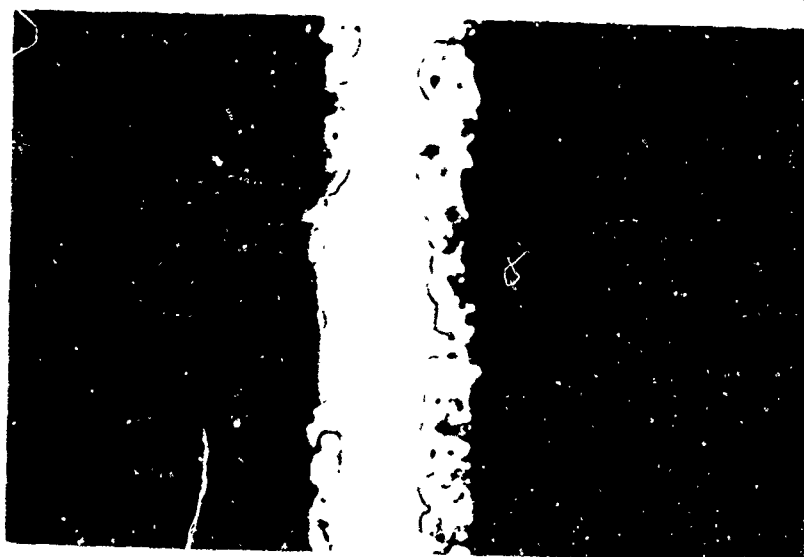
C 1850°C   Vacuum Tight

Figure III-2

Photomicrographs of Ceramic-to-Metal Seals (500X)

III-19

A   Mix No. 18   1800°C   Leaker

B   Mix No. 18   1900°C   Vacuum Tight
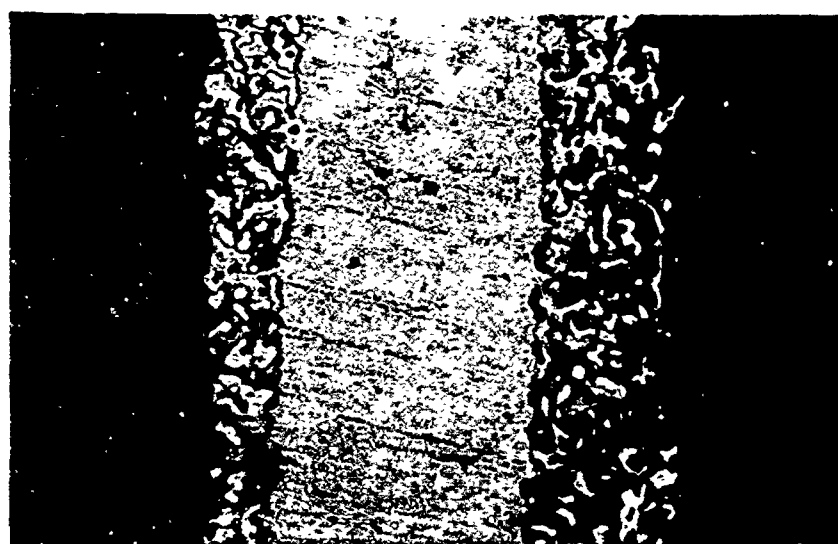
C   Mix No. 54   1750°C   Leaker

Figure III-3

Photomicrographs of Ceramic-to-Metal Seals (500X)

III-20

by coating the bonding oxides (excluding all molybdenum) on the ceramic surface. These samples were heat treated at various temperatures and the reacted surface analyzed using X-ray diffraction techniques. Results of these analyses are presented in Table III-2.

From the limited testing performed, it appears that the $CaO-Al_2O_3$ is undesirable (possibly because of a poor thermal expansion match) and that the $CaO-6 Al_2O_3$ reaction product may be the most desirable. The $CaO-6 Al_2O_3$ compound is isostructural with alpha alumina (not apparent in the photomicrographs).

It was observed that the metallized layer of high fired (1850°C) metallizing mix No. 1 is quite dense. This is attributed to the fluidity of the eutectic composition bonding oxide, which permitted good sintering of the molybdenum particles. It was theorized that the bonding strength of such a structure (where the molybdenum layer approaches a single sheet with a consequent reduction in mechanical interlocking to the substrate), might be less than that produced in a structure possessing more oxide constituent in the metallizing area. Metallizing mixes Nos. 18, 21 and 36 contain bonding oxide compositions having increased alumina contents in an attempt to impede densification of the metallic phase. Although a reduction in molybdenum particle sintering can be noted in the specimen shown in Figure III-3A (mix No. 18 - 1800°C sinter), it was not vacuum tight and failed at the interface. The higher

Table III-2

Bonding Oxide Reactions with A-976 X-Ray Diffraction Results

Oxide Composition No.	Reaction Temperature ($^{\circ}$C)	Phase Detected
26	1550	$CaO-Al_2O_3$
	1650	$CaO-2Al_2O_3$
	1750	$CaO-2Al_2O_3$
	1850	$CaO-6Al_2O_3$
44	1700	$BaO-Al_2O_3$, beta Al_2O_3
	1750	Beta Al_2O_3
	1800	Beta Al_2O_3
	1850	Beta Al_2O_3
46	1750	$3Y_2O_3-5Al_2O_3$, alpha Al_2O_3
	1800	Alpha Al_2O_3
	1850	Alpha Al_2O_3

sintering temperatures (1850°C and 1900°C) required to eliminate interface failures, produced leak tight samples with the structure shown in Figure III-3B. This coating is similar to that of mix No. 1 sintered at 1850°C (Figure III-2C) in that both are very dense and show no interface region. It appears that all four of these compositions, when sintered at 1850 to 1900°C, result in the same structure and composition. Strength results discussed later will show that the dense metallizing was not weak as feared, but actually produced excellent strengths.

Metallizing mix No. 54 (Figure III-3C) did not produce leak-tight seals. Porosity in the metallizing resulted from the baria instability and adequate sintering of the molybdenum did not occur.

Metallizing mix No. 55 (Figure III-4A) yielded excellent results. A desirably dense metallizing with no apparent interface was produced even at 1800°C.

It was reported by Cowan,[4] that a tungsten - 2 weight percent yttria metallizing produced good ceramic-metal seals. Mix No. 60 represents this composition while mix No. 56 represents a molybdenum counterpart. The leak check results given in Table III-1 should be considered in light of the fact that the nickel plate (0.1 mil) usually applied prior to copper-gold brazing had been omitted on these parts. It should be noted that the usual 30-40 v/o bonding oxide is not present in these two mixes. Mix No. 56 (Figure III-4B), with

A Mix No. 55 1800°C Vacuum Tight

B Mix No. 56 1890°C Vacuum Tight
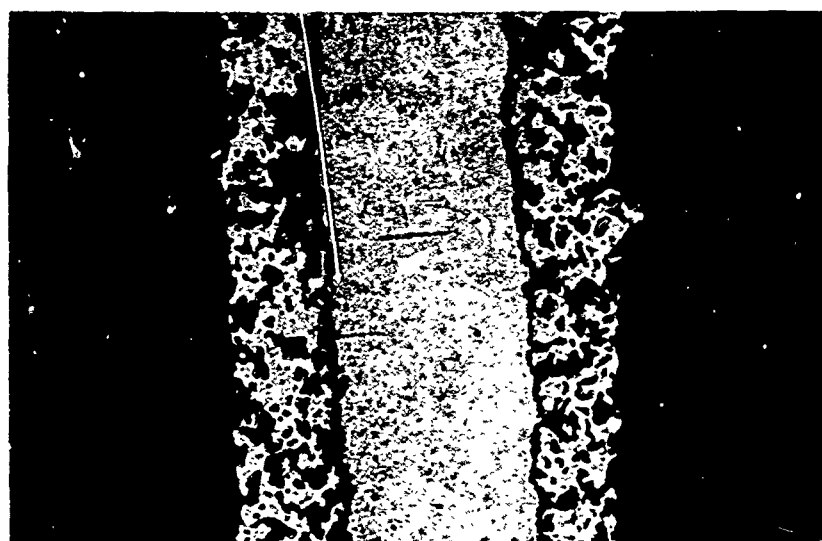
C Mix No. 60 1890°C Vacuum Tight

Figure III-4

Photomicrographs of Ceramic-to-Metal Seals (500X)

approximately 5 v/o oxide, produced a very dense structure as a result of the reactivity of molybdenum and the low percentage of bonding oxide. Mix No. 60 (Figure III-4C), with approximately 10 v/o oxide, and the more refractory tungsten powder produced a dense two-phase metallizing. Interfacial compounds were not noted in either case. Further evaluation of these compositions is recommended.

A number of flexural strength samples were prepared using the G-E A-976 ceramic and copper-gold brazing. The results displayed on Table III-3 show that the strengths compare well with those reported by Bristow[9] for active alloy seals. Several of the samples which had low strengths and were leakers failed in the braze joint and the data, therefore, are of questionable value. The mix No. 36 - 1800°C series, however, fractured at the metallizing-ceramic interface. All leak tight samples failed at the interface with varying quantities of ceramic also being torn loose.

High-Temperature Life Testing of Ceramic-to-Metal Seals

Seven copper-gold brazed ceramic-to-metal seals using metallizing mix No. 1 sintered at temperatures ranging from 1755 to 1855°C were placed in a vacuum chamber and heated to 900°C for 2020 hours. These samples were cycled to room temperature every 240 hours; all samples remained leak tight after this testing.

Thermal cycle testing was conducted to evaluate vacuum tight seals which had been prepared incorporating metallizing mix

Table III-3

Flexural Strength Results

Mix No.	Sintering Temperature (°C)	Leak Check Results	Strength (psi)
1	1750	Tight	25,200
		Tight	23,200
		Leaker	19,350
	1800	Tight	19,350
		Tight	20,100
		Tight	23,200
	1850	Tight	23,200
		Tight	34,800
		Tight	27,100
18	1800	Leaker	11,600
		Leaker	10,070
		Leaker	12,400
	1850	Tight	25,200
		Tight	31,000
		Tight	27,100
	1900	Tight	22,400
		Tight	23,200
		Tight	34,000
21	1800	Leaker	3,870
		Leaker	1,935
		Leaker	3,100
	1850	Tight	30,200
		Leaker	5,800
		Leaker	8,510
	1900	Leaker	7,740
		Leaker	18,600
		Leaker	16,250
36	1800	Leaker	17,000
		Leaker	12,400
		Leaker	6,190
	1850	Tight	31,700
		Tight	31,000
		Tight	31,700
		Tight	27,900
	1900	Tight	27,100
		Tight	35,600

No. 1 and cesium resistant braze alloys. Four ceramic-to-ceramic seals brazed with Palco (65 w/o Pd - 35 w/o Co)* remained vacuum tight after 12 cycles from room temperature to 900°C. Six vacuum-tight ceramic-to-metal seals, which incorporated a nickel braze-diffusion-bond between refractory metals and metallized ceramics, also passed this test. Three of these latter samples were joined to 0.010-inch thick molybdenum, two to 0.010-inch thick tantalum and one to 0.015-inch thick niobium. Additional data on the joining techniques and the seal test results are presented in the sections entitled "F. Metal-to-Metal Joining" and "G. Cesium Corrosion Testing".

Alumina bodies G-E A-976 and Coors AD-995** were metallized with mix No. 1 and subjected to a 20 Torr cesium vapor atmosphere at 1000°C for periods ranging up to 1000 hours. No apparent degradation was noticeable. These test results are detailed in the section entitled "G. Cesium Corrosion Testing."

Conclusions and Recommendations

Several refractory metal metallizing compositions have been developed which produce strong, vacuum-tight alumina-to-metal seals that are compatible with a high-temperature cesium vapor environment.

Additional testing is required to select the particular metallizing composition and processing treatment which, in conjunction with a cesium-resistant braze material, will produce the strongest, most reliable sealing system for this application.

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*Western Gold and Platinum Co., Belmont, Calif.
**Coors Porcelain Co., Golden, Colo.

D. Multilayered Cermets

Introduction

A new but quite promising approach to the development of very high-temperature tolerant, cesium resistant ceramic-to-metal seals was investigated under this contract. It comprises joining the metallic members of the device to the surfaces of a multilayered or graded cermet, the cermet consisting of an insulating oxide core with integrally bonded metallic surface layers. The structure may grade smoothly in composition from a predominately oxide core to a predominately metallic surface, or it may occur in discrete steps or layers. In either case, it is important that the composition gradient be such that, in systems where the metal and oxide possess different thermal expansion coefficients, internal stresses are minimized.

For purposes of this discussion, a cermet shall be defined as a "heterogeneous combination of metals or alloys with one or more ceramic phases in which the latter constitutes approximately 15 to 85 percent by volume and in which there is relatively little solubility between metallic and ceramic phases at the preparation temperature."[10]

The system which was chosen for initial study and evaluation is a two-phase system....aluminum oxide and molybdenum metal. The choice of this system was based upon the high-temperature stability, low vapor pressure, resistance to cesium attack, and freedom from phase transformations of

the two materials and their known compatibility at high temperatures.

Many cermet systems have been studied during the past twenty years with useful structures and a knowledge of bonding mechanisms evolving simulataneously. One of the first cermet systems to receive attention was chromium-alumina, and useful compositions containing from 30 to 77 w/c chromium have evolved. It is fortuitous that the thermal expansion of chromium closely matches that of alumina, thus minimizing stresses, and that chromium has a stable oxide which is soluble in alumina, leading to good bonding. Shevlin[11] and Marshal[12] have presented an excellent summary of the developments which led to the availability of present commercial materials.

Figure III-5 shows a polished section of a sample of the chromium-alumina cermet, LT-1, produced by Haynes Stellite Division of Union Carbide Corporation. The white areas shown in the illustration are molybdenum while the gray areas are alumina. The fine grained, essentially pore free structure of this 77 w/o chromium cermet can be seen. This sample was found to be vacuum tight (at 0. 100-inch thickness) and, as would be expected, was electrically conducting.

Chromium is not, however, believed to be a desirable major constituent of cermets destined for high-temperature vapor thermionic converter applications. Not only does chromium
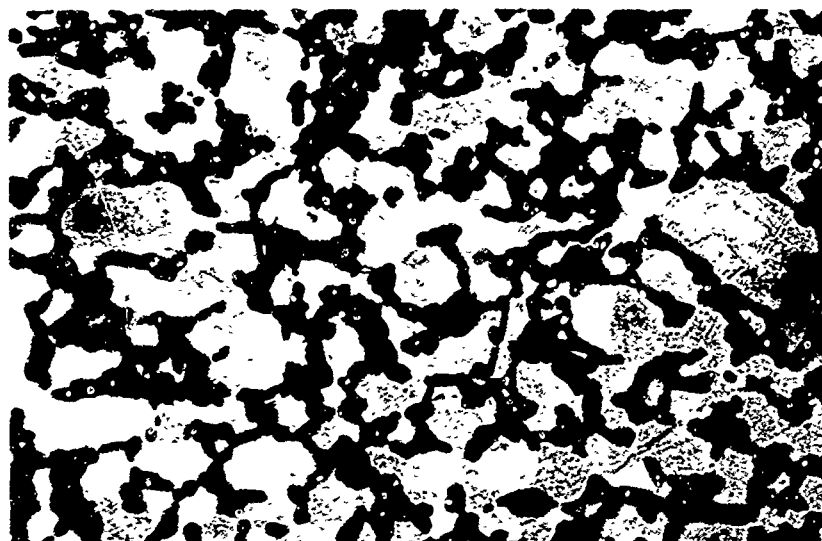
Figure III-5

Section of LT-1 Chromium-Alumina Cermet

have an undesirably high vapor pressure at the temperatures of interest (10^{-6} Torr at 977°C, 10^{-5} Torr at 1062°C) but its oxide is not stable in vacuum at these temperatures. It is possible, of course, that alloys containing small amounts of chromium may be tolerable.

The presence of chromium oxide has previously been considered important in establishing a strong bond in the chromium-alumina cermet. Specimens are said to be relatively weak and porous if oxidation of the chromium, forming the solid solution with alumina, is not established. Cermets containing refractory metals, such as molybdenum and tungsten, combined with chromium and alumina, have also yielded successful structures. Although these cermets have not been developed for vacuum retention applications, the densities reported are very near theoretical for several of the compositions and there is a good probability that the structures are vacuum tight. Recently[13] an alumina-molybdenum cermet, containing no chromium, was reported for use as a structural refractory possessing good thermal shock resistance. This material was said to possess a high strength and density, but no information was presented as to its vacuum tightness.

The formation of a strong, stable bond between the ceramic and metallic phases of an alumina-molybdenum cermet was initially considered to be a potential problem area. Although vacuum tight structures had already been demonstrated, as will be detailed later, the strength of the bond and its long

III-31

time, high-temperature stability had yet to be more exhaustively assessed.

The development of multilayered ceramic-to-metal seals produced by powder pressing techniques has been reported,[14] Vacuum tight structures were obtained using a modified 85 percent alumina ceramic sintered simultaneously with a tungsten-copper-nickel-chromium metallizing. Although many of the materials used in that development are not of interest in the present work, many of the processing considerations are similar.

Results and Discussion

A major problem in the fabrication of multilayered or graded cermets is the preparation of a series of alumina-molybdenum mixtures which will .. sinter at the same rate to near theoretical density at a chosen temperature, and which will have substantially identical sintering shrinkages. Thus, if end members of the series (molybdenum and alumina) can be found which exhibit the same shrinkage rate and total shrinkage, there is a good probability that blends of these powders will do likewise.

Company-sponsored work prior to initiation of this contract showed that the sintering of alumina-molybdenum mixtures to near theoretical density was feasible and, although graded cermets were prepared therefrom, the differential shrinkage of the several layers resulted in bowing of the specimen. The observed excessive distortion of multilayered compacts

prompted a study of the densification behavior of several
types of alumina and molybdenum powders for the purpose
of selecting several "matched" systems for subsequent cer-
met preparation. Chemical analyses and partical size mea-
surements (when available) of these powders were reported
in an earlier Technical Summary Report.[9] Compacts of
these powders were cold pressed (3/8-inch diameter die) at
several pressures and sintered at various temperatures in
a high-temperature hydrogen atmosphere tube furnace.
Firing shrinkage, apparent specific gravity, water absorp-
tion and apparent porosity measurements were made on these
specimens and the results, along with photomicrographs
showing the microstructure of these materials, were pre-
sented in the earlier report.

These preliminary sintering studies showed that dense, leak-
tight structures could be obtained by sintering at temperatures
in the 1800 to 1900°C range for four hours. All of the alumina
powders contained 1/4 w/o of $MgCO_3$ to inhibit grain growth
during sintering.

Measured shrinkage values showed that the M&R Type P
molybdenum had a total shrinkage similar to the A-14 alum-
ina powder.[*] The Linde A alumina[#] and G-E Type 61-8-1
molybdenum[+] were also well matched. Further studies were,
therefore, centered around these two combinations of powders.

Blends of 75 volume percent (v/o) metal, 50 v/o metal and
25 v/o metal, with the remainder alumina were prepared from

the two powder combinations mentioned. Compacts prepared from these powder blends were sintered at 1745°C for three hours. As reported in the previous Technical Summary Report all samples made from the fine powders (Linde A alumina - G-E molybdenum) were vacuum tight while the M&R molybdenum - A-14 alumina combination were still porous. Subsequent sintering studies showed that sintering in the 1850-1900°C range produces leak tight samples from all of these powder blends.

The next step was to fabricate the multilayered or graded cermet structure. Five layered compacts grading from a metallic-rich surface to an alumina-rich core and back to a metallic-rich surface were pressed, prefired at 1000°C, a hole drilled through a cylinder to permit leak detection, and then sintered. The photomicrograph shown in Figure III-6 details such a multilayered cermet structure. One half of the cermet is shown and the effect of die wall friction during pressing is obvious. Although this cermet was leak tight, it was not electrically insulating. This sample was subjected to high-temperature cesium vapor testing with no apparent attack noted (see section entitled "G. Cesium Corrosion Testing" for a description of this test).

During earlier work performed on Company funds, sintered compacts were produced from a blend of 75 v/o Linde A alumina and 25 v/o G-E No. 877 molybdenum*which were electrically insulating. During the present study, however,

*General Electric Lamp Metals and Components Dept., Cleveland, Ohio
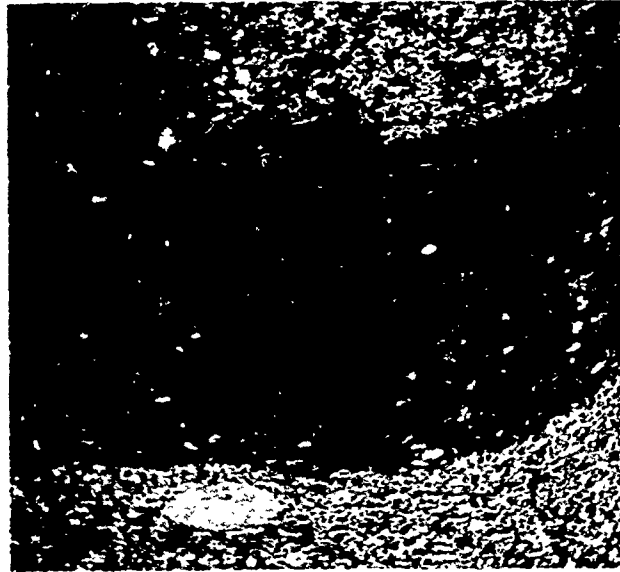
Figure III-6

Multilayered Cermet Structure.   Linde A Alumina M&R
Molybdenum Sintered 3 Hours at 1860°C.   Vacuum Tight.
(13X)

all of the specimens which were prepared using this metal-oxide ratio were conducting. Although various types of alumina and molybdenum were used (including Linde A alumina and G-E No. 877 molybdenum) and several blending techniques were tried, the earlier results could not be duplicated. Uniform dispersion of molybdenum and alumina was noted in the metallographic specimens and the reason for their conductivity was not obvious.

In order to produce an insulating layer in a cermet structure a 95 v/o alumina - 5 v/o molybdenum blend was used, resulting in a multilayered structure which did not conduct electricity. The necessity of using a very alumina-rich powder blend to prevent conduction greatly aggravated fabrication problems making production of a vacuum-tight multilayer cermet extremely difficult.

Fabrication of the multilayered cermet structure is complicated by several factors. Loading of the die with uniformly thick layers of the several powder blends is important if nonuniform compaction and shrinkage is to be avoided. The usual problems of interparticle friction, die wall friction, and air entrapment during cold pressing are also present. This is particularly evident with the fine Linde A powder blends.

The total sintering shrinkage is not exactly the same for all powder blends at a given pressing pressure and the possibility of these pressed layers shrinking at different rates also

exists. Additional sintering studies, with results shown in Table III-4, were conducted to further clarify the sintering shrinkage problem. Differences in the rates of sintering do not appear to be as great as the approximately two percent difference in total shrinkage which exists between various compositions in the multilayer composite at any given time during the sintering cycle.

Cracking of the multilayered compacts is sometimes apparent after pressing while other samples appear sound until after the prefiring or sintering operations. The cracks generally occur adjacent to the highest alumina content layer and are believed to be formed during pressing. Cracking was not caused by thermal shock since batch type sintering experiments did not eliminate this defect. Although the difficult-to-press Linde A powder could be successfully isostatically pressed, this same technique did not yield sound, one-piece multilayered specimens. The addition of various lubricants to the powders was investigated but they did not eliminate the formation of cracks in either dry or isostatically pressed specimens.

Hot pressing is a fabrication method which minimizes some of the compaction difficulties inherent in cold pressing since sintering and densification is assisted by the application of external pressure. Other problems are, however, present, including probable graphitization of the surface of the piece, high mold cost and a high unit cost. Nevertheless, the

Table III-4

Cermet Sintering Shrinkage

| | Pressure (tons/in^2) | Sintering Time at 1900°C | | | |
		10 Min.	30 Min.	1 Hr.	3 Hrs.
75 v/o Mo	15	19.1	21.3	21.9	22.9
25 v/o Al$_2$O$_3$	20	18.2	20.1	20.3	21.3
	25	17.4	18.6	18.7	19.5
50 v/o Mo	15	20.5	22.3	23.7	24.6
50 v/o Al$_2$O$_3$	20	19.5	21.2	21.1	22.7
	25	17.0	19.5	20.4	21.3
25 v/o Mo	15	21.1	22.7	23.5	23.5
75 v/o Al$_2$O$_3$	20	19.9	20.9	22.1	22.5
	25	19.1	20.8	21.1	21.3
5 v/o Mo	15	21.5	22.5	22.7	22.7
95 v/o Al$_2$O$_3$	20	20.3	21.7	21.9	-
	25	19.9	20.7	21.1	-

NOTE: 1. M&R Type P molybdenum powders and Alcoa A-14 alumina powders were used in the above cermets.

2. Sintering shrinkage is expressed in percent based on the fired dimension.

application of hot pressing to this problem was assessed and a multilayered cermet was fabricated using this technique. The powders were placed in an induction-heated graphite die and sintered at 1600°C for 10 minutes with a continuously applied pressure of 4000 pounds per square inch. This heat treatment appears inadequate to produce a dense alumina structure and cracking of the compact also occurred. This approach to multilayer cermet fabrication does, however, appear encouraging and should be continued.

Conclusions and Recommendations

Cermets composed of alumina and molybdenum with widely varying oxide ratios have been prepared which are structurally strong and vacuum tight. Fabrication of a multilayered or graded cermet structure which is both vacuum tight and electrically insulating requires the development of improved fabrication techniques including the study of lubricants for cold pressing, isostatic pressing techniques and control of hot pressing parameters.

E. ## Active-Alloy Sealing

Introduction

Several types of active-alloy seals were investigated and their tolerance to high temperatures was assessed, a task which comprised approximately one-sixth of the total effort under this contract. Seals were prepared by the "active metal shim" process introduced by Beggs.[15] In this process, a thin metal foil member (shim) is interposed between the metal and the

ceramic to be sealed. Upon heating to the eutectic temperature of the particular binary alloy system under consideration, a liquid phase is formed which wets and bonds to the ceramic. The "active" metal may comprise either the massive metal member or the foil, since it is only necessary that the liquid contain a small percentage of the active metal in order to reduce the solid-liquid interfacial energy thus permitting wetting to occur.

Under a previous contract,[1] an evaluation was made of the high-temperature capability of alumina-to-metal seals bonded with titanium-nickel alloy; seals wherein the metal member comprised titanium, tantalum, stainless steel, Kovar, or nickel. Summarizing briefly, it was found that seals which contained a titanium phase (α or β solid solution), either in the sealing alloy at the interface or as the metallic structural member of the seal, exhibited very short lives when tested at high temperatures in vacuum. Seal failure resulted from severe hardening and embrittlement of the titanium phase and/ or the formation of new phases at the interface, due to continued reaction of the sealing alloy with the ceramic. For a detailed discussion of the experimental procedure and results obtained, the reader is referred to the final report on that contract.

Preliminary evaluation of titanium shim seals to nickel, prepared so as to preclude the formation of alpha titanium or the brittle intermetallic Ti_2Ni in the sealing alloy (conducted

under Contract NObs-86220), indicated improved high-temperature tolerance. A more thorough study of the metallurgy of such seals, as well as their resistance to high-temperature vacuum and cesium-vapor environments, is reported herein.

In addition, the results of a brief study of alumina-to-niobium seals, effected through the formation of an "active" nickel-niobium alloy at the ceramic-niobium interface, is reported.

Experimental Procedure

The test specimens used in this study consisted of two polycrystalline alumina ceramic cylinders (0.699-inch outside diameter, 0.480-inch inside diameter, 0.200-inch long) which were butt sealed to either side of a metal washer through the use of thin metal foil washers which formed an "active" liquid alloy at the sealing temperature. In the seals to nickel, titanium foil washers formed this active binary liquid alloy, while in the seals to niobium, nickel foil promoted liquid formation.

Two types of ceramics were used: (1) a polycrystalline alumina (designated Schenectady Tube Operation body No. A-976) containing a small amount of MgO as a grain growth inhibitor, which was sintered to a density of approximately 99.5 percent of theoretical, and (2) a 97 percent alumina (designated G-E body A-923)[*]containing CaO, MgO, and SiO_2 as fluxing oxides. Body A-976 was used because of its proven resistance to cesium corrosion, while body A-923 was used to assess the effect of its higher mechanical strength.

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[*]General Electric Schenectady Tube Operation, Schenectady, N.Y.

Nickel washers of several different purities were used: (1)
Grade A, (2) Type 499, and (3) an ultra pure nickel, desig-
nated "SP", which was obtained from Metals for Electronics,
Inc. The nickel foil used in seals to niobium was 0.0003-
inch, Type 499. The electron beam grade niobium was
0.010-inch thick and was obtained from Fansteel Metallurgical
Company. Grade A-75 titanium foil was used in thicknesses
of 0.001-inch and 0.0005-inch while the 0.00025-inch foil
which was used was Grade A-35.

All metal washers and foil were cleaned using accepted elec-
tron tube processing methods but were not, with a few excep-
tions, given any vacuum or hydrogen firing treatment prior
to sealing. Ceramic specimens were cleaned ultrasonically
and were then air fired to $1000^{\circ}C$ for one hour.

All specimens were sealed by heating in a resistance-heated
tantalum oven contained within a vacuum bell jar at a pressure
lower than 2×10^{-5} Torr. A Pt-Pt, 10 percent Rh thermo-
couple, whose hot junction was held in contact with one face
of the specimen to be sealed, permitted accurate monitoring
of temperature. Thermocouple millivoltage was fed to an
X-Y recorder and any desired heating schedule could be accur-
ately followed by manually adjusting the current to the oven.
A typical schedule comprised heating to $900^{\circ}C$ for ten minutes
to allow the system to equilibrate, followed by heating to the
desired sealing temperature within about one-half to three
minutes. Soak times at the sealing temperature ranged from

III-42

a few seconds to five minutes. Although most of the specimens were cooled with no power in the oven, resulting in a temperature drop of about $300^{\circ}C$ during the first minute, some tests were conducted with controlled slow cooling.

Life testing of seals in vacuum was conducted in a dual chamber vacuum life test system at a pressure of 1×10^{-5} Torr. Each ceramic chamber was separately heated, thus permitting simultaneous testing of specimens at two different temperatures. Specimens to be tested were helium mass spectrometer leak checked, cleaned in xylene and acetone, loaded onto molybdenum boats and inserted into the ceramic test chamber. Sheet titanium spot welded to the molybdenum radiation shields, which blocked the chamber openings, acted as getters and minimized the possibility of back streaming oil vapor contacting the specimens under test. During life testing, each chamber was cycled to room temperature every 240 hours. This was done in order to induce mechanical stresses in the test specimens by virtue of the differential contraction of the component parts.

Results and Discussion

1. Ceramic-to-Nickel Sealing

    The time-temperature sealing conditions, which effect the best seals of alumina-to-nickel, were determined and reported in the semiannual report[9] on this contract. A portion of that discussion is repeated, since it is necessary for an understanding of the life test results.

Figure III-7 shows polished sections of alumina-to-nickel seals made at four different sealing temperatures. The seals were made to 0.010-inch thick SP nickel washers using 0.0005-inch titanium foil to form a liquid phase at the sealing temperature.

The titanium-nickel phase diagram, Figure III-8, shows that the first liquid to form would have the composition of the lowest melting eutectic, 71.5 w/o titanium, 28.5 w/o nickel. As the temperature is raised, the melt dissolves more nickel and the composition drifts toward the composition of the brittle intermetallic compound Ti_2Ni. Figure III-7A shows the structure which is obtained when sealing is performed at a temperature of about $1070^{\circ}C$. The region next to the ceramic is predominately Ti_2Ni and contains many cracks. Equilibrium conditions are not, however, attained in such a seal because of the "infinite" supply of nickel in contact with the melt. This results in a layer of TiNi adjacent to the Ti_2Ni layer, at whose surface the aforementioned cracks terminate. A thin layer of $TiNi_3$ lies between the TiNi and the Ni washer. $TiNi_3$ is optically anisotropic and is readily identified using polarized light. Heating a seal to a temperature of $1180^{\circ}C$, slightly above the $1118^{\circ}C$ eutectic, results in the structure shown in Figure III-7B. Here both TiNi and $TiNi_3$ are seen, as predicted by the phase diagram.
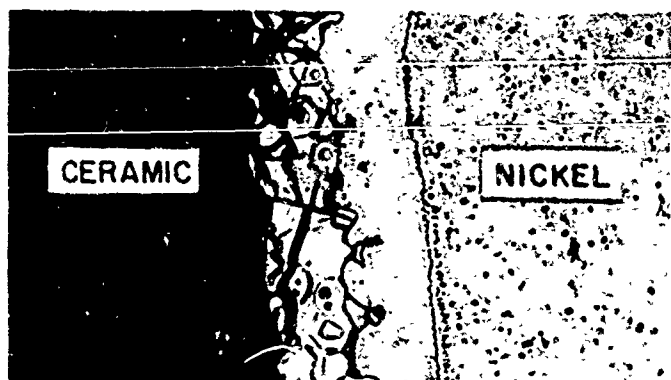
A   30 seconds at $1070^{\circ}C$

500X

B   20 seconds at $1180^{\circ}C$

500X

C   60 seconds at $1275^{\circ}C$

750X
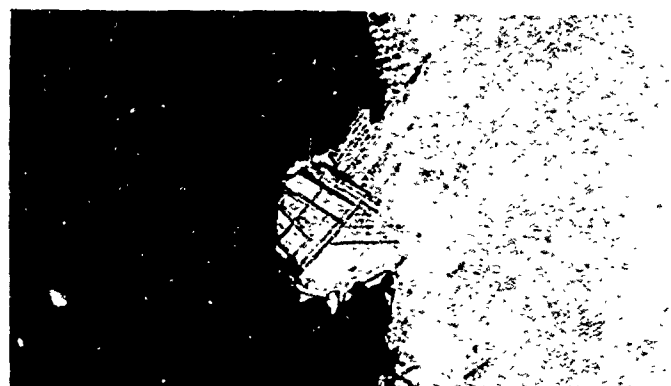
D   60 seconds at $1315^{\circ}C$

750X

Figure III-7

Photomicrographs of Alumina-to-Nickel Seals Made at Four
Different Sealing Temperatures

L

L + (Ni)

L + TiNi₃ —— 1380

1310

L + TiNi

1304   88.4

L + β

TiNi   1118
        66.2

β

36.6 — 985

(Ni)

12.3   .942
       28.4

α + β

TiNi₃
+ (Ni)

β + Ti₂Ni

768 ± 3

Ti₂Ni
+
TiNi

TiNi
+
TiNi₃

5.5

α + Ti₂Ni

Ti₂Ni

TiNi

TiNi₃

Temperature, C

Temperature, F

Weight Per Cent Nickel
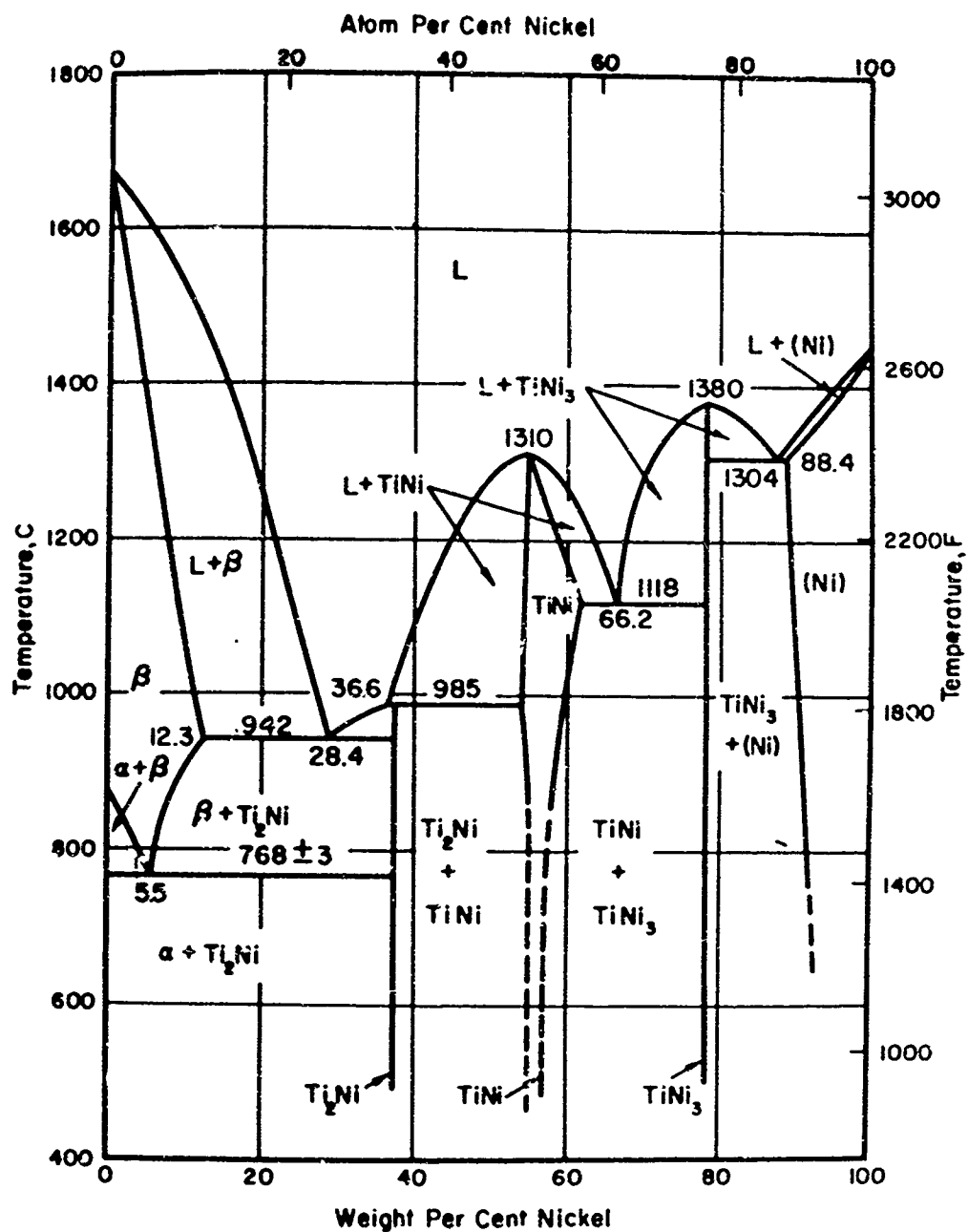
Figure III-8

Titanium-Nickel Phase Diagram[42]

Heating a similar seal to a maximum temperature of about 1275°C results in the structure shown in Figure III-7C. The sealing alloy is predominately equiaxed $TiNi_3$. If the temperature had been slightly lower, the time at sealing temperature slightly less, or the thickness of this layer somewhat greater, some isolated patches of TiNi would remain at the ceramic interface.

When sealing is carried to an even higher temperature, above 1304°C, the $TiNi_3$-Ni eutectic reaction occurs. Depending upon the time-temperature treatment, the structure may range from a nickel solid solution containing needles or plates of $TiNi_3$ at the interface, as in Figure III-7D, to one having all nickel solid solution at the interface.

Seals having a layer of $TiNi_3$ at the interface are very strong, easily prepared and vacuum tight. Seals containing the nickel solid solution at the interface possess lower mechanical strength and are considerably more sensitive to the time-temperature sealing treatment.

Small, rounded orange and/or brown colored particles of one or more extraneous phases have been repeatedly observed in seals to nickel. Although identification of the composition and origin of these phases was inconclusive, as discussed in the semiannual report, several comments and observations can be made. Electron probe microanalysis showed that both phases were

predominately titanium and did not contain any other elements with atomic numbers greater than 11. It is believed that the most probable composition of these particles is the oxide, carbide, and/or nitride of titanium. Experiments made with materials of varying purity failed to pinpoint the source of the particles. They continued to be observed in seals made above and below the 1304°C eutectic, seals to impure (Grade A) as well as ultra pure (SP) nickel, seals to impure (A-75) as well as pure (A-35 and iodide) titanium, and seals made with grossly different cleaning treatment of the component parts, including the ceramic. Although it was desired to prepare and test seals with and without these extra phases in or near the interface, this was not possible. Since, however, no definite relationship could be observed between the presence of these phases and the hour of failure in the life test, they are believed to have but a minor effect on seal performance.

Seals were prepared for life testing using different time-temperature sealing schedules as well as materials having different thicknesses and purities in order to assess their effect on seal life. Tables III-5, III-6 and III-7 (pages III-67, III-68 and III-69) summarize the test results.

Since primary interest was in life-test results at high temperatures, the 700°C life test (Table III-5) was

discontinued after 1370 hours. Sixteen percent of the seals which started the $700^{\circ}C$ life test had developed leaks at the end of 1370 hours, while one group (which had received some previous testing) successfully accumulated 2090 hours without a failure.

Of the 28 alumina-to-nickel seals which were started on the $900^{\circ}C$ life test (Table III-5), 27 reached 410 hours life and were still vacuum tight while a group of seven specimens (which had received previous testing) had by then successfully accumulated 1320 hours without any failures. Further exposure to this temperature, however, caused an increasing failure rate. By the end of 1370 hours, approximately one-third of all of the specimens had developed leaks. Included, however, was the group of seven specimens mentioned above, which had accumulated 2280 hours and were still vacuum tight.

Figure III-9 is a section through one of the seals to Type 499 nickel (group of three, Table III-5) which had developed a leak when checked at 1850 hours. The $TiNi_3$ layer, which was initially present at the interface, has been completely solutioned by the nickel washer and some void formation in this region can be seen. A section through the one specimen of this group, which was still vacuum tight at the end of 1850 hours, appeared identical. Both specimens contained a concentration of the unidentified orange-colored particles near the midpoint of what had originally been the $TiNi_3$ layer.

Figure III-10 is a photomicrograph of a polished section through one of the seven seals which was still vacuum tight at the end of 2280 hours at 900°C. It appears similar to other seals (both vacuum tight as well as leakers) which were exposed to this temperature for 1500 hours or more, in that the $TiNi_3$ layer which had initially been present at the ceramic-metal interface has been completely solutioned by the nickel washer. Like the several other seals just discussed, this one contained a concentration of the orange colored phase near the interface, some void formation, but no separation of the nickel from the ceramic at the interface. It is not known why this group of seven seals yielded such excellent life test results....it may be the result of having an optimum thickness of $TiNi_3$ initially present, or a ceramic surface condition which was conducive to better bonding.

The presence of residual $TiNi_3$ at the interface of a seal after 1370 hours at 900°C, but none in the seal of Figure III-9 after 1850 hours at the same temperature, suggested that solutioning of $TiNi_3$ was highly time-temperature dependent at temperatures approaching 900°C (seals tested at 700°C did not show loss of the $TiNi_3$ layer).

A higher temperature life test, Table III-6, was performed in order to ascertain the rate at which this solutioning could be expected to occur, as well as the effect
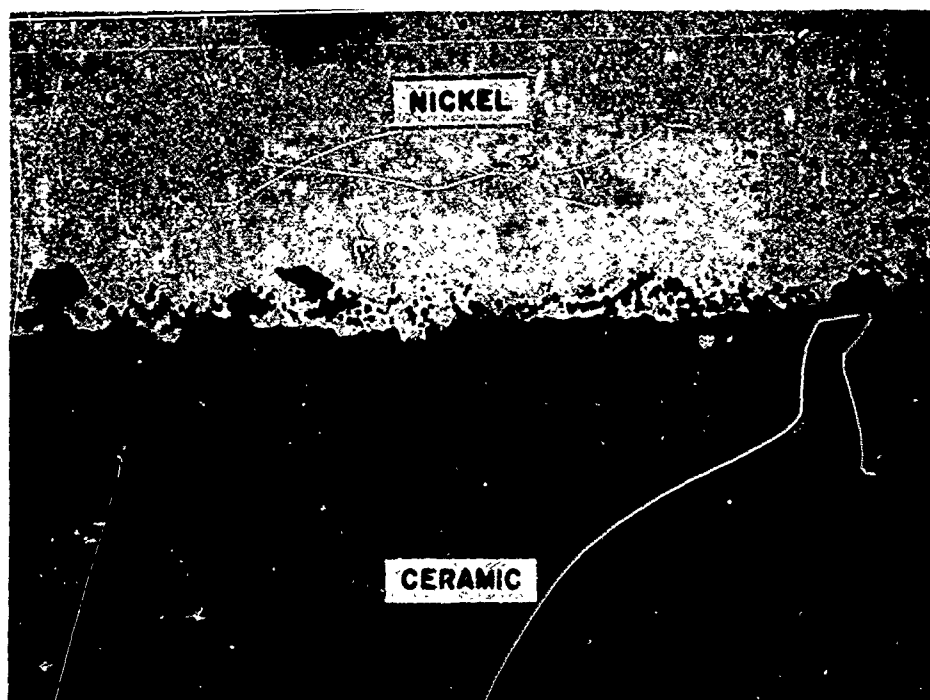
Figure III-9

Alumina-to-Nickel Seal After 1850 Hours at 900°C   (500X)
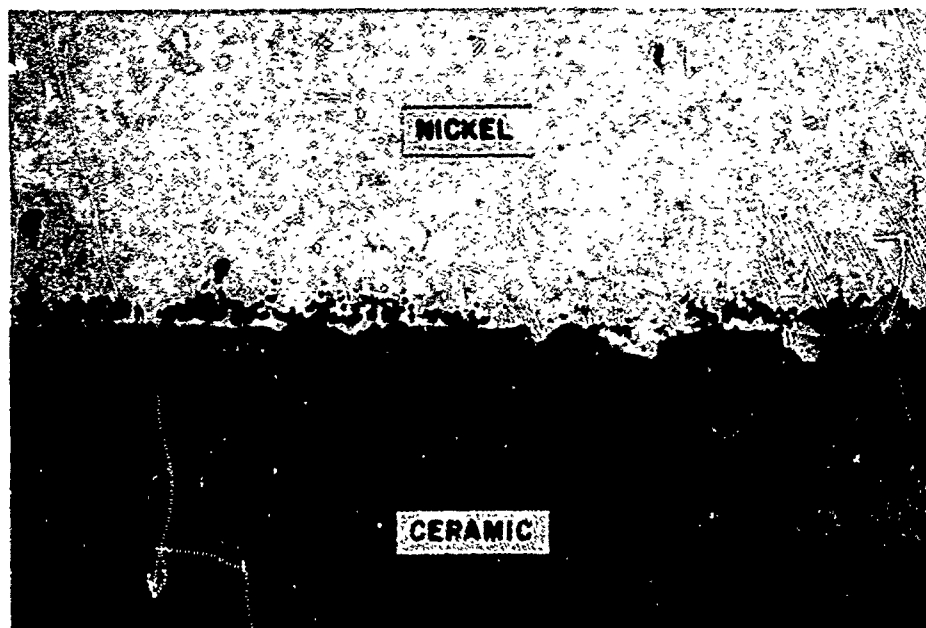
Figure III-10

Alumina-to-Nickel Seal After 2280 Hours at 900°C   (500X)

of the higher temperature on seal life. In addition, a
thermal cycling test, Table III-7, was begun to deter-
mine whether failure of alumina-to-nickel seals was
primarily the result of mechanical stress induced by
the differential thermal expansion which accompanied
each excursion to room temperature (at the end of every
240 hours in the life test) or was the result of chemical
reactions occurring at high temperature. In the cycling
test, the oven was turned off a few minutes after the
specimens reached the desired temperature and the
total exposure to high temperature was thus kept to a
minimum.

The 1075°C life test was made for a total period of 240
hours at the end of which time less than one-half of the
specimens were still leak tight. Polished sections showed
that the $TiNi_3$ layer which had initially been present at the
interface, had completely disappeared. Seals which
leaked usually, but not always, showed separation of the
alloy from the ceramic at the interface. In this test,
the rate of failure of seals to the pure sintered alumina
(body A-976) was not significantly different from seals
to the somewhat higher strength 97 percent alumina
(body A-923).

Thermal cycle testing of seals was begun with 10 cycles
from room temperature to 600°C.... no failures were
recorded! The temperature was then raised to 900°C

and after an additional 10 cycles, 18 percent of the specimens had developed leaks. An additional 10 cycles to $900^{\circ}C$ brought the total to over 38 percent failures.

No change in the thickness of the $TiNi_3$ layer was observed nor would it be expected since the specimens had been subjected to a total of only 13 hours at $900^{\circ}C$. Small cracks were, however, apparent in the $TiNi_3$ layer of many of the seals but it is uncertain as to whether they were actually present in the seal or were caused by metallographic mounting, sectioning and polishing. In this test, separation of the $TiNi_3$ layer from the alumina at the interface was usually observed in seals which leaked.

The seals to 0.010-inch nickel showed a higher failure rate than seals to 0.005-inch nickel as would be predicted from stress considerations. The only seals to the high strength 97 percent alumina body which were thermal cycle tested were nickel buffer washer seals to molybdenum and tantalum.... all of which remained vacuum tight.

It has been previously reported[9] that "compensated butt seals between alumina (A-923) and 0.010-inch thick nickel, sealed in such a manner as to form only the nickel solid solution at the interface, show flexural strengths approximately one-third that which is obtained

if sealing is performed so as to form a thin layer of
TiNi$_3$ at the interface." Thus, if high-temperature
exposure causes solutioning of the TiNi$_3$ layer, as has
been observed in the life tests, a reduction in strength
would be expected to occur. The reduced strength of
the alloy-oxide bond, coupled with the mechanical
stresses arising from the differential contraction be-
tween alumina and nickel, could then cause failure at
the interface.

As mentioned in the "Introduction" to "E. Active-
Alloy Sealing", two different ceramic bodies were used
in testing in order to assess the effect, on seal life, of
their differences in chemical composition and mechan-
ical strength. The pure sintered alumina (A-976) pos-
sesses the lower mechanical strength due to its larger
grain size (the anisotropy of thermal expansion of alpha
alumina generates stresses at the grain boundaries of a
glass-free polycrystalline alumina and as the grain size
increases, the mechanical strength decreases). If, in
a seal to alumina, transgranular or intergranular fail-
ure were observed in the alumina, the strength of the
body would be expected to have a significant effect on
the strength of the seal. This mode of failure was not,
however, observed in the seals of this study. If physi-
cal separation was noted in any of the polished sections
of seals which had failed the helium leak check, it was

predominately at the interface between the sealing alloy and the original ceramic surface, indicating that the alloy-oxide bond was the weakest link in the system. Figure III-11 clearly shows this type of failure. On the other hand, in some of the seals to pure alumina, an occasional alumina grain could be observed to have been pulled from the surface of the ceramic and could be found adhering to the $TiNi_3$ layer. This was never observed in the case of seals to the higher strength 97-percent alumina body.

The type of ceramic can affect seal strength (and probably seal life) in several other ways --- (1) through differences in surface roughness and consequent mechanical interlocking of the sealing alloy to the surface, and (2) differences in chemical bonding to the ceramic surface caused by the presence of a glassy phase and/or crystalline phases other than alumina.

In summary, the thermal cycling tests show that pure alumina-to-nickel seals (with $TiNi_3$ at the interface) fail after a relatively few thermal cycles from room temperature to $900^{\circ}C$. Failure is believed to result from the mechanical stresses induced by thermal expansion mismatch between alumina, nickel and $TiNi_3$. Similar seals (to pure sintered alumina as well as 97-percent alumina) also fail when exposed to $900^{\circ}C$ for long periods of time and generally show solutioning of the
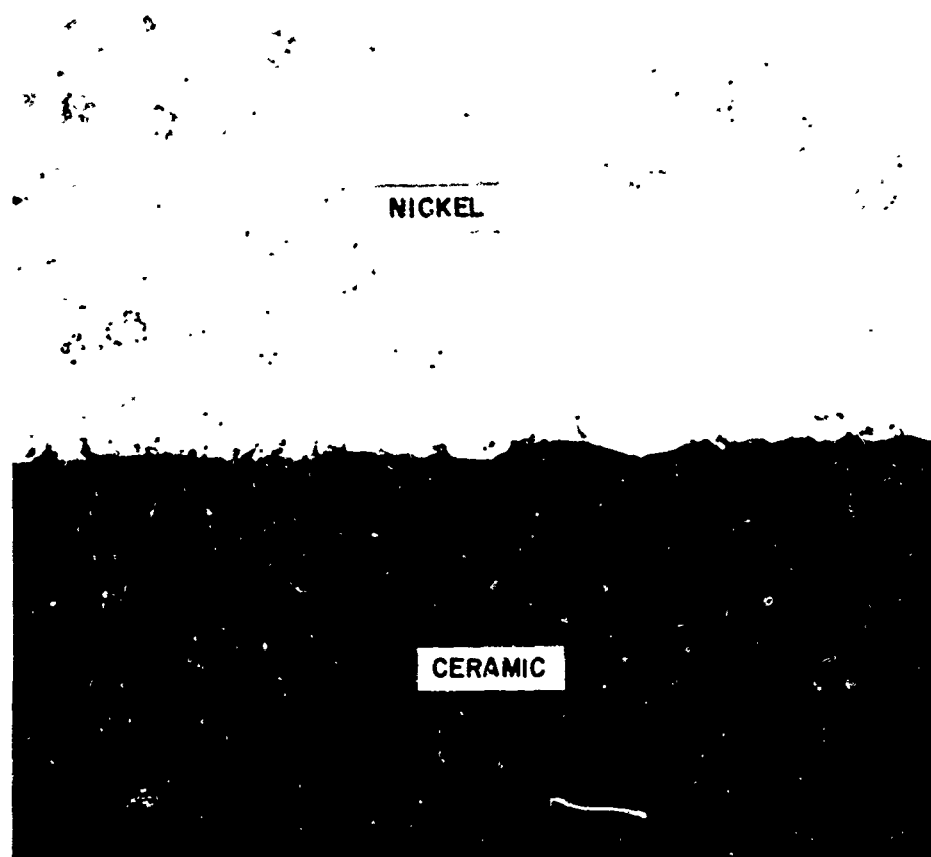
Figure III-11

Failure of Seal at Surface of Ceramic   (500X)

$TiNi_3$ layer at the interface. Since these long time life tests included periodic thermal cycling to .oom temperature (10 cycles during every 2400 hours of testing), this could have accelerated the onset of failure. Exposure of seals to a temperature of $1075^{\circ}C$, however, resulted in a very high rate of failure in a very short time (240 hours), clearly showing the deleterious effect of temperature alone.

2. **Alumina-to-Refractory Metal Seals with Nickel Buffer Washers**

Seals of alumina-to-molybdenum and alumina-to-tantalum, prepared with nickel buffer washers, showed quite different results on thermal testing, as shown in Tables III-5 and III-6.

Life testing at $900^{\circ}C$ in vacuum, with thermal cycling to room temperature every 240 hours, resulted in failure of all of the tantalum seals at 1370 hours, but no failures in the seals to molybdenum. Cracks were apparent in the wide multiphase braze region between the tantalum and the nickel buffer washer and may constitute the leak path. No such cracks were noted in the several alumina-to-molybdenum seals which were sectioned at the end of 1370 hours.

Thermal cycle testing caused the failure of one specimen of each type of seal after 10 cycles to $900^{\circ}C$. The remaining specimens withstood an additional 10 cycles

with no more failures occurring. The one specimen
of each type which failed was a seal to the pure alum·
ina ceramic (A-976) and a polished section showed
separation at the $TiNi_3$ - alumina interface. No fail-
ures occurred among the several seals to the 97-per-
cent alumina body.

Figure III-12 is a photomicrograph of a vacuum-tight
nickel buffer washer seal of A-923 to molybdenum
after 20 cycles to $900^{\circ}C$ showing the $TiNi_3$ layer at
the ceramic-nickel interface and the wide braze region
between the nickel and the molybdenum. Figure III-13
shows a similar seal to tantalum. Although cracks
were visible in the wide multiphase region between the
nickel buffer washer and the tantalum as well as in the
$TiNi_3$ layer, the seal checked leak tight after 20 cycles.

Life testing of several seals of each type to $1075^{\circ}C$ re-
sulted in no failures among the seals to molybdenum but
total failure of the seals to tantalum. Figure III-14 is a
photomicrograph of one of the vacuum-tight seals to
molybdenum after 240 hours at $1075^{\circ}C$. Loss of the
$TiNi_3$ layer at the interface, due to solutioning by the
nickel buffer washer, can be seen, as can the changes
which occurred in the braze region between the nickel
buffer washer and the molybdenum. Figure III-15 shows
one of the seals to tantalum which failed. Diffusion at
the interface between the nickel buffer washer and the
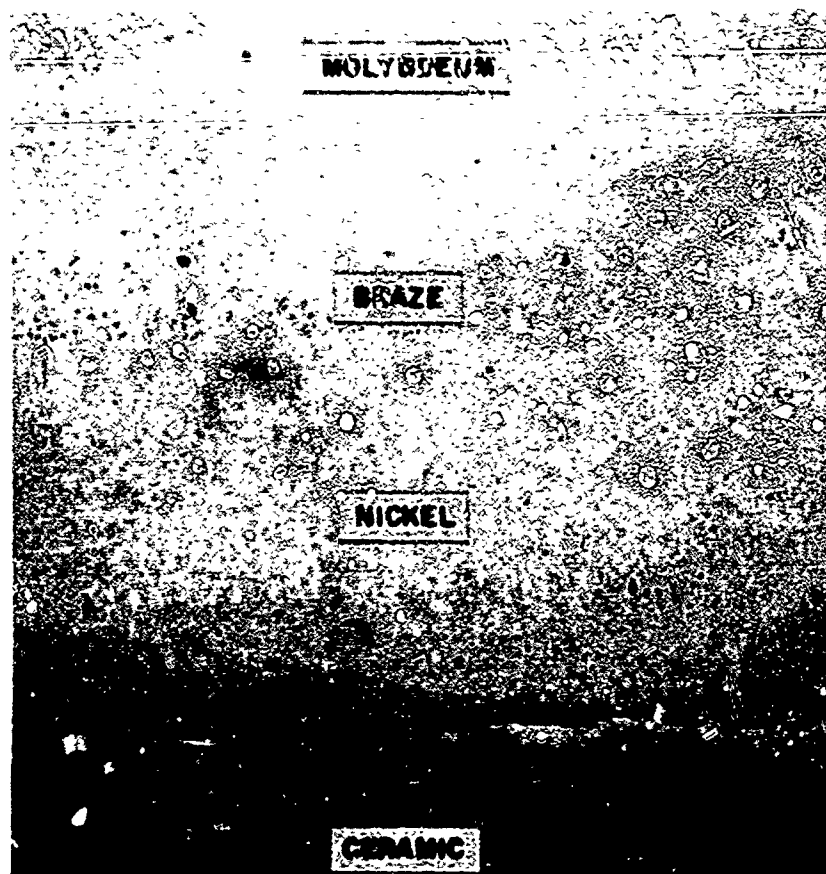
Figure III-

Alumina-to-Molybdenum Seal with Nickel Buffer Washers
After 20 Thermal Cycles to 900°C   (500X)
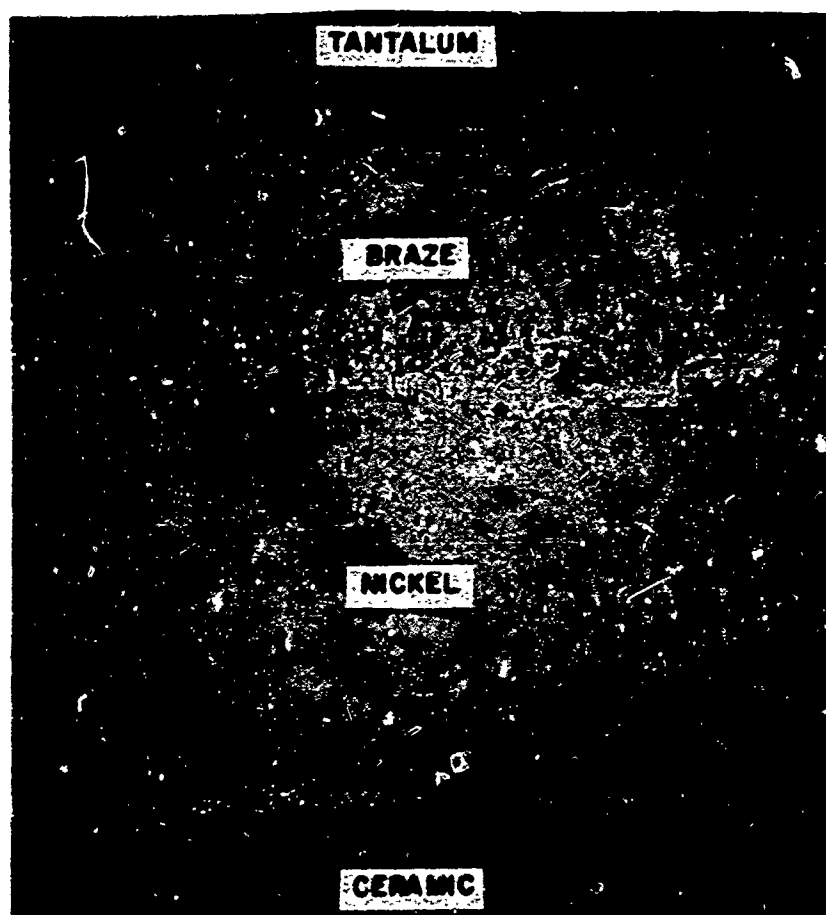
Figure III-1

Alumina-to-Tantalum Seal with Nickel Buffer Washers
After 20 Thermal Cycles to 900°C   (500X)
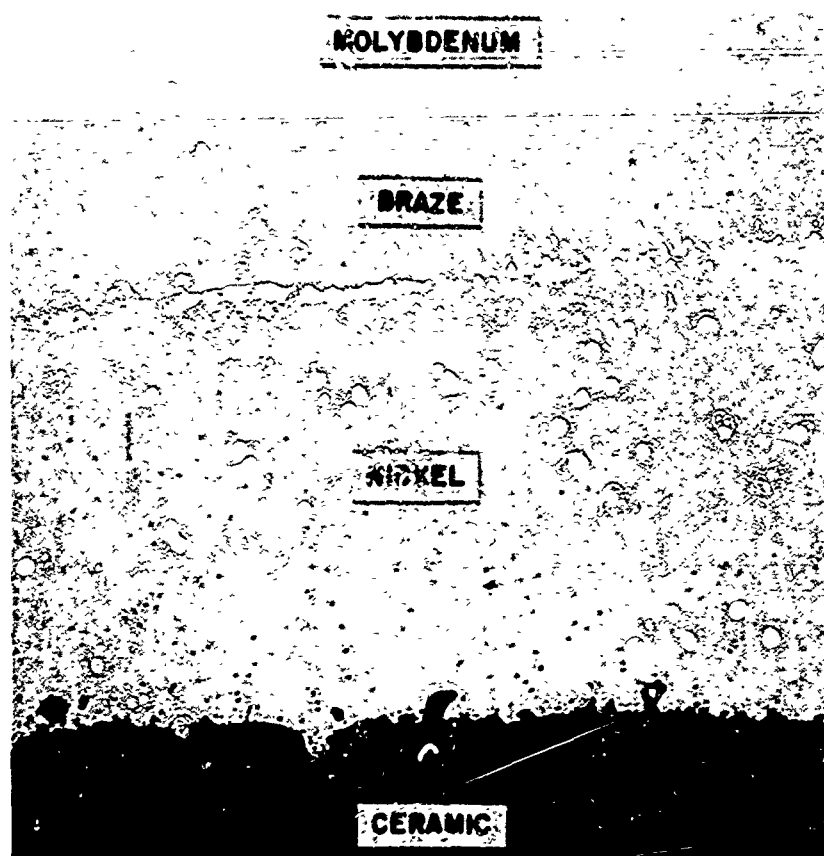
Figure III-14

Alumina-to-Molybdenum Seal with Nickel Buffer Washers
After 240 Hours at 1075°C   (500X)
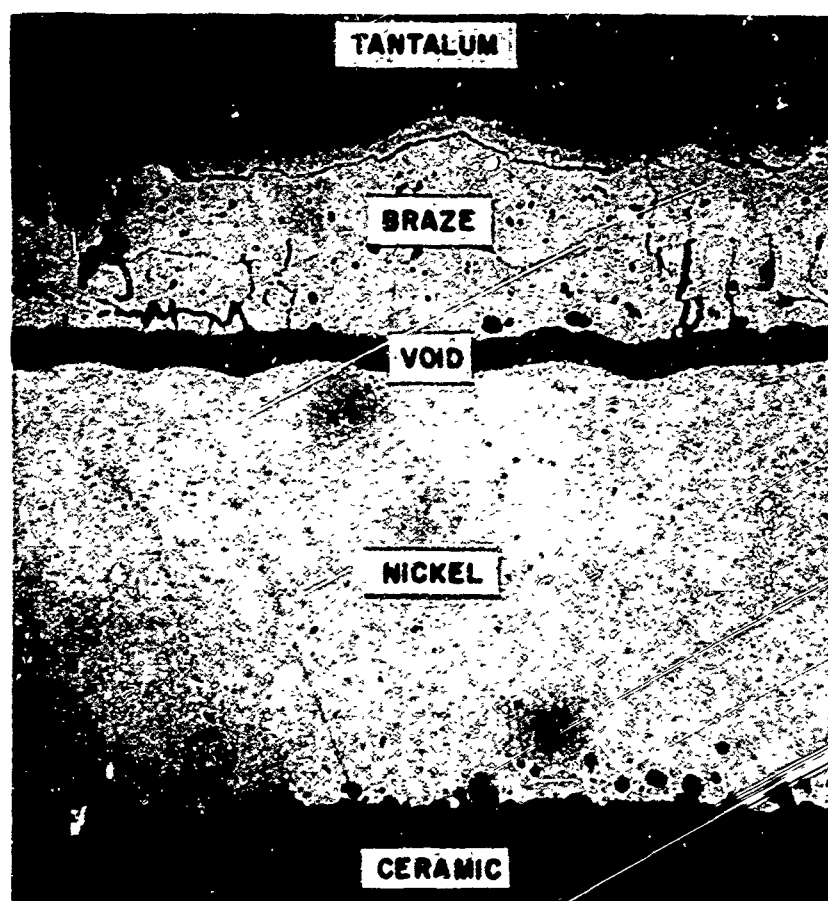
Figure III-15

Alumina-to-Tantalum Seal with Nickel Buffer Washers
After 240 Hours at 1075°C   (500X)

III-60

tantalum-nickel braze region has created a long crack-like void which probably constitutes the leak path. Small voids have also formed on the ceramic side of the nickel buffer washer where the $TiNi_3$ layer initially present was solutioned by the nickel.

Thus, nickel buffer washer seals of alumina-to-refractory metals are subject to several kinds of failure. In seals to tantalum, failure will occur at high temperatures ($900^{\circ}C$ and above) through the formation of cracks in the nickel-tantalum braze region, or separation at the ceramic interface. Since voids are observed to be formed near the ceramic interface (at the $TiNi_3$-nickel interface which was initially present) of seals to both tantalum and molybdenum, but the latter type do not develop leaks, it is concluded that void formation at the interface does not constitute a leak path in either type of seal. Since the $TiNi_3$ layer initially present in nickel buffer washer seals to molybdenum is solutioned (just as it is in seals to nickel alone), but no failures occurred on either the $900^{\circ}C$ or $1075^{\circ}C$ life test, it is theorized that the very low thermal expansion of molybdenum must offset the high expansion of the nickel buffer washer to effect a low shearing stress at the ceramic interface which never exceeds the strength of the alloy-oxide bond. If this is true, then an optimum thickness of molybdenum and nickel buffer washer must exist for each seal design.

3.   Alumina-to-Niobium Seals

Alumina-to-niobium seals were prepared with many
different time-temperature sealing conditions in order
to assess the effect of sealing parameters on seal
strength, vacuum tightness, and structure of the alloy
which was formed. Figure III-16 is a photomicro-
graph of a seal which was made at a temperature of
$1430^{\circ}C$ with a two-minute soak. Seals made at other
temperatures and with soak times up to ten minutes.
looked virtually identical. Although all of the polished
sections showed many cracks through the intermetallic
layer, all were vacuum tight. The width of the cracks
which appear in the photomicrographs has been exagger-
ated by etching and, as mentioned previously, it is
possible that these cracks are formed during prepar
ation of the polished section. Since the phase equilibrium
diagram for the nickel-niobium system is incomplete
(see Figure III-19), identification of the intermetallic
compounds formed at the interface was not attempted.
Microhardness measurements were made, at the mid-
points of the intermetallic layer and the niobium washer,
on seals prepared with different time-temperature con-
ditions. Sealing conditions ranged from $1270^{\circ}C$ for two
minutes, through $1416^{\circ}C$ for ten minutes, to $1433^{\circ}C$
for two minutes. Knoop hardness (10-gram load) of the
several layers was virtually identical in all of the seals
which were measured and averaged 150 KHN in the
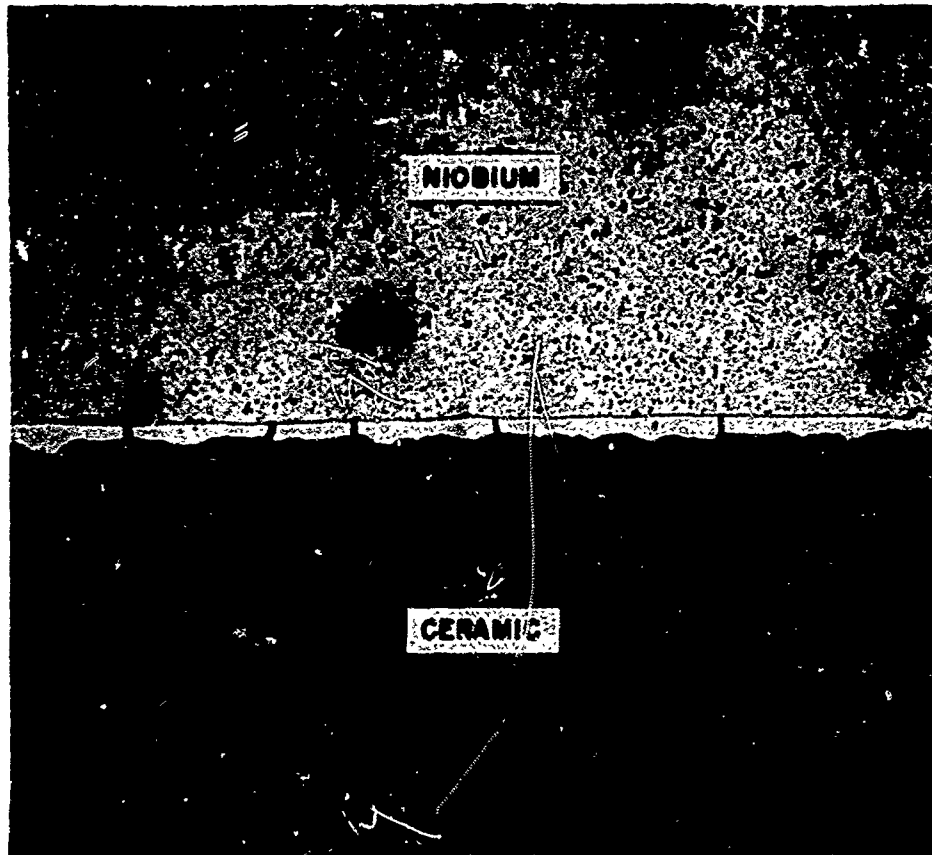
Figure III-16

Alumina-to-Niobium Seal Made at a Temperature of
1430°C   (500X)

niobium washer, and 680 KHN in the intermetallic layer.

Although no quantitative mechanical strength testing was performed, breaking of alumina-to-niobium seals showed that they were less strong than the alumina-to-nickel seals previously discussed (particularly those containing $TiNi_3$ at the interface). The virtually identical thermal expansion match between alumina and niobium, together with the ductility and low modulus of elasticity of niobium, is undoubtedly responsible for their excellent performance on life and thermal cycle testing....in spite of their low mechanical strength. Since the intermetallic should be a stable compound at the life test temperatures of interest, the strength of the bond to the ceramic may not change with time, as contrasted with seals to nickel where the $TiNi_3$ ceramic bond is gradually replaced by the lower strength nickel solid solution-ceramic bond.

Several seals were prepared in which a thin coating of titanium hydride had been applied to the surface of the ceramic to promote better wetting yet not to be present in such quantity as to form a titanium-containing phase. Such seals showed a definite improvement in strength but time did not permit comparative life testing.

Life testing of nickel shim seals of alumina-to-niobium yielded the most promising results. All of the seals

which were placed on 900°C life test (Table III-5 were still vacuum tight when last leak checked with the helium mass spectrometer at 2020 hours. Figure III-17 is a polished section through one of these seals showing no apparent change in the thick intermetallic layer at the interface but the formation of a new, thinner, phase layer at the niobium surface.

In addition, all five of the specimens which were tested at a temperature of 1075°C were still vacuum tight after 240 hours exposure, whereas most of the alumina-to-nickel seals in the same test chamber had failed.

Microhardness measurements were made on the seal of Figure III-17 and it was found that the hardness of the niobium washer was 127 KHN and the hardness of the intermetallic layer was 1075 KHN. It is believed highly significant that the hardness of the niobium had not increased (but apparently decreased) as a result of two thousand hours of testing at 900°C. Although reaction would probably occur between niobium and alumina at 900°C, resulting in gradual hardening of the niobium, the presence of the nickel-niobium intermetallic layer apparently prevents this reaction. This is in marked contrast to seals to titanium[9] where severe embrittlement occurs in much less than two thousand hours.

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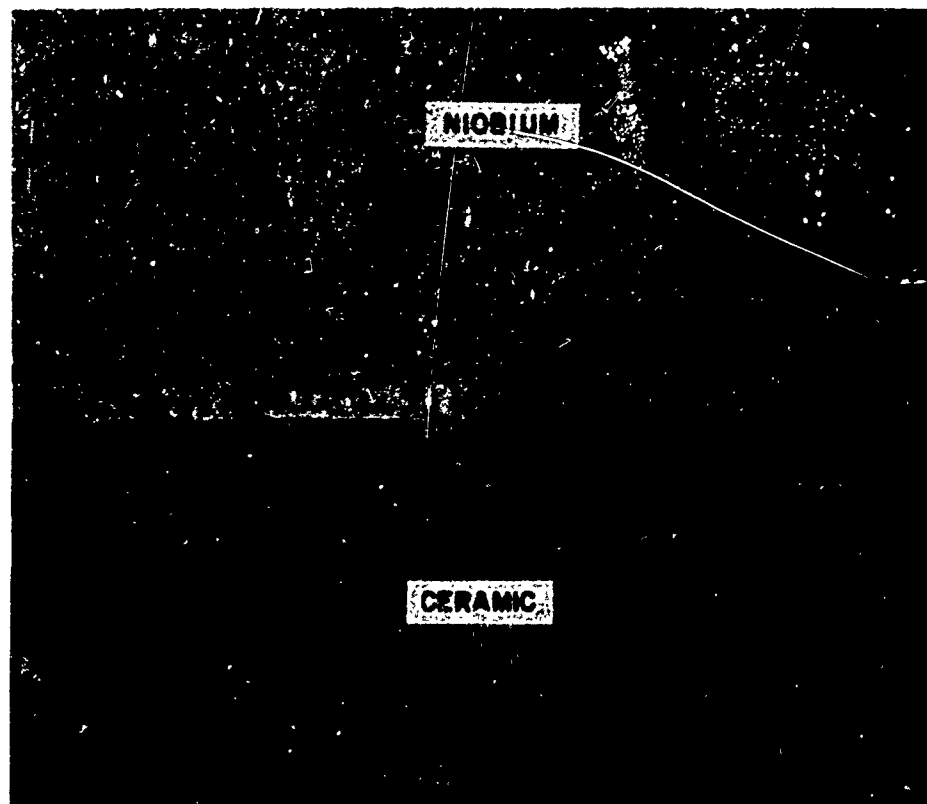
Figure III-17

Alumina-to-Niobium Seal After 2020 Hours at 900°C   (500X)

Table III-5

Seals Life Tested at 700°C and 900°C

Seal Type	Leak Tight at Start	Leak Tight after Indicated Hours of Exposure
Seals Life Tested at 700°C		
Alumina-to-Nickel		
(a) TiNi$_3$ at interface, SP nickel	9	9 at 410 hr; 8 at 1370 hr
(b) TiNi$_3$ at interface, 499 nickel	4	4 at 1130 hr; 4 at 2090 hr
	3	3 at 410 hr; 2 at 1370 hr
(c) Solid solution at interface, SP nickel	4	3 at 410 hr; 3 at 1370 hr
Alumina-to-tantalum, nickel buffer washers	5	5 at 410 hr; 4 at 1370 hr
Alumina-to-molybdenum, nickel buffer washers	5	4 at 410 hr; 4 at 1370 hr
Seals Life Tested at 900°C		
Alumina-to-Nickel		
(a) TiNi$_3$ at interface, SP Nickel	10	10 at 410 hr; 6 at 1370 hr
(b) TiNi$_3$ at interface, 499 nickel	7	7 at 1320 hr; 7 at 2280 hr
	3	3 at 890 hr; 1 at 1850 hr
	2	1 at 410 hr; 0 at 1370 hr
(c) Solid solution at interface, SP nickel	6	6 at 410 hr; 4 at 1370 hr
Alumina-to-Tantalum, nickel buffer washers	11	3 at 410 hr; 9 at 1370 hr
Alumina-to-Molybdenum, nickel buffer washers	7	7 at 410 hr; 7 at 1370 hr
Alumina-to-Niobium	6	6 at 410 hr; 6 at 1370 hr; 6 at 2020 hr

NOTE: All seals contained G-E A-923 ceramic.

Table III-6

Seals Life Tested at 1075°C

	Leak Tight Specimens	
Seal Type	At Start	After 240 Hours
Seals to Sintered Alumina (G-E A-976)		
Alumina-to-nickel		
(a) 0.005-inch nickel	6	2
(b) 0.010-inch nickel	4	0
Alumina-to-niobium	5	5
Seals to 97% Alumina (G-E A-923)		
Alumina-to-nickel		
(a) 0.005-inch nickel	12	6
(b) 0.010-inch nickel	5	0
Alumina-to-tantalum		
(a) 0.005-inch nickel buffer washers	3	0
(b) 0.010-inch nickel buffer washers	2	0
Alumina-to-molybdenum		
(a) 0.005-inch nickel buffer washers	2	2
(b) 0.010-inch nickel buffer washers	2	2

NOTES:

    A. SP nickel used in all seals.

    B. All seals to nickel had $TiNi_3$ at interface.

Table III-7

Seals Thermally Cycled at 700°C and 900°C

Seal Type	Leak Tight after Indicated Number of Cycles			
	At Start	10 Cycles to 600°C	10 Cycles to 900°C	20 Cycles to 900°C
Seals to Sintered Alumina (A-976)				
Alumina-to-Nickel				
(a) 0.005-inch nickel	9	9	9	7
(b) 0.010-inch nickel	12	12	8	3
Alumina-to-Tantalum, 0.005-inch				
Nickel Buffer Washers	5	5	4	4
Alumina-to-Molybdenum, 0.005-inch				
Nickel Buffer Washers	4	4	3	3
Seals to 97% Alumina (A-923)				
Alumina-to-Tantalum, 0.005-inch				
Nickel Buffer Washers	2	2	2	2
Alumina-to-Molybdenum, 0.005-inch				
Nickel Buffer Washers	2	2	2	2

NOTES:

A. All seals were prepared with $TiNi_3$ at the interface.
B. Total exposure at maximum temperature was 10 hours at 600°C, 13 hours at 900°C.

The desirability of using niobium as a structural metal, the simplicity of making nickel shim seals to niobium, and their excellent behavior at high temperatures continues to make this system particularly interesting.

Conclusions and Recommendations

Alumina-to-nickel seals and alumina-to-refractory metal seals prepared with nickel buffer washers, although suitable for moderate temperature applications, cannot be considered for long time exposure to high temperatures (above about $900^\circ C$) due to the degradation of the metal-ceramic bond which accompanies solutioning of the $TiNi_3$ layer initially present at the interface.

Alumina-to-niobium seals (prepared with nickel shims), on the other hand, displayed excellent high-temperature performance. Hardening of the niobium does not occur and must be prevented by the presence of a thin layer of a nickel-niobium compound at the interface. The very desirable properties of niobium, together with the excellent test data recorded for alumina-to-niobium seals, makes this system worthy of further evaluation.

F. Metal-to-Metal Joining

Introduction

The metal-to-metal joining problem of primary interest during this study is that encountered when a metallized ceramic or a cermet, such as those discussed in the preceding sections

of this report, must be joined to the structural metal members of a thermionic converter.

During this study, molybdenum received principal attention as the metallic constituent of the surface layer of a multi-layered cermet or metallized ceramic. The structural metal members or conductor portions of the metal-to-ceramic seal undoubtedly require, by present and anticipated service temperatures, fabrication from molybdenum, niobium, tantalum, tungsten, or alloys thereof. During this study, effort was limited to the problem of joining molybdenum to either itself, niobium, or tantalum.

Although the mechanical strength of the metal-to-metal joint is not of primary concern, it must be stable at the desired operating temperature, must be resistant to cesium corrosion, and preferably should be free of brittle phases. The probable thinness of the metallic layer which will be provided on the surface of the insulator imposes additional restrictions and makes the use of inert arc or electron beam welding unattractive. Electron beam welding of ceramics, both bare and metallized, has met with very limited success.[16, 17] Ultrasonic welding is a possibility, but the lack of encouraging results by others[16] has eliminated it from further consideration at this time. Thus, the joining methods having the greatest applicability to this problem are brazing and diffusion bonding.

Diffusion Bonding

Solid-solution diffusion can be conducted at relatively low temperatures; an added advantage is that other materials of unknown attack resistance are not added to the joint. Usually, however, this type of diffusion requires very high pressures. The pressure is considered the first stage of the two stages required to obtain strong diffusion bonds. It serves to plastically deform the interfaces to achieve intimacy of contact and to disrupt oxides so that the second stage of strengthening, diffusion, can readily occur. Others[18] have found, with refractory metal alloys, that the creep strength is so high that it becomes almost impossible to fulfill the pressure requirement. However, by using a thin interleaf of the base metal or a softer lower melting metal, the pressure required can approach a reasonable value.[19] Use of an interleaf of a lower melting metal, even though its melting point is not exceeded, also appears to increase the diffusion rate providing the interleaf is completely soluble at the diffusing temperature.

Considerable study[19] has been conducted on diffusion bonding of molybdenum, niobium, and tantalum alloys using various interleaf materials. Niobium and tantalum interleafs 0.001-inch thick produced good bonds with both the niobium and tantalum alloys. Titanium interleaf and electroplates of nickel, rhodium, palladium, platinum, and ruthenium produced good bonds with TZM alloy (0.5 w/o titanium,

0.1 w/o zirconium, remainder molybdenum). Electro-
plates of rhenium and chromium, however, did not produce
bonds with TZM. The high melting point of rhenium was
suggested as the reason for its inability to cause bonding.
The inability of the argon or hydrogen atmosphere to break
down the oxides on the chromium was possibly the cause of
the chromium failure. Since chromium was indicated[20] to
be completely soluble in molybdenum, this system was
studied further under this program, using a low dew point
hydrogen atmosphere. Palladium has been stated to have
relatively good solubility in molybdenum and to be free of
intermetallic compounds with either molybdenum or tant-
alum. Therefore it is of interest as a diffusion bonding
interleaf material. Attempts have been made to diffusion
bond molybdenum and niobium alloys with iron, nickel, and
cobalt alloys.[21] Brittle intermetallic compounds are formed
at the interface as anticipated from the restricted mutual
solubility between nickel, iron, or cobalt and the refractory
metals. The intermetallics that are believed to be formed
with nickel-molybdenum, nickel-niobium, and nickel-tantalum
are illustrated in the phase diagrams shown in Figures III-18,[22]
III-19,[23] and III-20,[24] respectively.

Brazing

Brazing can be accomplished in various ways, and again the
method chosen will,in part,be determined by the effect of the
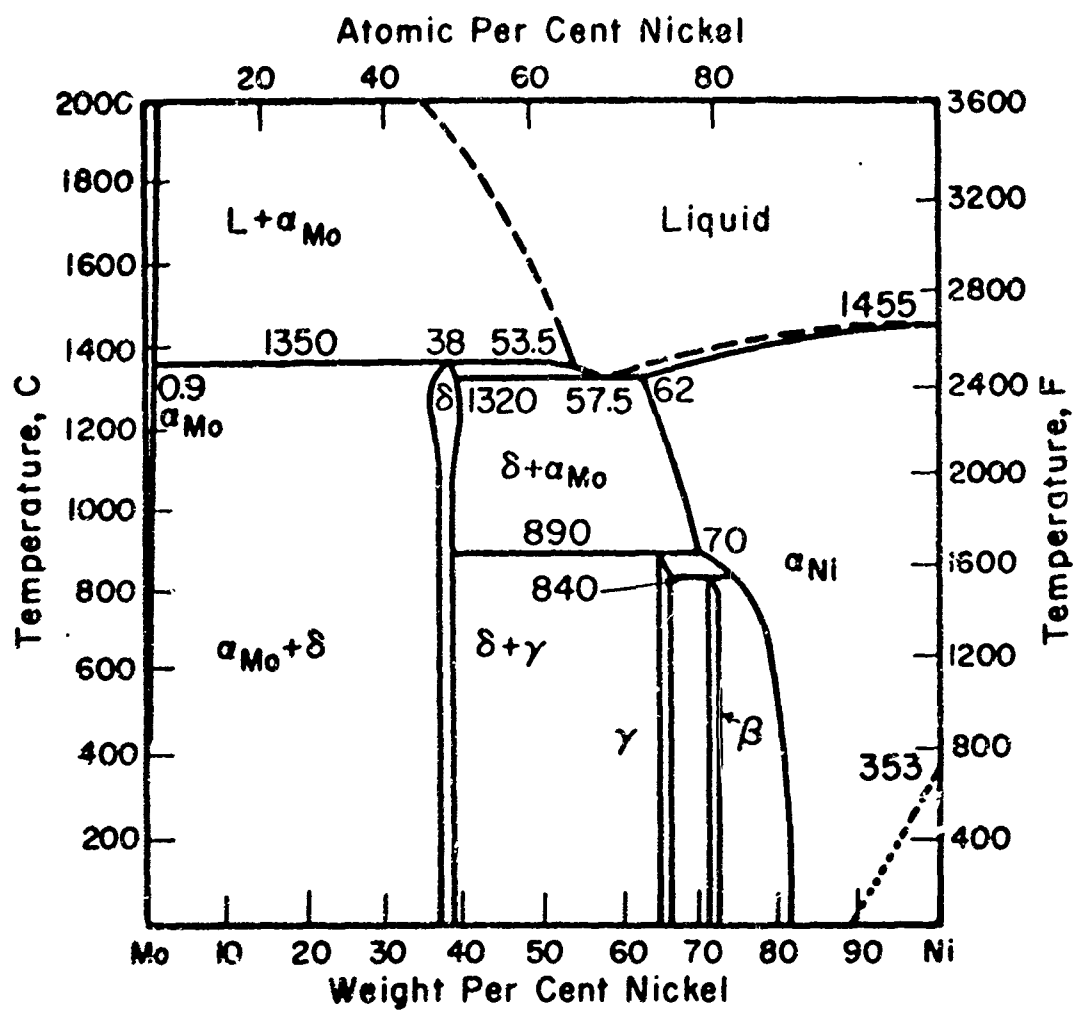
Figure III-18

Molybdenum-Nickel Phase Diagram[22]
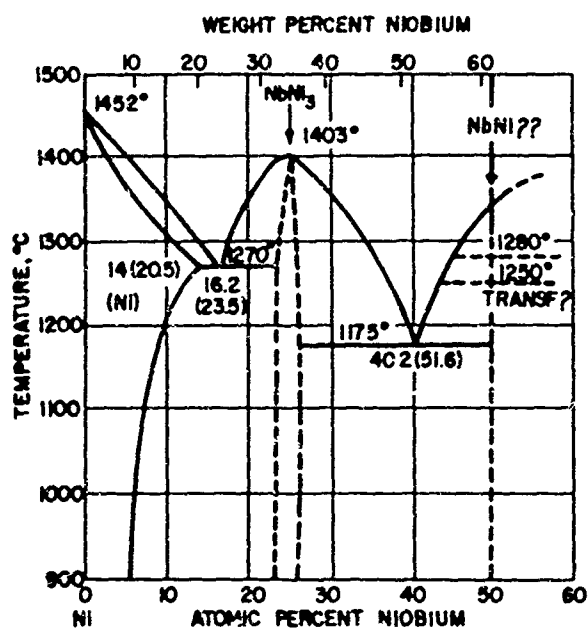
Figure III-19

Nickel-Niobium Phase Diagram[23]
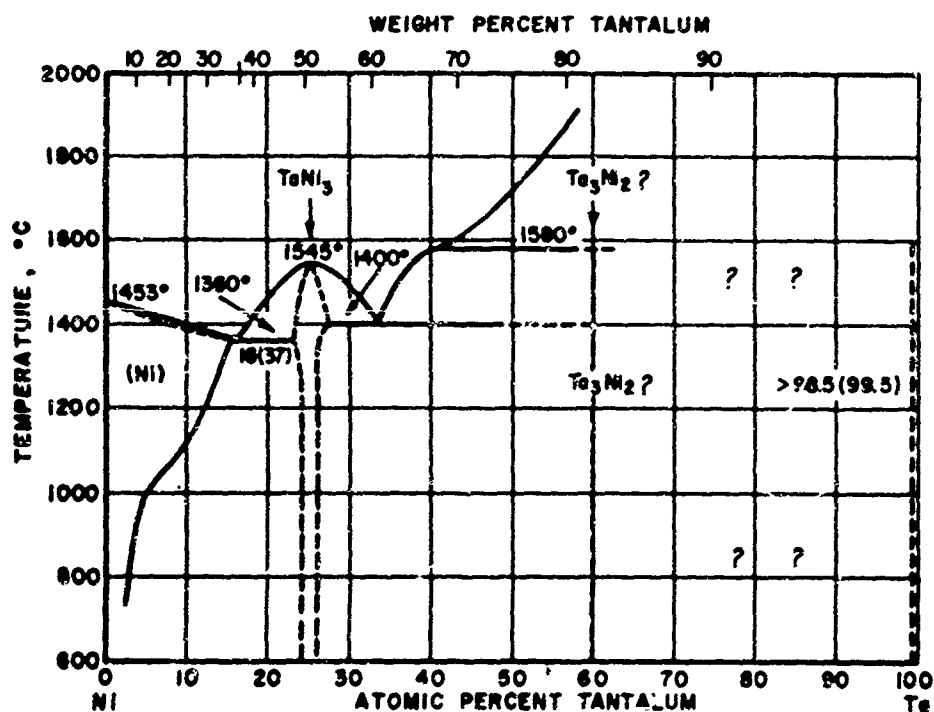
Figure III-20

Nickel-Tantalum Phase Diagram[24]

braze on the metallizing or cermet. Of course the braze must also be resistant to cesium attack and have long time stability at the seal operating temperature.

One method of brazing involves the use of high-temperature braze materials specifically designed for use with refractory metals and alloys.[21,25,26,27,28] This method offers the possible advantage of limited solutioning of the base metals (which may be important when brazing to a thin metallized coating or a graded cermet) and the advantage of having rather good ductility.[21] Unfortunately, many of these brazes contain large percentages of titanium or zirconium which have been shown by others[2a] to have poor cesium attack resistance as low as 750°C (see Table III-8 located in section on "G. Cesium Corrosion Testing") or vanadium whose cesium attack resistance has not been studied. However, brazes containing these metals have been found to survive in potassium vapor at 1000°C for 1000 hours.[29] The nickel and cobalt based braze alloys, developed for high-temperature nickel and cobalt based heat resistant alloys, may be useful, providing reaction with the refractory metals during brazing does not cause formation of brittle phases. However, a possible problem with these brazes is the continued diffusion of the various elements into the base metal while at the service temperature. This diffusion could be either beneficial in strengthening the bond or detrimental by causing the formation of brittle intermetallic compounds. It may be possible,

however, to improve the strength and attack resistance of a braze by heat treatment at a temperature above the service temperature. Often this is done[21,26] to increase the remelt temperature of the braze for very high-temperature applications.

Another method of brazing is to use a reactive type braze whereby the metal added to the joint reacts with the structural members forming a composition which melts at a temperature below the melting point of the added metal. This type of braze necessarily requires some solutioning of the base metal, but depending on which component is solutioned (the metallized layer, the graded cermet, or the conductor portion of the seal), this effect may or may not be serious.

The most common metals that are used for reactive brazes are chromium, cobalt, iron, and nickel. These metals have low melting compositions with the three refractory metals of interest, i.e., molybdenum, niobium, and tantalum. Unfortunately, these metals also form intermetallic compounds with the refractory metals as previously mentioned. However, it has been demonstrated[30] with nickel-molybdenum that, when the temperature used was high enough and maintained for about five hours, almost all of the brittle phase was eliminated by diffusion of the nickel into the molybdenum. Figure III-18 illustrates why this treatment is successful. By heating to slightly above a temperature of 1350°C, the intermetallic compound is not formed, and providing the temperature

is maintained long enough to lower the percentage of nickel in the joint to its solubility limit in molybdenum, the inter-metallic compound will not form on cooling. Other systems which could conceivably be handled the same way are nickel-niobium (Figure III-19) and nickel-tantalum (Figure III-20). The chromium-niobium, chromium-tantalum, cobalt-molyb-denum, cobalt-tantalum, and iron-molybdenum systems are similar to the nickel-molybdenum system shown in Figure III-18, except that considerably higher temperatures are required. Although the cobalt-niobium, iron-niobium and iron-tantalum systems are similar to the nickel-tantalum system (Figure III-20) they also require higher temperatures. Therefore, studying the nickel-molybdenum, nickel-niobium, and nickel-tantalum systems should provide basic inform-ation which would be applicable to all of the other systems mentioned.

Although this braze-diffusion-bonding technique requires relatively high temperatures as compared with diffusion or interleaf diffusion bonding or use of common ductile braze alloys, it should form a bond (1) almost as strong as the structural members, (2) free of localized attack by cesium vapor and (3) possessing a high remelt temperature.

Experimental Procedure

1.   Diffusion Bonding

The diffusion bonding studies were conducted in a simple fixture consisting of a stack of molybdenum

plates which had been riveted together and through which a rectangular hole had been cut. The specimens to be bonded along with alumina ceramic spacers and wedges were placed snuggly in the hole. The pressure applied to the specimens was then directly related to the thermal expansion mismatch between the molybdenum fixture and alumina ceramics, and therefore increased with temperature. With the fixture used, the calculated pressure at $900^{\circ}C$ was in excess of $100,000$ pounds per square inch. Therefore, the pressure during bonding changes in relation to the yield and creep strength of the materials to be bonded and the interleaf which is used. The specimens can be heated either by placing the fixture in a hydrogen furnace or by induction heating of a surrounding tantalum susceptor in vacuum.

2. Brazing

Specimens to be brazed were placed between two high alumina pusher ceramics and loaded in a molybdenum spring-loaded fixture. Brazing was performed in a vacuum bell jar using r-f heating of a tantalum susceptor placed over the fixture. The temperature was monitored by a Pt-PtRh thermocouple wired to the specimens. For braze metals and alloys which melted above $1400^{\circ}C$, temperatures were monitored with an optical pyrometer.

The specimens used were the same for both brazing and diffusion bonding. A molybdenum ring 3/16-inch high with a 0.480-inch inside diameter and 0.700-inch outside diameter was brazed or bonded to a 0.750-inch diameter, 0.010-inch thick molybdenum disc, a 0.015-inch thick niobium disc, or a 0.010-inch thick tantalum disc with the braze or interleaf placed between them. Those braze materials that were not sufficiently thin or in powder form were placed around the inside of the ring. The molybdenum ring very nearly matched the size of the metallized alumina ceramic specimens and allowed the braze or bond to be checked for leak tightness before and after cesium attack.

Results and Discussion

1. Diffusion Bonding

A chromium-plated molybdenum ring specimen was placed in contact with a bare molybdenum disc in the diffusion bonding fixture and held for 95 hours at 1000°C in very dry hydrogen. Very little bonding occurred and the structure was not vacuum tight. A photomicrograph of a portion of the bonded area is shown in Figure III-21. Failure to produce complete bonding, with molybdenum in contact with molybdenum, was blamed on the non-uniform and exceptional thickness of the plating. Further attempts using thin uniform chromium platings and holding at 1400°C for 2 hours in vacuum were completely

unsuccessful. A recent report[31] gives strong evidence that chromium and molybdenum do not have complete solid solubility and, therefore, considerable difficulty would be anticipated in attempting to obtain a molybdenum-to-molybdenum joint that was free of chromium or a chromium phase. Further work with chromium was stopped when it became apparent that the use of still higher diffusion temperatures would offer no advantage over straight brazing.

Palladium foil (0.0002-inch thick) was used between bare molybdenum rings and discs and the fixtured parts were heated to 1200°C for 5 hours in vacuum. This treatment resulted in vacuum-tight seals. The cross-section of an as-bonded specimen, along with one that was tested for 500 hours at 1000°C in cesium and remained leak tight, is shown on the summary data sheet for corrosion test No. 33, Figure III-47 (page III-135) Complete solutioning of the palladium in the molybdenum has not occurred and due to the unequal diffusion coefficients for palladium into molybdenum and molybdenum into palladium (Kirkendall effect), some pores have formed in the joint. No brittle inter-metallics and associated cracks were detected, as occurred when using a nickel interleaf (discussed in the semiannual report). Since still higher service temperatures (above 1000°C) were contemplated it was

felt that palladium should be studied as a braze material rather than as a diffusion bonding interleaf.

2.   Brazing

Some of the most promising (based on mechanical properties) ultra-high temperature refractory metal braze alloys studied on contract AF 33(616)-7484[21, 26] were supplied by W. R. Young. These alloys had the following compositions:

AS-501 - 30 w/o V; balance Ti

AS-514 - 35 w/c Nb; balance V

AS-540 - 60 w/o V: 30 Nb, 10 Ti

AS-546 - 60 w/o V; 30 Nb; 10 Zr

AS-547 - 59 w/o V, 29 Nb; 10 Zr; 2 Si

Unfortunately, the form in which the alloys were furnished....thick strips and chunks....did not permit ready application in the test joint and time did not permit converting them into more usable forms. However, a cesium corrosion test (Test No. 29) was performed on the alloys as received with the results reported in Figure III-44 (page III-131.) The lack of attack on these titanium and zirconium containing alloys makes them worthy of further investigation.

Brazes were made using the following commercially available heat resistant alloy brazes:

Standard Nicrobraz[*] - 13. 5 w/o Cr; 4. 5 Fe; 3. 5 B;

           0. 8 C; 4. 5 Si; balance Ni

Nicrobraz 50 - 17 w/o Mn; 8 Si; 0. 15 max. C;

           balance Ni

Nicrobraz 150 - 15 w/o Cr; 3. 5 B; 0. 15 max. C;

           balance Ni

G-E J8400[**] - 21 w/o Cr; 8 Si; 21 Ni; 0. 8 B; 0.4 C;

           3-5 W; balance Co.

Although some of the joints were leak tight all contained
brittle intermetallic phases and varying numbers of
transverse cracks. Figure III-22, niobium brazed to
molybdenum with G-E J8400, shows the formation of
various cracked phase layers from reaction of the
braze with the refractory metals. Other photomicro-
graphs of bonds formed by these brazes appear in the
Summary data sheet for Test No. 27, Figure III-43
(page III-130). This figure also shows that holding at
$1000^{o}C$ for 500 hours greatly increases the amount of
brittle intermetallics in the joint. Although these brazes
do not appear to be attacked by cesium vapor, they are
not suitable for making high-temperature tolerant seals
to refractory metals, unless the amount of braze alloy
in the joint can be critically limited or a post-treatment

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[*]Wall Colmonoy Corp., Detroit, Michigan

[**]General Electric Metallurgical Product Department, Detroit, Michigan

1000°C, 95 Hours, Dry H_2

Leaker

250X

Figure III-21

Diffusion Bond to Mo to Mo Using Chromium Plating
to Promote Diffusion
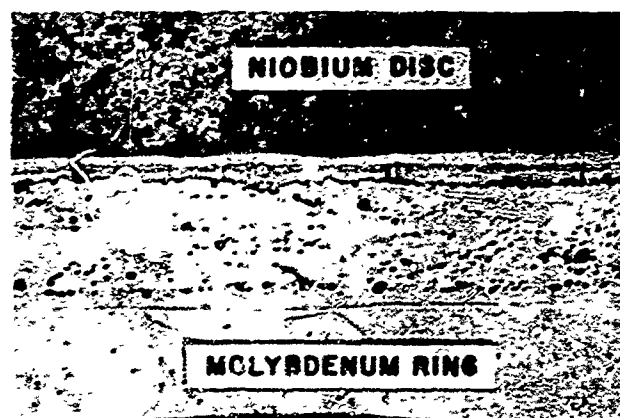
Braze: G-E J8400
1220°C, 1 Min, Vacuum

Leaker

250X

Figure III-22

Niobium Brazed to Molybdenum With G-E J8400

developed to solution the brittle phase forming elements.

Brazes were also attempted with palladium and 60-40 w/o palladium-nickel alloy. Because of the rapid diffusion of palladium into the refractory metals at the braze temperature (approximately $1600^{\circ}C$) and the inability to obtain good optical pyrometer readings, due to metal vapor deposition of the inside of the bell jar, very little success was realized using this metal as a braze. Others[22] have studied the use of palladium for brazing niobium and found that critical control of the temperature was necessary to prevent severe erosion and pore formation. It is believed that this sensitivity to temperature is due to the fact that the melting point of palladium is very near that of the palladium-niobium eutectic. In addition to causing erosion, the noble metals are known[33,34] to form brittle phases.

The 60-40 palladium-nickel material was not thin enough to use as a braze washer and therefore had to penetrate the joint by capillary action. This penetration occurred when using a niobium disc, but did not occur when using a tantalum or molybdenum disc. This phenomenon is undoubtedly related to the two niobium-nickel eutectics (see Figure III-19) being below the brazing temperature ($1280^{\circ}C$). A photomicrograph of the bond which was formed as well as its appearance

after 500 hours at 1000°C is shown in Figure III-49 (page III-137). The microstructure is very similar to that obtained when brazing niobium with pure nickel at a temperature of about 1380°C. Therefore, this braze may have some advantage over nickel when applied in the joint and used sparingly for prevention of erosion.

Brazing of molybdenum discs either to molybdenum rings or metallized A-976 ceramic rings, using nickel braze washers, has been quite successful. Vacuum-tight seals were relatively easy to produce with 0.0005-inch nickel shims but the joint contained the brittle Mo-Ni intermetallic, either as a continuous layer or as isolated islands. Even heating to almost 1500°C and holding for 10 minutes did not completely prevent the formation of this brittle intermetallic. However, when the nickel was reduced to 0.0001-inch, heating to 1480°C and holding for 5 minutes produced joints that were almost entirely free of the intermetallic; therefore they should have remelt temperatures almost equal to the melting point of pure molybdenum. When brazing to metallized ceramics with the 0.0001-inch nickel, it was found necessary to grind the metallizing flat to insure good contact. The seal formed is essentially a graded seal having metal-to-cermet (metallizing)-to-ceramic. This seal is illustrated in Figure III-48 (page III-136) before and after exposure to cesium for 500

hours at 1000°C. Two similar seals were still leak tight after this exposure, even though failure had been expected due to the poor thermal expansion match between molybdenum and alumina. The continued formation of the brittle MoNi intermetallic, which occurs when the nickel is not completely in solid solution in the molybdenum prior to testing, was brought out in cesium corrosion Test No. 17 and illustrated in Figure III-34 (page III-121). Two other specimens, similarly brazed to 5 MNA (Figure III-48) but with a ceramic ring on each side of the molybdenum disc to minimize bending stresses, were cycled 12 times to 900°C in vacuum and remained vacuum tight.

Others[32] have tried similar approaches to form graded seals. However, solid-state (rather than liquid-metal) diffusion was used with chromium, (instead of nickel) as the active diffusing metal. With solid-state diffusion, the diffusion rates are inherently lower and therefore bonding to the metallizing required heating to 1800°C and holding for one hour. Besides requiring a very high bonding temperature, this system has the disadvantage of requiring the mating pieces to be quite smooth and parallel, whereas with braze diffusion bonding the liquid can, to a certain extent, move around and increase contact.

Nickel braze diffusion bonding of niobium discs, either to molybdenum rings or metallized A-976 ceramic rings, was also quite successful. However, the resulting structures are not as ideal as those obtained with molybdenum discs. While complete bonding between the niobium and molybdenum was developed, isolated islands of a Nb-Ni intermetallic phase were never completely eliminated. The variation in the distribution of this phase with hold time and nickel shim thickness is illustrated in Figure III-23. Holding at 1400°C for 10 minutes with a 0.0005-inch nickel shim (5 CNM) produces a structure approaching that obtained when holding at 1400°C for 2 minutes with a 0.0001-inch nickel shim (8 CNM). When using a 0.0005-inch nickel shim and only holding for 2 minutes at 1400°C (7 CNM) the Nb-Ni intermetallic phase forms in a continuous band across the seal. This band is very brittle and can easily result in a leak path if thermal stresses cause it to fracture (as apparently was the case with specimen 7 CNM). The as-brazed structure of specimen 1 CNA, which was brazed at about 1200°C for 10 minutes using a 0.0005-inch nickel shim, is shown in Figure III-42 (page III-129). This figure shows that at 1200°C the braze does not penetrate the niobium, but a continuous band of brittle phase, as illustrated by the cracks, is formed. It is interesting to note that holding this joint
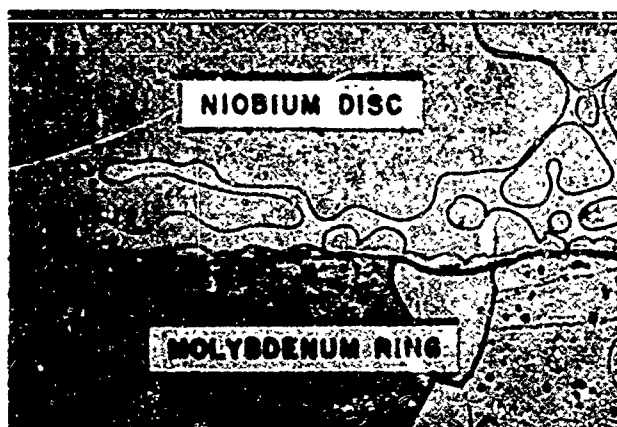
5 CNM   1400°C, 10 min, 0.0005 in. Ni
         Vacuum Tight
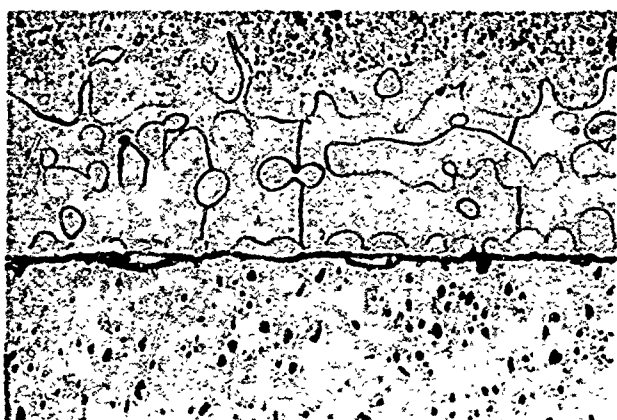
250X

7 CNM   1415°C, 2 min, 0.0005 in. Ni
         Leaker

250X
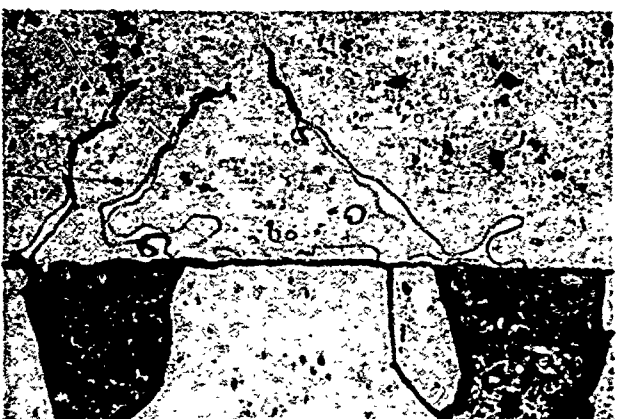
8 CNM   1415°C, 2 min, 0.0001 in. Ni
         Vacuum Tight

250X

Etch: 30 Latic, 30 HNO_3, 3 HF

Figure III-23

Photomicrographs Illustrating Variation in Penetrating Phase
With Hold Time and Shim Thickness

at 1000°C for 500 hours causes the structure to change
to one similar to that developed from brazing at higher
temperatures (1400°C). Also shown in Figure III-42
is specimen 2 CNM, which was brazed at 1300°C for
2 minutes using a 0.0005-inch nickel shim. These
parameters did not prevent formation of a continuous
band of intermetallic phase at the joint. However, like
the 1 CNA specimen, the 500-hour treatment at 1000°C
changed the structure to that which would be formed
when brazing for short times at temperatures higher
than 1300°C. Figure III-48 shows that brazing at
1420°C for 5 minutes (9 CNM), rather than 2 minutes
(8 CNM), results in very little difference in braze struc-
ture. This figure also shows that the testing of a high
temperature braze structure causes very little change
in this structure, although a second phase appears to
have precipitated in the penetrating phase. Another
specimen, similar to 9 CNA (shown in Figure III-48)
was thermally cycled 12 times to 900°C and remained
vacuum tight.

Nickel braze diffusion bonding of tantalum, either to
molybdenum rings or metallized A-976 ceramic rings,
was quite successful but, similar to niobium, resulted
in a less ideal structure than was obtained with molyb-
denum to molybdenum. Also, when brazing to metal-
lized ceramics it was found necessary to use tantalum

washers, rather than discs, to prevent cracking of the ceramic, whereas with molybdenum, slow cooling was sufficient and with niobium no precautions were necessary. As pointed out in the semiannual report,[9] there is an apparent temperature above which penetration of the braze into the tantalum starts to occur and transverse cracking in the braze is virtually eliminated. This temperature now appears to be around $1470^{\circ}C$ (incorrectly suggested as about $1370^{\circ}C$ in semiannual report). Figure III-38 (page III-125) shows the braze structure obtained below this temperature (specimen 6 TNM) and that obtained above this temperature (specimen 7 TNM). Hardness measurements indicated higher temperature brazes did not crack because they were much softer (480 Knoop compared to 690 Knoop), and, therefore, more ductile than the lower temperature brazes. It is interesting to note that the thermal treatment received during cesium corrosion testing did not grossly change the as-brazed microstructure of the lower temperature brazes, as it did to niobium, even though the exposure time was twice as long for the tantalum. This difference is undoubtedly due to the high melting point of tantalum and the associated lower diffusion rates.

Vacuum-tight seals of tantalum to metallized A-976 were obtained too late in the study to be tested in cesium.

Difficulties were not only experienced with cracked ceramics, due to thermal expansion mismatch, but also with metallizing which was not sufficiently flat for good contact as well as metallizing that was too thin to avoid being completely solutioned by the braze. Figure III-24 shows the microstructure of one of the latter seals, made with a tantalum washer rather than a disc, which appears worthy of cesium testing. This seal, 8 TNA, was brazed at 1500°C for 5 minutes. The slight difference in the microstructure between this seal and 7 TNM shown in Figure III-38 may have been due to the shorter brazing time (5 minutes instead of 15 minutes) and the use of only 0.0001 inch of nickel rather than 0.0005 inch. Note that the metallizing appears to have been only slightly dissolved by the braze. Two similar specimens to 8 TNA were thermally cycled to 900°C in vacuum 12 times without developing leaks.

Conclusions and Recommendations

Braze diffusion bonding using a nickel shim can be used to develop near ideal bonds between the refractory metals and alumina ceramics metallized with the metallizing developed during this program. Since these seals appear to be only limited in temperature by the structural members themselves, they should be capable of much higher service temperatures than the 1000°C employed for cesium corrosion testing and

III-92
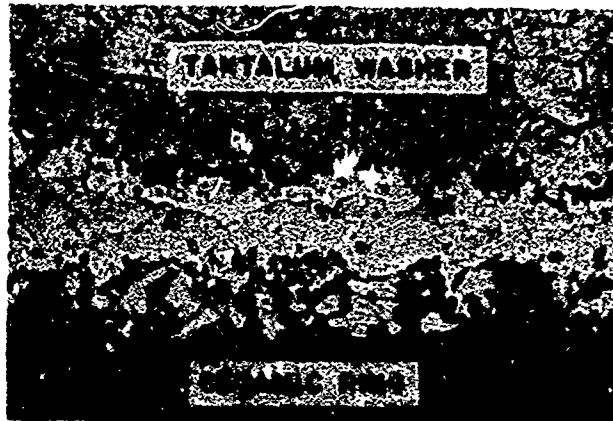
8 TNA brazed 1500°C, 5 min, .0001 in. Ni (500X)

Figure III-24

Tantalum Nickel Brazed to Metallized A-976
Ceramic

the 900°C used during thermal cycling. Therefore, further study of these seals is warranted to determine their maximum service temperature and their resistance to thermal cycle fatigue.

The commercially available heat resistant nickel and cobalt based braze alloys do not offer any advantages over braze diffusion bonding,(possibly some disadvantages), and therefore do not warrant further consideration for use in joining the refractory metals.

Brazing with palladium based braze alloys can yield structures similar to those obtained with nickel, with the possible advantage of a lower brazing temperature. These alloys, therefore, deserve further investigation using the braze diffusion bonding techniques used for nickel.

Brazing with ultra-high-temperature brazes (titanium and vanadium based) developed for refractory metals should be further investigated since they have been shown to be free from attack by cesium and may have applications where braze diffusion bonding is not practical.

Diffusion bonding does not offer any advantages over braze diffusion bonding and, therefore, further consideration of diffusion bonding is not recommended.

G.   Cesium Corrosion Testing

Introduction

The design of thermionic converters capable of 10,000 hours
or more of life required additional information concerning
the stability of the structural materials and seals in cesium.
The purpose of this program was: (1) to obtain design data
on the resistance of various materials (both insulators and
conductors) to attack by cesium vapor, and (2) to study the
attack on metal-to-metal and metal-to-ceramic seals that
are designed for exposure to elevated temperatures (1000°C).

The need for studying actual seals is very great when all of
the ways a seal can fail are considered. For example, fail-
ure can be caused by: (1) cesium attack of the sealing or
braze material or a particular phase within the joint; (2)
anodic behavior of the joint or braze material with respect
to the other materials forming the seal; (3) cesium dissolv-
ing in the joint material causing failure by formation of
brittle or low melting phases; and (4) cesium transferring
elements from other materials in the system to the joint
material where brittle phases can form. This list is by no
means complete and in fact there may be effects due to
ionized cesium but its study was beyond the scope of this
investigation.

Although seals have received very little study in regards to
stability in cesium vapor, effects have been noted from vari-
ous alkali metal studies which may be extrapolated to

illustrate the suggested causes of seal failure. For instance, in the first example (which deals with selective attack), cesium has been found to leach titanium from Type 321 stainless steel,[35] remove carbon from Type 310 stainless steel,[36] and both cesium[36] and potassium[37] have been shown to be responsible for the removal of oxygen from various refractory metals. Intergranular attack by potassium of the weld metal of niobium[38] and of a niobium alloy[39] suggests anodic behavior of these boundaries due to segregation of impurities or alloying elements during solidification. Also, the formation of a reaction product on niobium when placed with nickel in potassium[38] at $980^\circ C$ suggests electrolytic behavior of the type that would cause seal failure under Example (2). The formation of a glassy surface[40] from exposure to cesium vapor, on an alumina ceramic containing one or more percent SiO_2 was attributed to the formation of a cesium-aluminum-silicate, and thus illustrates Example (3) where failure of a seal can occur from formation of a lower melting cesium phase.

The possibility of failure by the fourth example, or by embrittlement from cesium transfer of other elements in the system to the joint material, was demonstrated[41] when tantalum, used for a specimen rack, was embrittled by transfer of carbon from Type 304 stainless steel in the same system.

Unfortunately, not all of the corrosion or attack data in the literature have been obtained using the same experimental procedures. Most studies have used a loop or reflux type of test in which various portions of the system are at different temperatures so that boiling and condensation occur simultaneously. This type of test more nearly simulates the application of liquid metals (in place of water) to drive turbo-machinery. Vapor pressures of four or more atmospheres are not uncommon; these high pressures exit because the cooler-condensing portion of the system is only slightly cooler than the boiling portion. This type of test is undoubtedly severe because of the high rate at which the liquid-metal atoms arrive at the surface and the constant washing of the container surface by the liquid metal. This latter effect alone can cause weight loss just by erosion. In fact, attack has also been attributed to cavitation in the boiling liquid.

Another method of studying cesium attack more nearly simulates the conditions in a thermionic converter. Here the specimens are maintained at the anticipated elevated operating temperature and exposed to alkali metal vapor of relatively low pressure (fractions of an atmosphere). The vapor pressure is controlled by maintaining a connecting reservoir at a relatively low temperature. With this type of test, the specimens are exposed only to the alkali metal vapor under fairly stable static conditions. However,

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because of the relatively large differences in temperature used, weight loss can occur from vaporization of the material being tested and condensation in the cooler reservoir portion of the system.

This lack of uniformity of obtaining cesium attack data made it desirable to retest many materials under simulated thermionic converter conditions, particularly since the published results cannot be compared directly as illustrated in Table III-8.[*] Materials previously found to be unacceptable in reflux or high-pressure studies may actually be acceptable under thermionic converter conditions.

There are other materials which require further study due to apparent conflicting data. For example, tantalum was found by one investigator to be resistant at 750°C but attacked at 1300°C, whereas another investigator found it to be resistant to attack at 1730°C. Platinum was reported to have poor attack resistance at 900 and 1300°C, but iridium and rhodium appeared to be unaffected at 1300°C.

Other materials also warranted investigation because they had not been previously tested or because they had not been tested as high as 1000°C. For example, chromium is of interest because of its potential applications in diffusion

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[*]Note: Table III-3 has its own set of references. These references do not correspond with those listed in the section entitled "References".

bonding and in graded cermets, and certain commercial alumina ceramics have been reported to be resistant at $750^{\circ}C$ but have not been tested at higher temperatures.

Experimental Procedure and Equipment

The test vessels used to contain the samples of materials and seals during testing were made of high purity alumina (A-976) and had high purity nickel closures and cesium reservoirs. Figure III-25 shows a schematic cross-section of the test vessel. A complete discussion of the construction of this vessel was given in the semiannual report on this contract. Also included in that report is a complete description of the experimental procedure. The only change made in this procedure was to cool the vessels in dry ice while driving the cesium from the crushed ampoule into the vessel. This extra step appeared to improve the efficiency of cesium transfer and also the reliability of the pinch-off made between the vessel and the cesium ampoule. A chemical analysis of the cesium was furnished by the vendor, Dow Chemical Company, and was included in the report.

Results and Discussion

General

Table III-9 gives a summary of all the successful cesium corrosion tests completed during this study and they are discussed in the sections to follow. Many of the results obtained are given in Table III-8 for easy comparison of results with those of others, and are

III-99
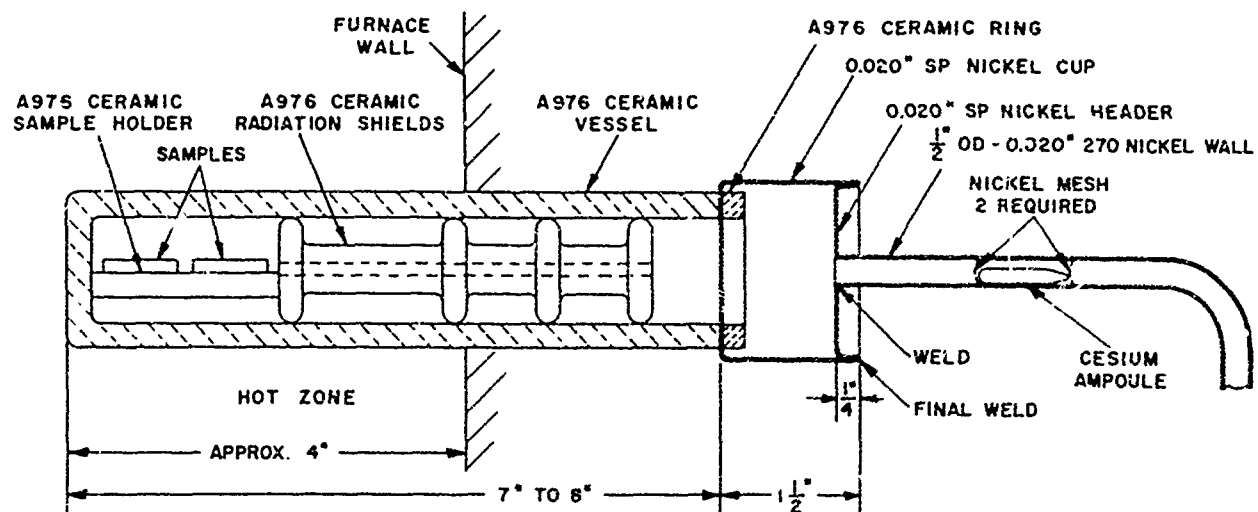
Figure III-25

Schematic Cross-Section of Ceramic Test Vessel

Table III-8

Resistance of Materials to Attack by Cesium

Material	Reference	Cesium Pressure	Test Temperature (°C) — data
Aluminum	1a	10 Torr	Poor 300–400 (1000*)
Carbon	1a	10 Torr	Poor 300–400 (216)
Copper (OFHC)	2	1 Torr	Poor ~800–900 (281)
	1a	10 Torr	Good 300–400 (1000); Poor 800 (1000)
Chromium	3	20 Torr	Good ~1000 (500)
LT-1Cermet 77 w/o Cr, 23 w/o Al₂O₃	3	20 Torr	Limited ~1000 (1000)
Gold	2	1 Torr	Poor ~900 (281)
50 w/o Au 50 w/o Cu	2	1 Torr	Poor ~900 (281)
Hafnium	1a	10 Torr	Good 300 (1000); Good 800 (1000); Good 1300 (700)
	7	~4 atmos.	Good ~850 (720)
Iridium	1b, 4	10 Torr	Good 300 (1000); Good 800 (1000); Good 1300 (300)
Iron	4	10 Torr	Good ~800 (1000)
	3	20 Torr	Good ~1000 (202)
	5	8.85 atmos.	Good ~1000 (450)
Kovar	1a	10 Torr	Good 300 (1000); Good 800 (1000)
60 w/o Mn 40 w/o Ni	1a	10 Torr	Poor 300–400 (1000)
Molybdenum	2	1 Torr	Good ~900 (281)
	1a	10 Torr	Good 300 (1000); Good 800 (1000); Good 1300 (700)
	6	1.16 atmos.	Good ~600 (100)
	7	~4 atmos.	Good ~850 (720)
	7	~8 atmos.	Limited ~900 (720)
Molybdenum	6	8.85 atmos.	Limited ~950 (100)
	5	8.85 atmos.	Good ~950 (450)
	7	~30 atmos.	Poor ~1350 (54)
TZM Alloy 0.5 w/o Ti, 0.08 w/o Zr, rem. Mo	8	~30 atmos.	Limited ~1350 (100)
Nichrome V	1a	10 Torr	Good 300 (1000); Good 800 (1000)
Nickel	2	1 Torr	Good ~850 (281)
	1a, 4	10 Torr	Good 300 (1000); Good 800 (1000)
	6	1.16 atmos.	Good ~600 (100)
	6	8.85 atmos.	Limited ~950 (100)
SP Nickel	3	20 Torr	Good ~1000 (500)
Nicoro (35 w/o Au, 62 w/o Cu, 3 w/o Ni)	1a	10 Torr	Limited 300–400 (1000)
Nicrobraz LM	1a	10 Torr	Good 300 (1000); Good 800 (1000)
Nicrobraz 170	4	10 Torr	Good ~800 (1000)
Niobium	1a	10 Torr	Good 300 (1000); Good 800 (1000)
	3	20 Torr	Good ~1000 (500)
	7	~4 atmos.	Good ~850 (720)
	7	~8 atmos.	Limited ~950 (720)
	7	~30 atmos.	Limited ~1350 (54)
Niobium + 1% Zr	7	~4 atmos.	Good ~850 (720)
	7	~8 atmos.	Limited ~900 (720)
	7	~30 atmos.	Limited ~1350 (54)
FS-82 Nb Alloy (0.75 w/o Zr, 33 w/o Ta)	2	1 Torr	Limited ~900 (281)

Good ▓ Limited ▒ Poor ▨ No Data ☐

Table III-8 (contd)

Chart: Test Temperature (°C) vs Material, Reference, and Cesium Pressure. Temperature scale: 300, 400, 500, 600, 700, 800, 900, 1000, 1100, 1200, 1300, 1400, 1500, 1600, 1700, 1800.

Material	Reference	Cesium Pressure
Palladium	1a, 1b, 4	10 Torr
	3	20 Torr
65 w/o Pd, 35 w/o Co	4	10 Torr
	3	20 Torr
60 w/o Pd, 40 w/o Ni	4	10 Torr
	3	20 Torr
Platinum	2	1 Torr
	1a	10 Torr
	3	20 Torr
Rhenium	1a, 4	10 Torr
Rhodium	1a, 1b, 4	10 Torr
Silver	1a	10 Torr
BT Solder (72 w/o Ag, 28 w/o Cu)	1a	10 Torr
715 VTG (0.75 w/o Ni, 26.1 w/o Cu, bal. Ag)	1a	10 Torr
Type 304 SS (18 w/o Cu, 8 w/o Ni)	1a, 4	10 Torr
Type 310 SS (25 w/o Cr, 20 w/o Ni)	7	~4 atmos.
Type 321 SS (18 w/o Cr, 8 w/o Ni, + Ti)	6	1.16 atmos.
	6	8.65 atmos.
Type 430 SS (16 w/o Cr)	2	1 Torr
Tantalum	9	1.5 Torr
	1a	10 Torr
	3	20 Torr
	7	~4 atmos.
	7	~8 atmos.
	7	~30 atmos.
Ta-10 W	8	~30 atmos.
Titanium	1a	10 Torr
72 w/o Ti, 28 w/o Ni	1a	10 Torr
Tungsten	1a	10 Torr
	7	~4 atmos.
	7	~8 atmos.
	6	8.65 atmos.
	7	~30 atmos.
	8	~30 atmos.
W-25 Re	8	~30 atmos.
Zirconium	1a	10 Torr
	7	~4 atmos.
Quartz	1a	10 Torr
Steatite	1a	10 Torr
Sapphire	1a	10 Torr
Alsimag 614 (96.0% Al₂O₃)	1b	10 Torr
Am. Feldmuehle RK 37 T (99% Al₂O₃)	1b	10 Torr

Legend: Good ■ | Limited ▨ | Poor ▧ | Bad ☐

III-102

Table III-8 (contd)

Test Temperature (°C)

Material	Reference	Cesium Pressure	Test Temperature data
Coors AD 96 (96.0% Al_2O_3)	1b	10 Torr	Poor at 1000; Poor at 1000
Coors AD 99 (99.0% Al_2O_3)	1b	10 Torr	Poor at 1000; Poor at 1000
Coors AD995 (99.5% $Al_2O_3 + Cr_2O_3$)	4	10 Torr	Good at 1000
	3	20 Torr	at 500
Diamonite B390 (95% Al_2O_3)	1a	10 Torr	Good at 1000; Limited at 650
Diamonite P-3142-1 (94.7% Al_2O_3)	1a	10 Torr	Good at 1000; Poor at 1000
Frenchtown 17225 (94.5% Al_2O_3)	1a, 1b	10 Torr	Poor at 1000; Poor at 1000; Limited at 650
Wesgo Al 300 (97.6% Al_2O_3)	1b	10 Torr	Good at 1000; Poor at 1000
Wesgo Al 400 (95% Al_2O_3)	1a	10 Torr	Good at 1000; Poor at 1000
Wesgo Al 995 (99.5% Al_2O_3)	1b	10 Torr	Good at 1000; Poor at 1000; Poor at 1000
Silk City SC95D (95% Al_2O_3)	1b	10 Torr	Good at 1000; Good at 1000
	3	20 Torr	at 300
Silk City SC98D (98% Al_2O_3)	1b	10 Torr	Good at 1000; Good at 1000
G-E A923 (97% Al_2O_3)	2	1 Torr	Good at 24; Good at 24; Poor at 24
G-E A976 (Al_2O_3)	2, 10	1 Torr	Good at 24, 24, 24, 24, 24; Good at 24
	10	10 Torr	Good at 24; Good at 24
Al_2O_3 containing more than 1% SiO_2	10	1 Torr	at 24; Poor at 24
	10	100 Torr	at 24; Poor at 24
Carborundum MgO 0333	1b	10 Torr	Poor at 1000; Poor at 1000
Carborundum MgO 0340	1b	10 Torr	Good at 1000; Poor at 1000
Minneapolis-Honeywell high MgO	1b	10 Torr	Limited at 1000; Poor at 1000

Good ▮ (filled)   • Hours tested
Limited ▦ (cross-hatched)   # Static test
Poor ▨ (diagonal)
No Data ☐ (empty)

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Table III-9

Cesium Corrosion Tests

Test No.	Material	Hours Exposed	Weight Change (%)	Remarks[f]
5	Tantalum	235	< -0.02	No attack
6	Palladium	250	Nil[*]	No attack
9	S-20 metallizing on A-976 ceramic	209	metallizing +5	Metallizing attacked
11	Iron	202	-0.07	No attack
12	Metallized Silk City SC95D alumina ceramic	300	total +0.6	Metallizing & ceramic attacked
14	H-1 metallized on A-976 ceramic	500	0	No attack
	H-1 metallized A-976 ceramic brazed together with Prema-braze #101		Nil	Still vacuum tight
15	Niobium	500	< -0.03	No attack
16	Chromium	500	< -0.02	No attack
17	Molybdenum disc to molybdenum ring using nickel braze	500	Nil	No longer vacuum tight
	Tantalum disc to molybdenum ring using nickel braze		Nil	Still vacuum tight
18	60-40 w/o Palladium - nickel braze alloy	500	-0 13	No attack
19	6 active alloy seals from this program	500	Avg. total < +0.02	None still leak tight
20	SP Nickel	500	Est. -0.1[**]	No attack
21	Halves of TNN specimens 1, 2, 3, 4, 6, 7.	1000	Avg. < 0.01	No attack
23	Palco (65 w/o Palladium - 35 cobalt)	500	Avg. -0.6[##]	No attack 3 of 4 bonded together
	Palco brazed, H-1 metallized, A-976 ceramic		Nil	Two complete seals no longer vacuum tight

[*]Weight change of 0.0002 g or less listed as nil change

[f]For more complete description see Summary Data Sheets

[**]Before testing weight in error - weight surmised from weighing similar untested samples

[##]Average weight of specimens was less than 0.05 g

Table III-9 (contd)

Test No.	Material	Hours Exposed	Weight Change (%)	Remarks
24	Metallized Coors AD995 alumina ceramics	500	total +0.17	Metallizing attacked
25	Platinum	500	$< +0.05$	No attack
26	Halves of CNM specimens 1, 2, 3, 4, 5, 6, 8 and 1 CNA	500	All Nil	No attack
27	Molybdenum-to-molybdenum brazed with standard Nicrobraz Nicrobraz 150 Nicrobraz 60 GE J8400	500	$< +0.02$ $< +0.03$ $]-0.05^{***}$	No attack No attack
28	Oxide melts from this program 46-1800 (65 w/o Al_2O_3 -35 Y_2O_3) 48-1750 (60 w/o Al_2O_3 - 20 CaO)	500	Samples damaged when removed from vessel	No attack
29	Ultra-high temperature brases AS 501 (Ti - 30 w/o V) AS 514 (V - 35 Nb) AS 540 (60V, 30 Nb, 10 Ti) AS 546 (60V, 30 Nb, 10 Zr) AS 547 (59V, 29 Nb, 10 Zr, 2 Si)	500	+0.6 Nil $< +0.1$ Nil Nil	Reacted with pallet No attack No attack No attack No attack
30	LT-1 Cermet 77 w/o Cr, 23 w/o Al_2O_3	1000	+0.27	Turned dull blue gray with sweaty appearance pores developed in structure
31	Niobium nickel brazed to H-1 metallized A-976 (4 & 5 CNA)	1000	Nil	No attack - microstructures similar to test 34 - specimens leaked due to irregular metallizing
	Molybdenum nickel brazed to H-1 metallized A-976 (1 & 2 MNA)	1000	Nil	No attack - one seal vacuum tight - other ceramic cracked. Seals not initially free of MoNi intermetallic
32	H-1 metallizing on A-976 H-1 metallizing on Coors AD 995	500	0 or Nil 0	No attack - 6 specimens No attack - 2 specimens
33	Mo - Al_2O_3 Cermet (this program) Diffusion bonded molybdenum-to-molybdenum using palladium interleaf	500	0 Nil	No attack - still vacuum tight No attack - still vacuum tight
34	Specimens 7 & 8 CNA Specimens 4 & 6 MNA & 1/2 5 MNA	500	All Nil All Nil	No attack - both vacuum tight No attack - both vacuum tight
35	Molybdenum, niobium & tantalum brazed to H-1 metallized A-976 using 60-40 w/o palladium-nickel	500	All Nil	No attack on any - niobium specimen still vacuum tight Mo & Ta specimens brazed poorly

***Specimens bonded together

also presented in the form of Summary Data Sheets
in Figure III-26 through Figure III-49. Most of the
metal specimens were made from 3/4-inch square
pieces of the material with the corners bent down to
allow exposure of the underside and provide minimum
contact with the high-purity alumina ceramic speci-
men holder.

Chromium and Chromium-Containing Cermet

Chromium was not attacked by cesium vapor at $1000^{\circ}C$
as shown in Figure III-33 (Test No. 16). The speci-
mens were machined from a block of arc-cast chrom-
ium of unknown purity and had holes drilled through
them to provide a higher surface-to-weight ratio. Un-
like metallic chromium, LT-1 (77 w/o Cr, 23 w/o
Al_2O_3) cermet did show considerable weight gain and
sweating of cesium after testing. The results on this
material are given in Figure III-45 (Test No. 30).
Some increase in porosity in the alumina phase occurred
and cesium absorption in these pores could have accounted
for the increase in weight and sweating of cesium after
testing. Since both chromium and pure alumina are not
attacked by cesium vapor, the changes realized may
have been due to impurities in the material.

Iron

Iron was not attacked by cesium vapor as shown in
Figure III-29 (Test No. 11). The results of other tests

at 750°C and 1000°C confirm the results of this test, which was discussed in the semiannual report.

Nickel

Nickel developed a slight etched appearance when tested at 1000°C, Figure III-37 (Test No. 20), but this was attributed to metal vaporization and not cesium attack. Other investigators, using high cesium pressure (8.85 atmos) have attributed the etched appearance at 1000°C to cesium attack but no mention was made of the use of microsections to confirm this conclusion.

Niobium

Niobium was not attacked by cesium vapor at 1000°C, as shown in Figure III-32 (Test No. 15). The marginal results reported by others for Nb - 1 percent Zr and FS-82 Nb alloy at 980°C and 900°C, respectively, may have been due to reaction of the cesium with zirconium oxide, which is formed by the gettering of dissolved oxygen by the zirconium in these alloys.

Palladium and Palladium Alloys

Palladium, 65-35 w/o palladium-cobalt, and 60-40 w/o palladium-nickel, Figures III-27, -39 and -35 (Tests 6, 23 and 18), respectively, were not attacked by cesium vapor at 1000°C. Some surface etching did occur but this, as in the case of nickel, was attributed to metal vaporization and not attack. The poor attack resistance

of palladium at 1050°C reported by others may have
been a result of loss of strength due to very extensive
grain growth, and not a result of cesium attack of the
filament type specimen which was used. The failure
of seals brazed with 65-35 w/o palladium-cobalt
(Falco), Figure III-39, was attributed to continued
solutioning of the molybdenum metallizing in the braze
during the corrosion test. A seal brazed with Prem-
abraze 101[*](54 w/o Pd, 36 Ni, 10 Cr) was still vacuum
tight after 500 hours, Figure III-31 (Test No. 14),
even though diffusion pores and some solutioning of
the metallizing occurred.

Platinum

Figure III-41 (Test No. 25) gives the results of cesium-
attack for platinum, and shows that no apparent attack
occurred. This result does not agree with other invest-
igators who found attack at 750°C, 900°C and 1300°C.
However, the lack of attack was not unexpected since
palladium had been shown to be resistant and others
had reported that iridium and rhodium were not attacked
at 750°C and 1300°C.

Tantalum

Tantalum, as shown in Figure III-26 (Test No. 5), was
not attacked by cesium vapor at 1000°C. This test was
discussed in the semiannual report for this study.

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[*]Handy and Harmon, New York 22, N.Y.

Coors AD-995 Alumina Ceramic

This ceramic was not attacked by cesium vapor at $1000^{\circ}C$ which is in agreement with results reported at $750^{\circ}C$. However, the metallizing applied by Coors was attacked, as shown in Figure III-40 (Test No. 24). The Coors metallizing was removed and metallizing mix No. 1*from this program (see section entitled "C. Cesium Resistant Metallizing") applied. Subsequently, both ceramic and metallizing were then found to be resistant to attack by cesium vapor, Figure III-46 (Test No. 32).

Silk City SC-95D Alumina Ceramic**

This ceramic was badly attacked (spectrographic analysis showed it to contain nearly 1 percent SiO_2) at $1000^{\circ}C$, as shown in Figure III-30 (Test No. 12). In fact, the attack of the ceramic negated evaluation of the attack resistance of the metallizing applied by Silk City. Others found that this ceramic was not attacked at $750^{\circ}C$.

G-E A-976 Alumina Ceramic

This ceramic was previously shown to be resistant to cesium attack up to $1500^{\circ}C$, and so was used during this study for evaluating metallizing coatings. Figure III-28 (Test No. 9) shows the attack, which was anticipated, when a silica-containing metallizing (designated S-20) is corrosion tested on this ceramic. Metallizing mix No. 1 developed under this program was also tested on

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*Metallizing mix No. 1 is identical with the H-1 metallizing material referred to on pages III-118, III-126, III-129, III-134, III-136, and III-137.
**Silk City Ceramics, Hawthorne, N. J.

this ceramic and the results given in Figure III-31
(Test No. 14) and the rerun results in Figure III-46
(Test No. 32). No attack or degradation of the mix
No. 1 metallizing was detected from these tests.

Ultra-High-Temperature Brazes - AS-501, AS-514,
AS-540, AS-546, AS-547

These braze materials (studied and furnished by Young)[21,26]
previously discussed under "F. Metal-to-Metal Joining,"
were not attacked at $1000^{\circ}C$, as shown in Figure III-44
(Test No. 29). Only one alloy, AS-501, (Ti 30 w/o V)
showed any significant change.... the weight gain due
to reaction of the titanium with the ceramic sample
holder and etching due to recrystallization and grain
growth. The results obtained on these braze alloys,
all of which contain at least 10 w/o titanium or zircon-
ium, except AS-514, do not support the results of
others who found titanium attacked at $750^{\circ}C$ and $1100^{\circ}C$,
and zirconium at $750^{\circ}C$ and $1300^{\circ}C$ under low cesium
pressures. Still others found titanium leached from
Type 321 stainless steel at $700^{\circ}C$ and $1000^{\circ}C$ under
high cesium pressures.

Other Materials

Two bonding oxide compositions (discussed in section "C.
Cesium Resistant Metallizing"), 46-1800 (65 w/o
Al_2O_3 - 35 Y_2O_3) and 48-1750 (80 w/o Al_2O_3 - 20 CaO),
melted onto molybdenum boats were tested at $1000^{\circ}C$.

Neither composition showed signs of attack. Damage
to the extremely brittle recrystallized molybdenum
boats did not permit accurate weight loss measurements.

A multilayered molybdenum-alumina cermet (Figure
III-6), developed under the Multilayered Cermets por-
tion of this program, was tested at 1000°C. It was
not attacked and still leak tight. The fabrication of
this cermet is discussed under the section entitled
"D. Multilayered Cermets."

Various active-alloy seals, developed under the Active-
Alloy Sealing portion of this program, were tested at
1000°C with the results presented in Figure III-36
(Test No. 19). All of the seals leaked after testing,
but did not show signs of cesium attack. Failure was
attributed to continued diffusion of the titanium into
the essentially unlimited supply of nickel, causing loss
of bond and considerable pore formation.

Conclusions and Recommendations

The refractory metals of interest in thermionic converter
construction,-molybdenum, niobium, and tantalum,-are free
from cesium attack at 1000°C when exposed for a minimum
of 200 hours in 20 Torr cesium. In addition, iron, nickel,
palladium and platinum, as well as the alloys 65-35 palladium-
cobalt, 60-40 palladium-nickel, and 54-36-10 palladium-
nickel-chromium, which are potential braze materials for

III-111

thermionic converter components, are also free from attack at 1000°C. Various commercially available nickel and cobalt based braze alloys, as well as the ultra-high-temperature titanium and vanadium based braze alloys are also free of attack at 1000°C. Further testing of these materials should be restricted to insuring attack resistance at higher temperatures and their compatibility with other construction materials.

The alumina ceramics, G-E A-97o and commercially available Coors AD-995, were not attacked by cesium nor was the metallizing developed during this program when applied to these ceramics. Also, the molybdenum-alumina cermets developed under this program are free from attack. Knowledge of the resistance of these materials to cesium at higher temperatures is desirable for higher (above 1000°C) temperature seal development.

Alumina-to-nickel active-alloy seals are not attacked by cesium; however, the rather rapid diffusion of the braze into the structural members at 1000°C indicated that these seals would be limited to service temperatures somewhat below 1000°C.

Commercially available chromium-alumina cermet LT-1 is attacked by cesium vapor at 1000°C, as are materials containing about 1 percent or more silica, such as commercially available alumina ceramic Silk City SC-95D and a silica-containing metallizing (designated S-2o). These results emphasize the importance of a very low silica content in new insulators and seals for use in thermionic converter construction.

Test No. 5
Material: Tantalum, 0.010-inch thick
Test conditions: 1000°C, 20 Torr cesium pressure
Hours tested: 235

Appearance (approx. 2X)
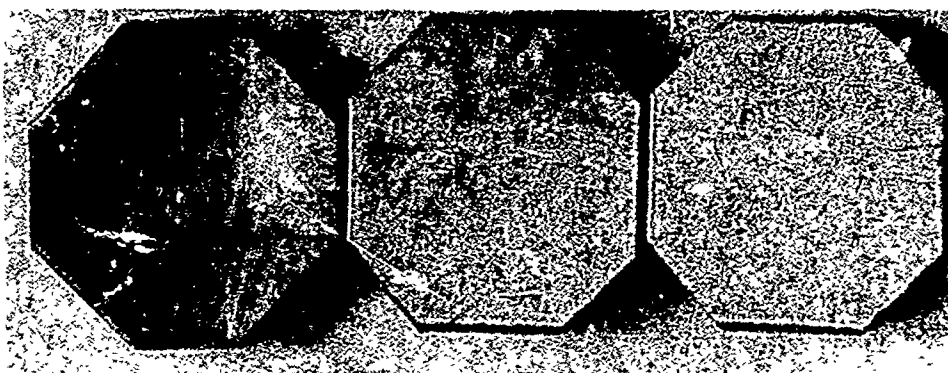
	Before	After Specimen 3	After Specimen 4	
Weight:		1.5318 g	1.5391 g	Before
		1.5320 g	1.5395 g	After

Microstructure (100X)
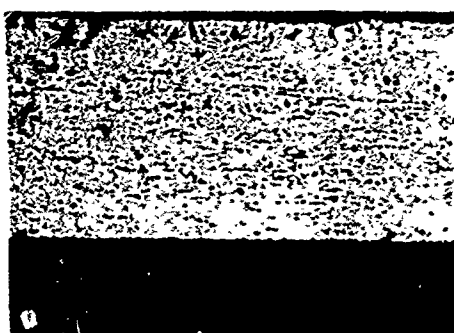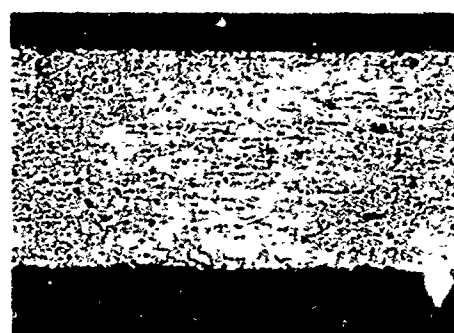
Before   After
                                      Specimen 3

Etch: 50 ml H_2SO_4
       20 ml HNO_3
       20 ml HF

Remarks: Specimens received very very slight etching from cesium.
          Microstructure shows no significant attack. Pits in micro-
          structure partially due to etch pitting of dislocations.

Figure III-26

Summary Data Sheet of Cesium Attack for Tantalum

Test No. 6
Material: Palladium, 0.010-inch thick
Test Conditions: 1000°C, 20 Torr* cesium pressure
Hours tested: 250

Appearance (2X)

	Before	After Specimen 1	After Specimen 2, after washing
Weight:		1.1022 g	1.0762 g	Before
		1.1021 g	1.0761 g	After
			1.0759 g	After washing

Microstructure (100X)
Etch: Aqua-Regia
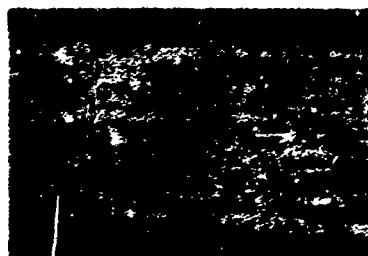
Before   After

Remarks: Surface of specimens covered with white film which could only
be partially washed off. Material etched by cesium - very
slight attack of grain boundaries not shown in "after" micro-
structure.

*May not have been this pressure during full time as indicated by lack of
cesium in reservoir at end of test.

Figure III-27

Summary Data Sheet of Cesium Attack for Palladium

Test No. 9
Material: S-20 metallizing on A-976 ceramic
Test conditions: 1000°C, 20 Torr cesium pressure
Hours tested: 209

Appearance (approx. 2X)
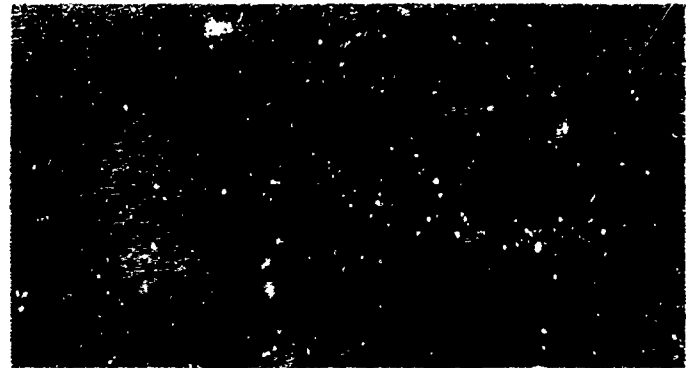
Before   After

Weight: 2.2450 g   Before
                                             2.2462 g   After

Microstructure (100X)
Unetched
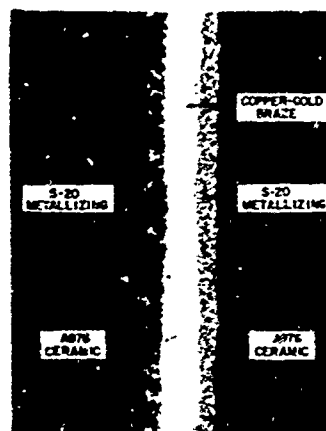
After   Before

Remarks: Staining of tested specimen occurred after prolonged exposure
          to air after test. Before and after specimens brazed together
          after testing. Note attack of glass phase in metallizing.

Figure III-28

Summary Data Sheet of Cesium Attack for S-20
Metallizing on A-976 Ceramic

III-115

Test No. 11
Material: Iron, 0.010-inch thick
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 202

Appearance (2X)
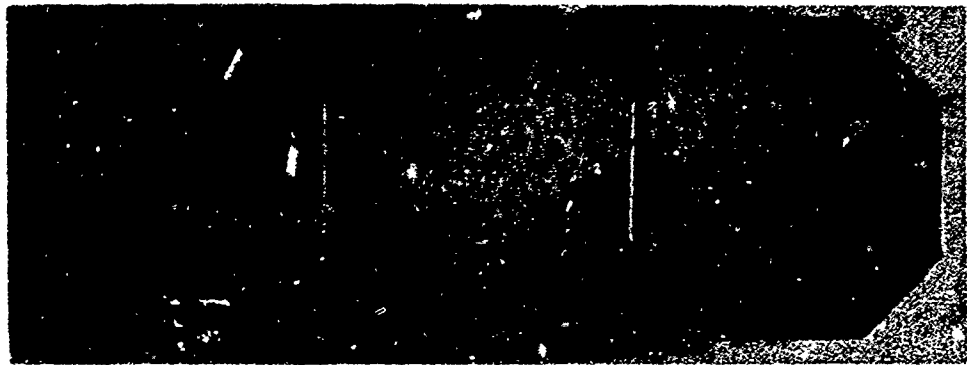
	Before	After Specimen 1	After Specimen 2	
Weight:		0.7627 g	0.7691 g	Before
		0.7621 g	0.7686 g	After

Microstructure (100X)
Etch: 2% Nital
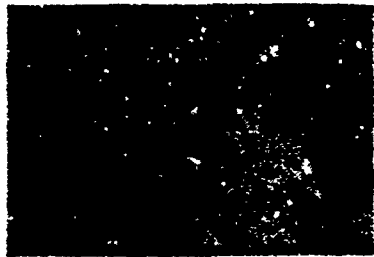
Before   After

Remarks. Specimens had rough surface after testing and were
covered with thin white film. Microstructure indicates
that roughness was due to shifting of grains during
growth realized during testing.

Figure III-29

Summary Data Sheet of Cesium Attack for Iron

III-116

Test No. 12
Material: Silk City SC95D alumina ceramics metallized by Silk City
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 300

Appearance (approx. 2X)
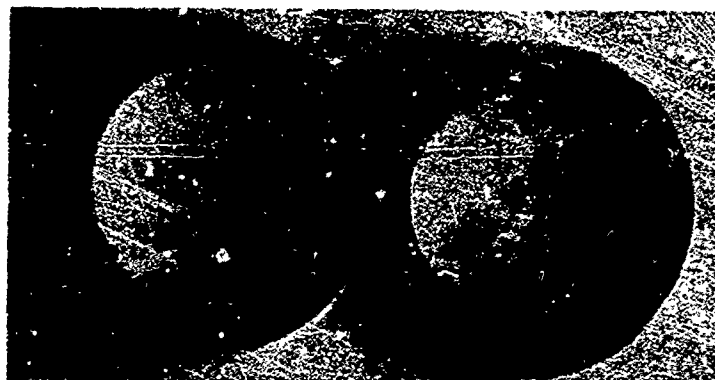
Before   After
                         Specimen 3

Weight: 1.5293 g   Before
                                       1.5385 g   After

Microstructure (50X)
Unetched
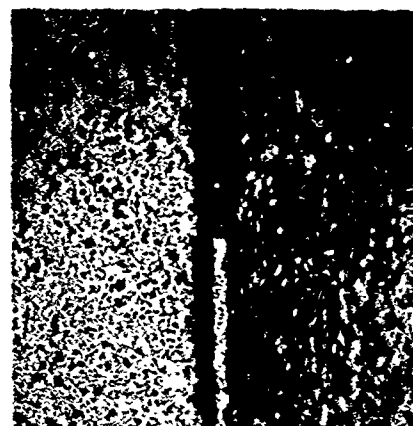
Before   After

Remarks: Ceramic darkened from cesium attack. Before and after
         specimens brazed together after testing. Extensive attack
         of ceramic prevented evaluation of metallizing.

Figure III-30

Summary Data Sheet of Cesium Attack for Silk City SC95D
Metallized Ceramic

Test No. 14
Material: H-1 metallizing on A-976 ceramic
         H-1 metallized A-976 ceramic brazed together with
         Premabraze 101 (54 w/o Pd, 36 w/o Ni, 10 w/o Cr)
Conditions: $1000^{\circ}C$, 20 Torr cesium pressure
Hours Tested: 500

Appearance (2X)

Before   After

	Brazed Specimen		Specimen 1	
Weight:	4.5740 g		2.2552 g	Before
	4.5739 g		2.2552 g	After

Microstructure (250X)
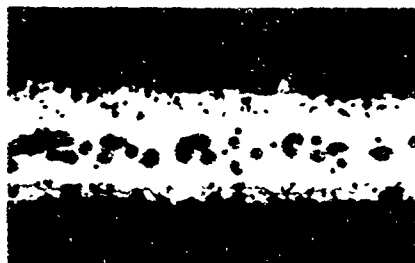
After

Before   After

Remarks: No apparent attack of Premabraze 101 or metallizing. Brazed
         specimen still leak tight at end of test. Pores in brazed speci-
         men formed during the test from Kirkendall type diffusion.
         Copper-gold braze applied to metallizing after testing.

Figure III-31

Summary Data Sheet of Cesium Attack for H-1 Metallizing on A-976
Ceramic and Similar Ceramics Brazed Together With Premabraze 101

III-118

Test No. 15
Material: Niobium
Test Conditions: 1000°C, 20 Torr cesium pre sure
Hours Tested: 500

Appearance (2X)

	Before	After Specimen 1	After Specimen 2	
Weight:		1.0622 g	1.0605 g	Before
		1.0619 g	1.0602 g	After

Microstructure (100X)
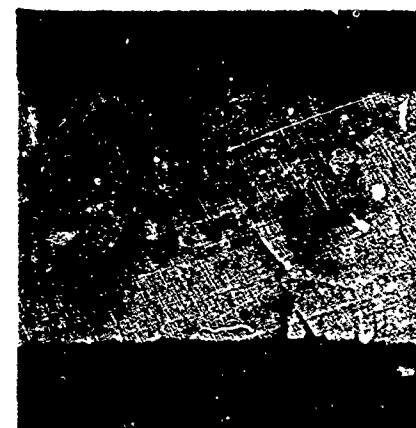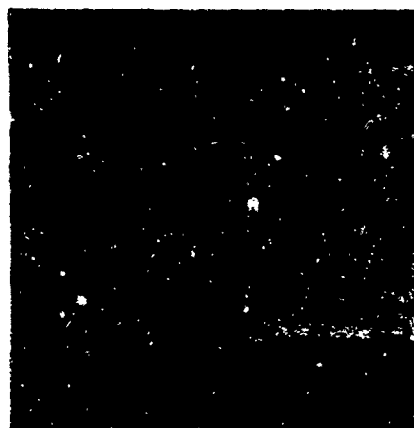
Before   After

Remarks: No apparent attack. Note increase in grain size from thermal
treatment of test.

Figure III-32

Summary Data Sheet of Cesium Attack for Niobium

Test No. 16
Material: Chromium
Test Conditions: 1000°C, 2(Torr cesium pressure
Hours Tested: 500

Appearance (2X)

Weight:

	After Specimen 3	After Specimen 4	
	7.5629 g	8.1049 g	Before
	7.5615 g	8.1040 g	After

Microstructure (100X)
Etch: 10 HCl, 90 Methyl Alcohol, 6V DC

Before   After

Remarks: No apparent attack. Specimens made from arc-cast
chromium of unknown purity.

Figure III-33

Summary Data Sheet of Cesium Attack for Chromium

III-120

Test No. 17
Material: Nickel brazed tantalum-to-molybdenum (No. 5 TNM) and
           molybdenum-to-molybdenum (No. 2 MNM)
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Microstructure (250X)
    Molybderum-to-Molybdenum

Before (No. 6 MNM)   After (No. 2 MNM)

    Tantalum-to-Molybdenum
        Microstructure similar to No. 7 TNM Test No. 21

Weight: 5 TNM   2 MNM
                     7.4697 g   7.0621 g   Before
                     7.4701 g   7.0622 g   After

Remarks: No apparent attack of either specimen. Specimen No. 5 TNM
          still leak tight after testing, No. 2 MNM leaked. Note coarsen-
          ing of braze structure in No. 2 MNM.

                        Figure III-34

    Summary Data Sheet of Cesium Attack for Nickel Brazed Tantalum-
    to-Molybdenum and Molybdenum-to-Molybdenum

Test No. 18
Material: 60-40 w/o Palladium-Nickel
Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Appearance (2X)

Before   After   After
              Specimen 1   Specimen 3

Weight:

              0.9898 g   0.9723 g Before
              0.9887 g   0.9709 g After

Microstructure (100X)
Etch: 50 Acetic, 50 HNO$_3$
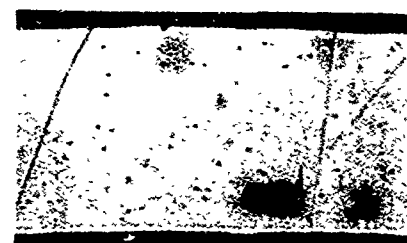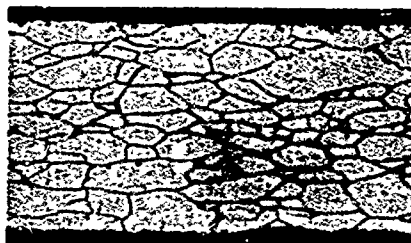
Before   After

Remarks: Slight etching believed to be due to vaporization and not attack.
         Note recrystallization and grain growth.

Figure III-35

Summary Data Sheet of Cesium Attack for 60-40 Palladium-Nickel

Test No. 19
Material: Active alloy (Ti-Ni) seals
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Microstructure (250X)
Etch: 4-1/2 H_2O 4-1/2 HNO_3, 1 HF, 9 Lactic
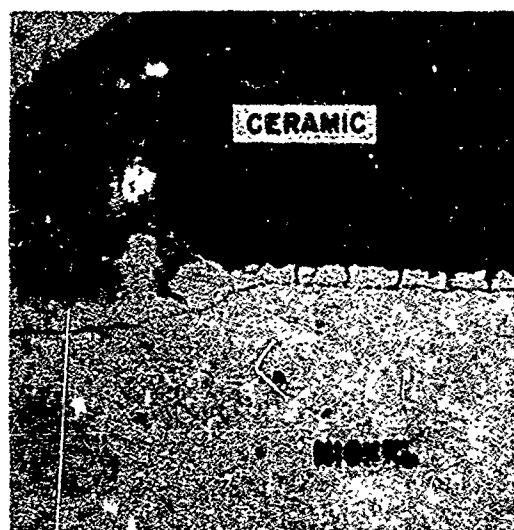
Specimen B 86B Before   Specimen B86B After
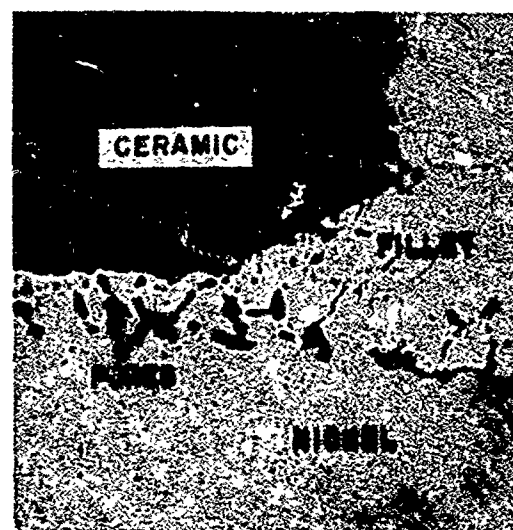
Weight:	Specimen 94A	94B	95A	95C	B76A	B86B	
	4.6124 g	4.6069	4.6082	4.6043	4.0528	4.0995	Before
	4.6129 g	4.6075	4.6090	4.6050	4.0535	4.0997	After

Remarks: Pores formed and bonds lost in all specimens from continued diffusion of titanium into nickel. Intermetallics in fillet still bonded to ceramic. As tested microstructures of other specimens looked similar to that shown. No attack by cesium was noted on any of the specimens.

Figure III-36

Summary Data Sheet of Cesium Attack for Active Alloy Seals

Test No. 20
Material: SP* Nickel
Test Conditions: 1000°C,   sure
Hours Tested: 500

Appearance (2X)

	Before	After	After
Weight:		Specimen 5	Specimen 6
		Estimated Weight	Loss approx. 0.1%
		Initial weight inaccurately taken	
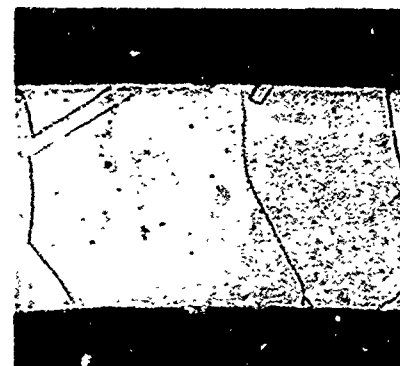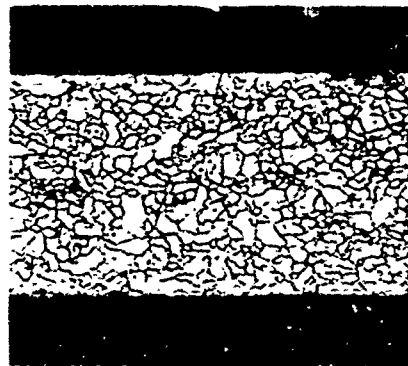
Microstructure (100X)
Etch:

Before   After

Remarks: Slight etching believed to be due to vaporization and not attack.
Note recrystallization and grain growth.

*Trademark Metals for Electronics Co.

Figure III-37

Summary Data Sheet of Cesium Attack for SP Nickel

III-124

Test No. 21
Material: Nickel brazed tantalum to molybdenum
Test Conditions: $1000^{o}C$, 20 Torr cesium pressure
Hours Tested: 1000

Microstructures
Etch: 50 H_2SO_4, 20 HNO_3, 20 HF
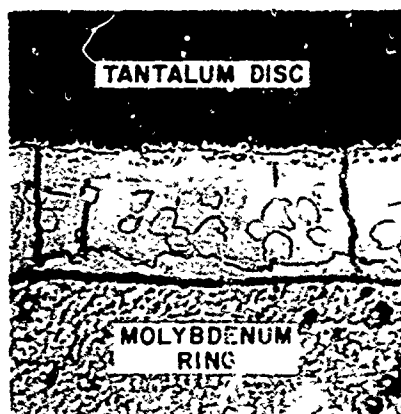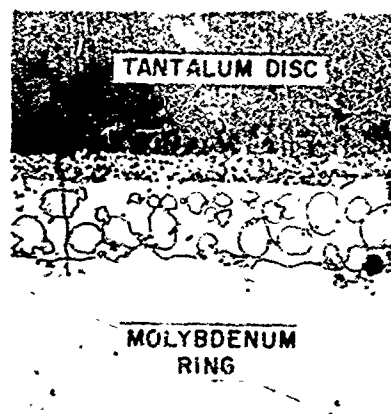
Before   (500X)   After

6 TNM brazed approximately $1450^{o}C$, 10 min., 0.0005-inch nickel shim
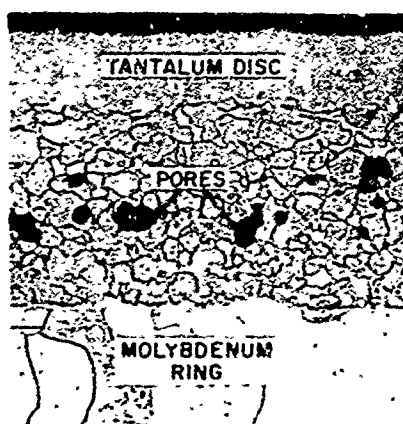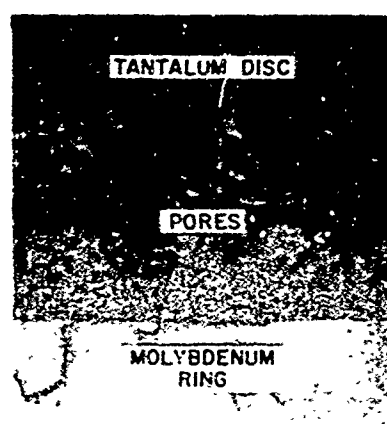
Before   (125X)   After

7 TNM brazed approximately $1480^{o}C$, 15 min., 0.0005-inch nickel shim

Weight: Weight change less than 0.02% for all specimens

Remarks: No apparent attack. Note widening of phase adjacent to tantalum
in lower temperature brazed specimen from corrosion testing.
Pores in 7 TNM due to unbalanced diffusion during brazing

Figure III-38

Summary Data Sheet of Cesium Attack for Nicke   zed Tantalum to
Molybdenum

III

Test No. 23
Material: Palco (65 w/o palladium - 35 cobalt) and Palco
brazed, H-1 metallized, A-976 ceramics
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Appearance (2X)

	Before	After	After
Weight: Brazed specimens (not shown above)		Specimen 1	Specimens 2, 3, 4
Nil weight change		0.0480 g	0.0507, 0.0480, 0.0490 g Before
		0.0474 g	0.1468 g After

Microstructure
Etch: 30 Lactic, 30 HNO$_3$, 3 HF   50 Acetic, 50 HNO$_3$
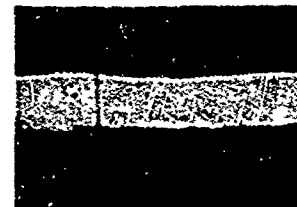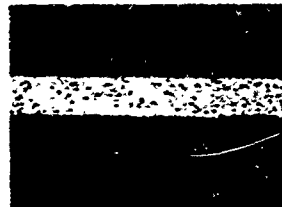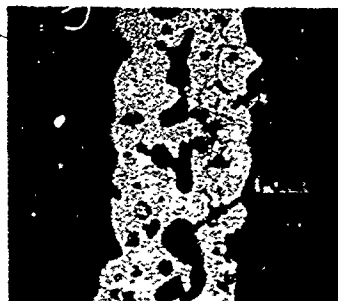
Before   After (100X)

Before   After (250X)

Remarks: Specimen 1 damaged when removed from vessel. Specimens 2, 3, and 4 bonded together during testing. Etching of Palco believed to be due to vaporization and not attack. Pores in center of braze and loss of bond due to diffusion of Palco into molybdenum of metallizing.

Figure III-39

Summary Data Sheet of Cesium Attack for Palco and Placo Brazed Metallized Ceramics

Test No. 24
Material: Coors AD995 alumina ceramic metallized by Coors
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Appearance (2X)

	After Specimen 1	After Specimen 2	
Weight:			
	1.4861 g	1.3351 g	Before
	1.4884 g	1.3375 g	After

Microstructure (100X)
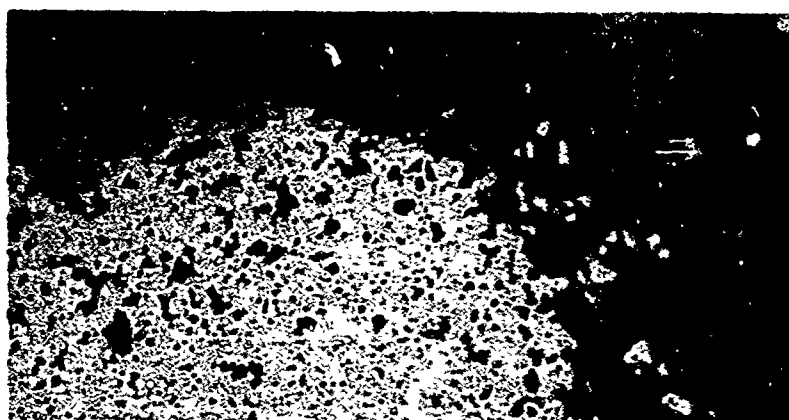
After   Metallized Surface

Remarks: Attack appears limited to metallized surface. Flaking of specimens made final weighings inaccurate.

Figure III-40

Summary Data Sheet of Cesium Attack for Coors Metallized AD995 Alumina Ceramic

III-127

Test No. 25
Material: Platinum Strip
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Appearance: Specimen after test was very bright and shiny
with very slight amount of grain boundary etching.

Weight: .8235 g   Before
          .8239 g   After

Microstructure (100X)
Etch: Aqua Regia, warm, slightly dilute

After

Remarks: No apparent attack. Metal still very ductile after testing.

rface

Figure III-41

Summary Data Sheet of Cesium Attack for Platinum

Test No. 26
Material: Nickel brazed niobium to molybdenum and H-1 metallized
        A-976 ceramic
Test Conditions: $1000^{\circ}C$, 20 Torr cesium pressure
Hours Tested: 500

Microstructures
Etch: 30 Lactic, 30 HNO_3, 3 HF
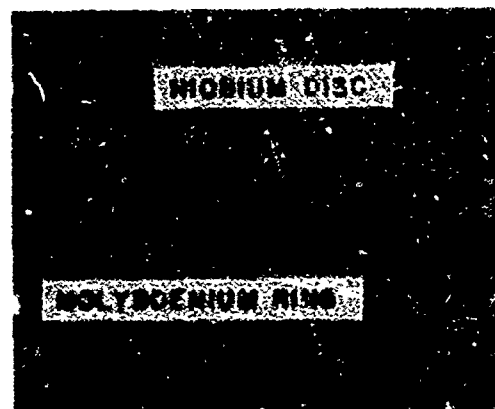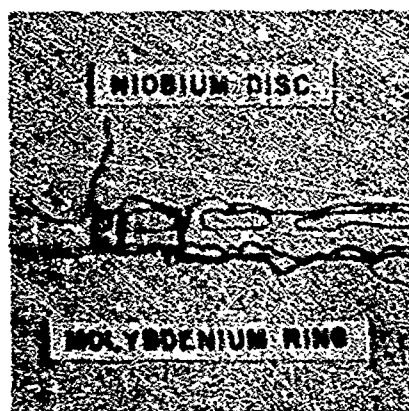
Before   (250X)   After
2 CNM brazed approx. $1300^{\circ}C$, 2 min., .0005-inch nickel shim
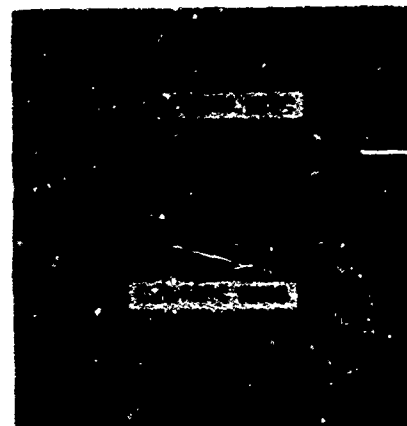
Before   After
1 CNA brazed approx. $1200^{\circ}C$, 10 min., .0005-inch nickel shim

Remarks: No apparent attack. Note change in microstructures due to the
        prolonged holding at the test temperature.

Figure III-42

Summary Data Sheet of Cesium Attack for Nickel Brazed Niobium to
Molybdenum and Metallized A-976

III-129

Test No. 27
Material: Molybdenum to molybdenum brazed with standard Nicrobraz,
         Nicrobraz 150, Nicrobraz 60 and GE J8400
Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Microstructures (250X)
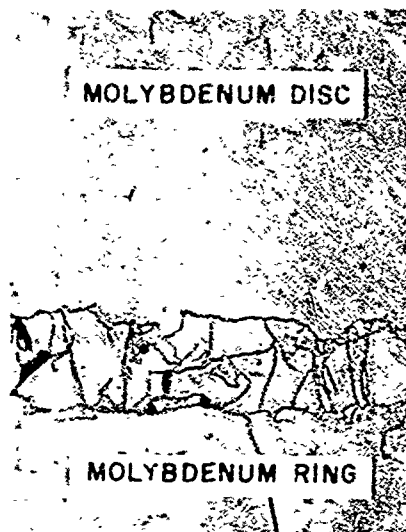Etch: 4-1/2 H_2O. 4-1/2 HNO_3, 9 Lactic 1 HF
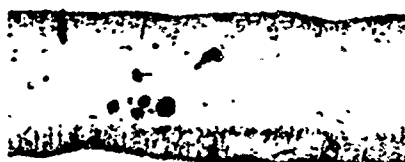

MOLYBDENUM DISC
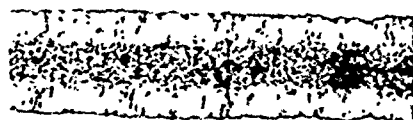
MOLYBDENUM RING

Before

1M60M - brazed 1120°C, 1 min.,
Nicrobraz 60

After

MOLYBDENUM DISC

MOLYBDENUM RING

Before

1M84M - brazed 1200°C, 30 sec.,
GE J8400 braze

After

Remarks: No apparent attack. Note formation of very brittle (cracked)
         intermetallic compounds from testing. Specimen brazed with
         Standard Nicrobraz similar to 1M60M and specimen brazed
         with Nicrobraz 150 similar to 1M84M after testing.

Figure III-43

Summary Data Sheet of Cesium Attack for Molybdenum to Molybdenum
Brazed With Nickel and Cobalt Base Brazes

Test No. 29

Material: Ultra-high temperature brazes: AS 501, Ti-30 w/o V,
AS 514, V-35 Nb, AS 540, 60V - 30 Nb - 10 Ti, AS 546
60V - 30 Nb - 10 Zr, AS 547, 59V - 29 Nb - 10 Zr - 2 Si

Test Conditions: 1000°C, 20 Torr cesium pressure

Hours Tested: 500
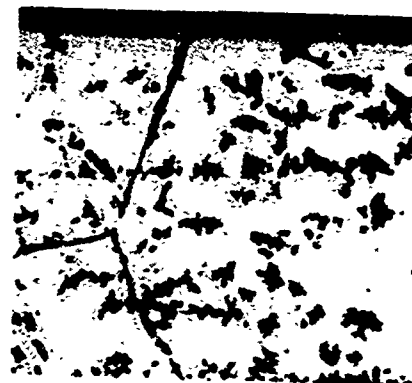
Appearance (2X)

Before

After

	AS 501	514	540	546	547
Weight:	0.5193 g	0.2323 g	0.5535 g	0.8200 g	1.5055 g Befo
	0.5224 g	0.2325 g	0.5539 g	0.8201 g	1.5056 g Afte

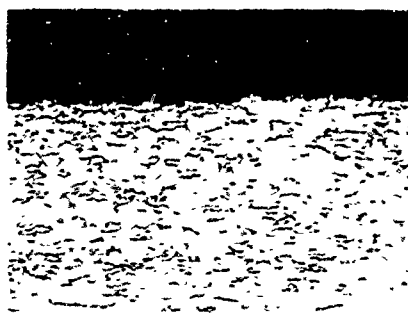Microstructures (100X)

AS 501

Before

After

Test No. 29 (contd)
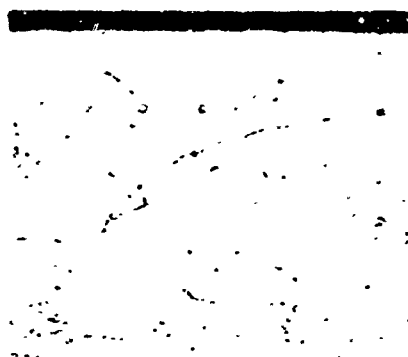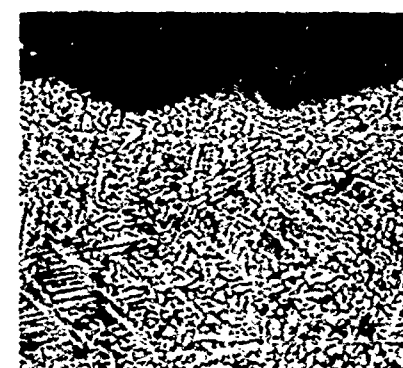
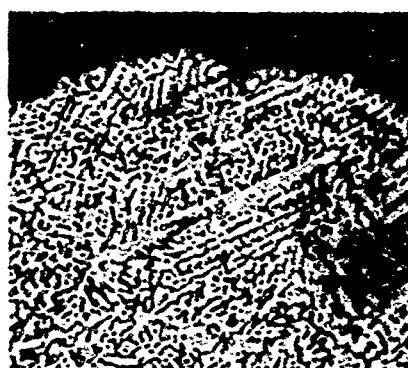Before   After

AS 514
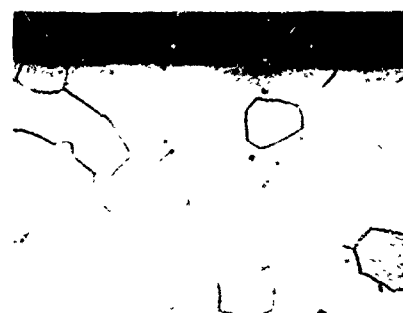
AS 540

AS 546

AS 547

Remarks: AS 501 reacted with pallet, no Cs attack, recrystallized -
α Ti precipatated on cooling. AS 514 no attack - recrystallized.
AS 540 no attack - recrystallized. AS 546 no attack - possibly
some solutioning of network phase. AS 547 no attack - no appar-
ent change in structure.

Figure III-44

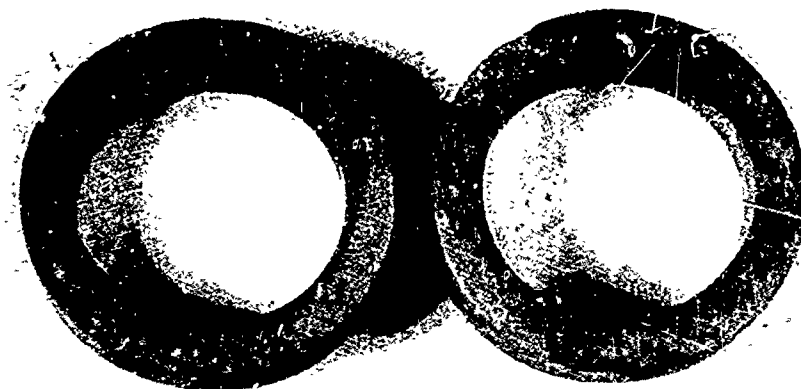Summary Data Sheet of Cesium Attack for Ultra-High Temperature Brazes

Test No. 30
Material: LT-1 Cermet, 77 w/o Cr, 23 w/o Al_2O_3
Test Conditions: $1000^{\circ}C$, 20 Torr cesium pressure
Hours Tested: 1000

Appearance (approx. 2X)

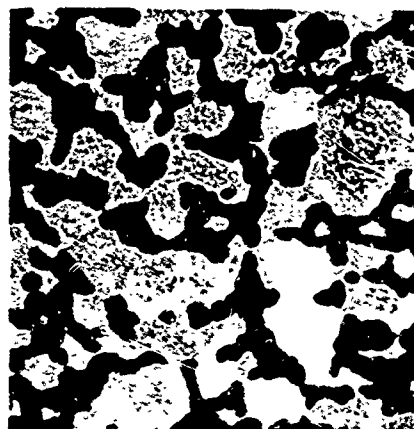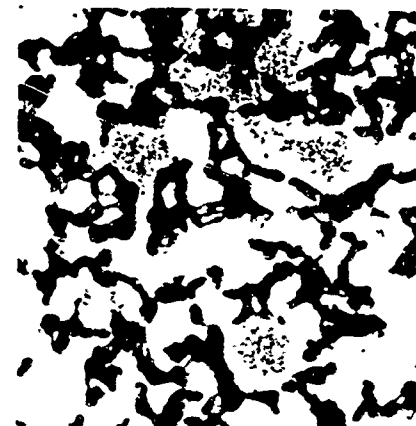|	After Specimen 3	After Specimen 4	
Weight:	6.2572 g	7.2195 g	Before
	6.2721 g	7.2416 g	After

Microstructure (500X)
Etch: 10 HCl, 90 methyl
alcohol, 6 VDC

Before   After

Remarks: Specimens turned from metallic gray to bluish gray from testing.
Sweating of specimens after testing indicated bleeding of cesium.
Note apparent increase in porosity of microstructure from testing.

Figure III-45

Summary Data Sheet of Cesium Attack for LT-1 Cermet

Test No. 32
Material: H-1 metallizing on A-976 and Coors AD995 alumina ceramics
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Appearance (approx. 2X)   Coors AD995

See Test No. 14 for
  appearance of H-1
  metallizing on A-976

	After Single Coat	After Double Coat	
	Specimen CS-5	Specimen CD-5	
Weight:	1.5598 g	1.5704 g	Before
	1.5598 g	1.5704 g	After

Microstructure (250X)

After Coors AD995   After A-976

Remarks: No attack of either ceramic or of H-1 metallizing on either ceramic.
          Specimens brazed together with Cu-Au before sectioning. Double
          coating of metallizing on ceramics on left, single on right.

Figure III-46

Summary Data Sheet of Cesium Attack for H-1 Metallizing on A-976
and Coors AD995 Alumina Ceramics

Test No. 33
Material: Molybdenum-Alumina Cermet from this program and
           Diffusion bonded Mo to Mo using palladium interleaf
Test Conditions: 1000°C, 20 Torr cesium pressure
Hours Tested: 500

Microstructure (250X)
Etch: 80 cc H_2O, 10 g $CuSO_4$, 20 cc NH_4OH

Mo Disc

Mo Ring

	Before	After
Weight:	Specimen 5 Pd	Specimen 4 Pd
		7.0851 g Before
		7.0850 g After

Both seals formed by holding clamped at 1200°C for
5 hours in vacuum using .0002-inch palladium

Remarks: No signs of attack on cermet or Pd diffusion bond. Both specimens
          still leak tight. Cermet discussed under Multilayered Cermets
          section of this report. Pores due to faster diffusion of Pd into Mo
          than Mo into Pd.

Figure III-47

Summary Data Sheet of Cesium Attack for Molybdenum-Alumina Cermet
and Diffusion Bonded Mo to Mo Using Palladium Interleaf

Test No. 34
Material: Nickel brazed niobium and molybdenum discs to H-1
          metallized A-976 ceramic
Test Conditions: 1000°C, 20 Torr cesium pressure
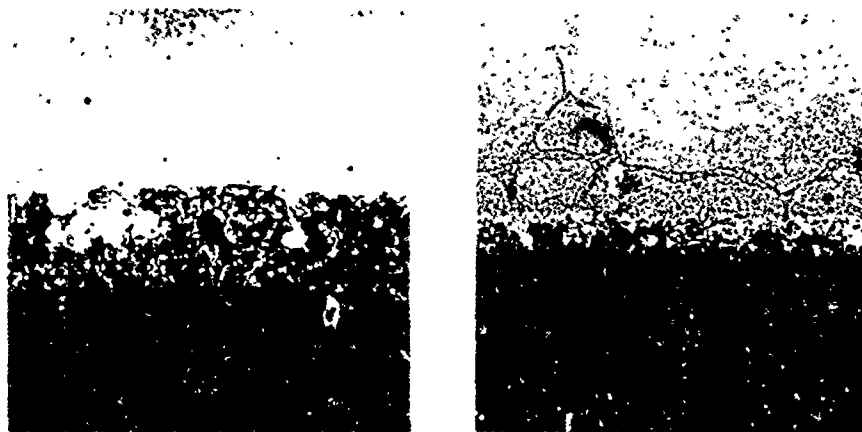Hours Tested: 500

Microstructures (250X)
Etch: 30 Lactic, 30 HNO₃, 3 HF

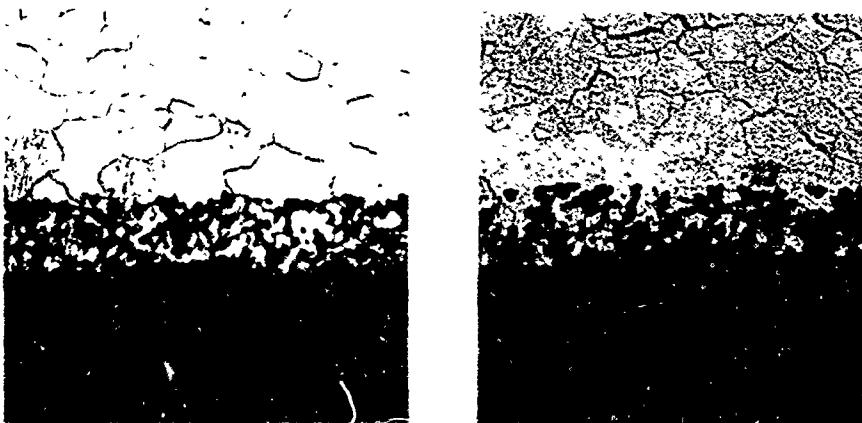Nb Disc

Metallizing

A-976 Ceramic

Before Specimen 9 CNA   After Specimen 7 CNA

Brazed at approx. 1420°C for 5 min., with .0001 inch nickel
Metallizing on 9 CNA initially thicker than on 7 CNA

Mo Disc

Metallizing

A-976 Ceramic

Before   Specimen 5 MNA   After

Brazed at approx. 1480°C for 5 min., with .0001 inch nickel

Remarks: No apparent attack on any of the specimens. Specimens 7 CNA,
         8 CNA, (Nb) 4 MNA and 6 MNA (Mo) all leak tight after testing.
         Note nil change in Mo specimen and precipitation of another
         phase in Nb specimen.

Figure III-48

Summary Data Sheet of Cesium Attack for Nickel Brazed Niobium
and Molybdenum-to-Metallized A-976 Ceramic

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Test No. 35
Material: 60-40 w/o Palladium-nickel brazed Mo, Nb, and Ta discs
       to H-1 metallized A-976 ceramic
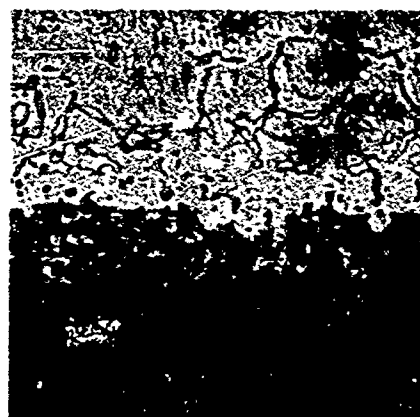Test Conditions: $1000^{\circ}C$, 20 Torr cesium pressure
Hours Tested: 500

Microstructure (250X)
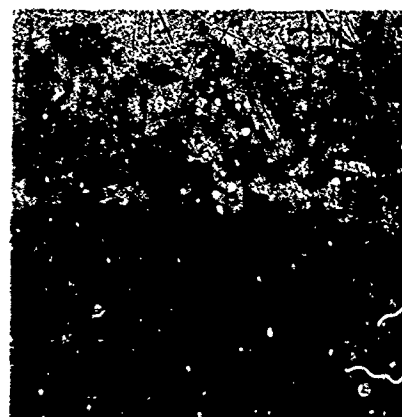Etch: 30 Lactic, 30 HNO_3, 3 HF

Nb Disc

Metallizing

A-976 Ceramic

Before   After

Brazed approx. $1410^{\circ}C$ for 2 min.

Weight: All spec mens showed nil weight change

Remarks: No apparent attack of any of the specimens. Specimen 2C6-4A
         still vacuum tight after test. Both molybdenum and tantalum
         specimens leaked after testing due to almost no flow of braze
         into joint. Note formation of another phase in the phase that
         penetrates the niobium.

Figure III-49

Summary Data Sheet of Cesium Attack for 60-40 Palladium-
Nickel Brazed Mo, Nb, and Ta to A-976 Ceramic

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CHAPTER III
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